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MIME: MICROPROGRAMMABLE
MINICOMPUTER EMULATOR

#### THESIS

Presented to the Faculty of the School of Engineering

of the Air Force Institute of Technology

Air University

in Partial Fulfillment of the

Requirements for the Degree of

Master of Science

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## Preface

A thesis such as this represents the culmination of many efforts and we wish to thank those whose contributions made our work possible and successful. It is appropriate that our first thank you be to Dr. Gary Lamont, who listened to our proposal with a sympathetic ear, agreed to serve as our advisor, and provided us with the resources necessary to accomplish this project.

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Theresa and Vicki, to assist with some of the mundane clerical details

and whose continued moral support were significant factors in our success.

We also appreciate the many constructive suggestions and comments from faculty members and fellow students and the fine work of our typist.

We have gained extreme personal satisfaction from the accomplishment of this project. The breadth of experience gained from realizing a theoretical design in hardware was invaluable.

## Contents

																															Page
Prefa	ice													. •																	ii
List	of	F	igur	es							•						• .														vii
List	of	T	able	s									•			•								•					٠		x
List	of	T	erms																												xii
Abst	rac	t			•		•			•				•																	xv
ı.		In	trod	uc	tic	on																									1
			Mic	ro	pro	ogr	ram	mi	ng																						2
			Pro																												3
			Bac																												3
			Goa																												5
			Pla																												5
			0rg																												7
			org	an	120	1 (1	. 01	1	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	
II.		Fu	ncti	on	al	Re	equ	iir	em	en	ts								•			•		•	•		•	•			9
			Int	ro	du	eti	or	,																							9
			Edu																												11
					uca																										12
				Lu			rat																								12
					O		Exe																								12
																															13
							Dat																								
							Deb																								13
					I		orm																								13
							Seq																								13
						(	Con	ntr	ol	S	ig	na	115	5												•		•		•	13
						r	Dat	a																							14
					F	unc	cti	or	al	14		or	of:	igu	ire	d	На	ard	lwa	are	,										14
							Fur																								14
						7	111	115	tr	at	iv	re.	C	onf	io	ur	at	ic	n												14
							Sim																								15
			Mic	ro	pro	rgo	ran	ıma	bi	1i	ty	,																			15
				Re	sic	der	nt	Co	nt	ro	1																				15
				Us	er	M	icr	or	ro	gr	an	ıma	b	11	tv	,															15
			Gen																												16
					st										·																17
					ogi								•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•		17
					ith								.:				•	•	•	•	•	•	•	•	•	•	•	•	•	•	17
																	•	•	•	•	•	•	•	•	•	•	•	•	•	•	17
					ta											-		•	•	•	•	•	•	•	•	•	•	•	•	•	
					ta						-				•	• •	•	• •	•		•					• •					20
					mo						•	•	•		•	•	•		•	•	•		•	•			•	•	•	•	20
					gi						•	•	•		•		•		•		•		•		•	•	•	٠		•	20
					pu										•		•	•			•							•	•		21
			Sum	ma	ry																	•									21

III.	Detail Requirements	22
	Introduction	22
	Bussing Requirements	22
		22
		22
		25
	Dienlaye	26
	Displays	26
		27
	Memory	28
	Computer Control Unit	29
	Control Store	30
	Input/Output	30
	Chassis	31
	Summary	31
IV.	Hardware Realization	32
	Introduction	32
	Architecture	32
		32
		35
	A	35
		35
	Input/Output	35
	Input/Output	35
	Parts Selection	36
	Am2900 Family	36
	Control Store Memory	36
	Component Mounting and Interconnection	37
	Clock Considerations	38
		39
	Chassis	41
	Summary	41
v.	Emulation Example	43
	Introduction	43
		14
		15
	P1-1:	16
		-
		17
	Summers	52
	Summary	58
VI.	Results, Recommendations and Conclusions	1
	Results	1
		1
		2
		3
	D	4
	Enhancements	4

0

•

0-	Appl:																							
Co	nclus	ion	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	67
Bibliography																								68
Appendix A:	MIME	Use	r's	Mar	nua	1																		70
Appendix B:	Conf	igur	atio	n I	Man	ag	eme	ent	Pi	roc	eec	lur	e											191
Vitae																								204

# List of Figures

Figure	Pag	ļ€
1	Functional Requirements Hierarchy	)
2	Required Shifting Capabilities 18	3
3	Required Rotate Capabilities	)
4	MIME System Hardware	5
5	MIME Architecture	1
6	MIME Chassis	2
7	Circuit Card Positions	2
8	Microprogram Flow	5
9	PDP-11/03 Emulation Structures 48	3
10	IFTCH Flowchart	)
11	DECODE Flowchart	L
12	INTHNDL Flowchart	3
13	COM Flowchart	1
14	COM(B) Flowchart	5
15	MOV Flowchart	7
16	MOV(B) Flowchart	3
17	BGE Flowchart 60	)
18	RTS Flowchart 60	)
19	TRAP Flowchart 60	)
A1	MIME Architecture	
A2	MIME Hardware	
А3	Card Rack Mounting	
A4	Card Positions	
A5	Micro Level Transfers	
Α6	Macro Level Transfers	

A7	FP Block Diagram
A8	MIME Front Panel
A9	ALU Block Diagram
A10	MEM1 Block Diagram
A11	CCU Block Diagram
A12	CS Block Diagram
A13	I/O Block Diagram
A14	Microword Definition
A15	Representative Microword Formats
A16	PDP-11/03 Emulation Structure
A17	IFTCH Flowchart
A18	DECODE Flowchart
A19	INTHNDL Flowchart
A20	PUSH Flowchart
A21	COM Flowchart
A22	DSTDCD Flowchart
A23	DPCDCD Flowchart
A24	OPFTCH Flowchart
A25	COMB Flowchart
A26	MOV Flowchart
A27	SRCDCD/SPCDCD Flowchart
A28	MOVB Flowchart
A29	SWABQ Flowchart
A30	BGE Flowchart
A31	RTS Flowchart
A32	POP Flowchart
A33	TRAP Flowchart

A34	FP1 Schematic	•
A35	FP2 Schematic	
A36	ALU Schematic	
A37	MEM1 Schematic	
A38	CCU1 Schematic	
A39	CCU2 Schematic	
A40	CS1 Schematic	
A41	I/O Schematic	
B1	Wiring Table Sample	
B2	Alphabetized Data	
В3	Master Connector Pin List Excerpt	
RA	Racknlane Wiring Table Excernt	

# List of Tables

<u>rable</u>			Page
I	Arithmetic/Logic Capabilities		17
11	Requirements Correlation		23
III	MIME Operating Modes		25
IV	Displays		26
v	MIME Characteristics		33
VI	Module Cycle Times (Approximate)		39
VII	Power Requirements	•	40
VIII	MIME Estimated Cost		40
IX	Sample PDP-11/03 Instructions		47
AI .	MIME Characteristics		
AII	Circuit Card Identifiers		
AIII	Microaddress Sequencer Field		
AIV	Command, Bus Source, Bus Destination Fields	•	
AV	Input/Output Field		
AVI	Am2901 Processor Fields	•	
AVII	Shifting Linkage Fields	•	
AVIII	Test Condition Fields		
AIX	ALU Condition Code Fields, Carry-In Field		
AX	16-Way Branch Fields		
AXI	Sample PDP-11/03 Instructions		
AXII	Sample Microcode		
AXIII	Testpoint Array		
AXIV	FP Test Equipment and MIME Set Up		
AXV	FP. Tests		
AXVI	CCU Test Equipment and MIME Setup		

MALL		
IIIVXA	CS1 Test Equipment and MIME Setup	
AXIX	CS1 Tests	
AXX	ALU Test Equipment and MIME Setup	
AXXI	ALU Tests	
AXXII	MEM1 Test Equipment and MIME Setup	
AXXIII	MEM1 Tests	
VIXXA	I/O Test Equipment and MIME Setup	
AXXV	I/O Tests	
AXXVI	FP1 Parts List	
AXXVII	FP2 Parts List	
AXXVII	FP2 Parts List	
AXXVIII	MEM1 Parts List	
AXXIX	ALU Parts List	
AXXX	CCU1 Parts List	
AXXXI	CCU2 Parts List	
AXXXII	CS1 Parts List	1
AXXXIII	I/O Parts List	
AXXXIV	Chassis and Miscellaneous Parts List	
B1	Circuit Board Identifiers	
BII	Component Identifiers	
BIII	Designator Formats	,

### List of Terms

AB Address Bus

ALAT A address latch.

ALB A less than B (Comparison of bytes A & B)

ALU Arithmetic Logic Unit

AMD Advanced Micro Devices

AMUX A address mux

backplane Wiring between edge connectors

BAR Base Address Register

BLA B less than A (Comparison of bytes A & B)

BLAT B address latch

BMUX B address mux

BP Breakpoint

BRMUX Branch mux

CCR Condition Code Register (macro level)

CCU Computer Control Unit

CS Control Store

CSB Control Store Buffer

DB Data Bus

DBR Data Buffer Register: buffers DB to D inputs of Am2901's

DC Display code

DMA Direct Memory Access

EPROM Electrically programmable read-only memory

FP Front Panel

hex Hexadecimal

i Subscript used to indicate integer

IMUX Instruction mux: chooses input to 2901's

I/O Input/Output module

IR Instruction Register (CCU)

KYBRD Keyboard

L.S. Least Significant

MAB Microaddress Bus

macro Designation of the machine language level of operation

MAR Memory Address Register (MEM1)

MB Memory Bus

MBR Memory Buffer Register (ALU)

MCCR Micro Condition Code Register (ALU)

MDB Microdata Bus

MEM1 Memory module: main program storage

MEMFF Memory flip-flop: specifies read or write

micro The microprograms level of operation

microword Group of bits used to generate control signals

MIME Microprogrammable Minicomputer Emulator

MR. Mask Register (in Am2914)

MLC Micro Loop Counter (CCU)

MPMUX Mapping mux

MPROM Mapping PROM

MSKB Mask Buffer: buffers PL 63-56 to DB

M.S. Most Significant

MSP Miscellaneous Signal Panel

MTCM Micro Test Condition Mux (ALU)

mux Multiplexer

N.A. Not Applicable

PC Program Counter

PL Pipeline Register (CCU)

POLMUX Polarity Mux (CCU)

Q register in Am2901's

RAM Random Access Memory

Ri One of 16 2-port RAM locations in Am2901's

DFF Direction Flip-flop (I/O)

SRT. Status Register (Am2914)

TCM Test Condition Mux (ALU)

TCRB Test Condition Register Buffer (ALU)

WCR Word Count Register (I/O)

YBFR y Buffer: buffers output of Am2901's to DB

#### Abstract

This report addresses the design and fabrication of a microprogrammable, general purpose minicomputer specifically configured

(AFIT's Digital Engineering Laboratory).

for use in an educational environment, In order to have utility
as an instructional aid in the areas of computer control and microprogramming, it was determined that such a machine must have the
following attributes: educationally oriented human interface,
educationally oriented design, and user-microprogrammability. These
high level attributes were then used as a basis for deriving
functional and detail requirements. The Am2900 Bipolar Microprocessor
Family was used as the basis for realizing the design which satisfied
the defined requirements.

The project resulted in hardware which was used by students in digital engineering classes and laboratory to investigate microprogramming and its application to emulation. This report includes representative microcode necessary to emulate sample PDP-11/03 instructions as a demonstration of MIME capabilities.



#### I. Introduction

One of the most powerful and flexible techniques to emerge from the continuing evolution in digital technology has been microprogrammed computer control. The Air Force interest in this technique results from its widespread commercial adoption and its potential for simplifying problem solutions and giving equipment inherent flexibility to meet changing requirements. Thus, microprogramming has become an important facet in understanding and utilizing current digital technology.

This investigation was largely motivated by experiences gained during digital engineering class and laboratory work having computer control and microprogramming techniques as a major topic. The title for this thesis and the hardware which resulted from it was chosen both because it was an approximate mnemonic for Microprogrammable Minicomputer Emulator and because the meaning of the word mime (i.e. to act a part or to mimic) was appropriate to the capabilities of the envisioned machine. For a comprehensive discussion of microprogramming the reader is referred to the many texts (e.g. Ref 1) on the subject as well as current literature (e.g. Ref 2). However, the presentation of a few key concepts is necessary to provide a basis for understanding the purpose of the project and the approach taken by the authors.

## Microprogramming

In order for a computer to accomplish data processing, a series of sequential and combinatorial events must be controlled in a specified manner. This controlling function may be accomplished by either of two principle broad techniques: use of random logic or microprogramming.

Random logic control is implemented by providing a unique group of logic circuitry which accepts each instruction, the status bits, and the clock pulses as inputs and outputs the various latch and bus gate settings as well as control pulses to the active elements. Thus, the machine instruction set implemented by the computer and the functions it performs are fixed by hardware. The lowest level of control afforded to the user is the machine language operations (i.e. add, shift, move, etc.).

Microprogramming may be defined as a technique for designing and implementing computer control as a sequence of control signals stored in a special memory as opposed to having them generated by hardware. Each group of bits is called a microword and the bits of these words represent signal states necessary to accomplish the information transfers which make up the machine instruction operations. This technique allows the user to exercise control to the level of individual register transfers which are the fundamental computer operations.

Not only does microprogramming implement control at the register transfer level, it also contrasts with random logic in that the control may be changed without hardware modification. Thus an inherent flexibility exists to meet changing requirements without hardware redesign.

Microprogramming techniques may be viewed as covering a spectrum with non-encoded and highly encoded techniques at opposite ends. Strict application of the non-encoded technique requires the microword to contain a bit that corresponds to each function which is to be controlled. Thus, the word tends to be lengthy but rather simple. Conversely, various microword bits may be grouped together into fields associated with specific functions. One or more levels of decoding may then be required in order to derive the actual control signals from the functional fields in the microword. In actual practice it is often expedient to use a combination of both techniques.

#### Problem Definition

The objective of this investigation is the design and fabrication of laboratory equipment specifically configured for use in graduate level investigations in the areas of computer control and microprogramming. Units currently available for laboratory experiments consist of commercial off-the-shelf minicomputers and microprocessor equipment. However, no unit totally combines user microprogrammability with a design philosophy meant to facilitate user understanding.

#### Background

The authors encountered the above problem in the Minicomputer/
Microprocessor Laboratory course, EE 6.87. This course has the
objective of providing the student with an understanding of the input/
output information transfers and interfaces required in minicomputer
and microprocessor operations. In addition; it is desired that the

student acquire the ability to design and utilize I/O transfers.

Because of a desire to learn about microprogramming and also to work with state-of-the-art technology at the integrated circuit level, the authors chose the Advanced Micro Devices 2900 Learning and Evaluation Kit (Ref 3) as the object of their laboratory project.

The Am2900 integrated circuit family consists of bipolar Large Scale Integration (LSI) devices designed for use in microprogrammed systems (Ref 4:2). The devices are cascadable in four-bit increments, thus allowing the word length and addressing capability to be tailored to the intended application. The reader is referred to the Am2900 Bipolar Microprocessor Family Data Book (Ref 4) for complete information.

In order to utilize the kit in realizing the EE 6.87 objectives, it was decided to interface one kit to act as the control unit for I/O occurring in the second kit. Although the authors were successful in causing one kit to operate under the microprogrammed control of the other, the ultimate goal of exploring I/O transfers was not achieved.

Literature provided with the kit stated that it was primarily intended to familiarize the user with the characteristics and performance of the Am2900 Family and microprogramming (Ref 3:1). However, because of the difficulties encountered in interfacing the two kits, the authors concluded the kits were not suited for investigating microprogrammed computer control. These difficulties were in the general categories of signal inaccessibility (for both monitoring and interfacing), limited displays, tedious programming, and limited memory.

Even though the ultimate goal was not realized, the authors gained valuable insight into microprogramming and how its utility might best be

demonstrated. These ideas resulted in the proposal of this thesis topic.

#### Goal

The goal of this investigation is to provide the AFIT Digital Engineering Laboratory with a small microprogrammable digital computer having a generalized architecture and a configuration tailored specifically for educational purposes. This unit will be suited for use in laboratory instruction and student design projects in the areas of computer control and microprogramming. In addition to the hardware, a User's Manual and sample microprograms will be provided.

#### Plan of Attack

The effort consisted of several major phases:

Literature search
Minicomputer survey
Requirements definition
Design
Fabrication
Integration and checkout
Documentation

The first objective of the literature search was to determine whether any previous work was relevant to the problem. The second objective was to clarify the concepts of microprogramming and emulation.

The second step of the effort was to obtain information about typical minicomputer architectures. The PDP-11, Nova, and HP21MX were chosen for detailed analysis as they were three of the most frequently

used machines in the military research and development environment and were representative of commercially available architectures. These three units along with a suggested design presented in Advanced Micro Devices (AMD) literature (Ref 5) served as the basis for deriving a generalized architecture for MIME.

The purpose of the requirements definition was to translate the overall goal into the technical requirements which when satisfied would provide a solution to the stated problem. A top-down approach in which each level of requirements was factored into successively lower levels was applied until there was sufficient detail to allow hardware design.

At various points during the design, trial circuits were breadboarded and analyzed to verify that they in fact fulfilled the requirements. When the design was found to be deficient, the design was iterated and then reverified. Redesign also occurred as the result of discovering invalid assumptions about module interfaces.

After first generating an overall functional design, the individual module design was begun. The order of the detail design was predicated upon the philosophy of providing a means of hardware checkout as soon as possible and retaining the greatest flexibility as long as possible. This resulted in the design of the control panel being accomplished first, the processor and memory modules next, and the control unit last.

Because of time constraints, fabrication and design were overlapped.

As detail design on each module was completed, fabrication on that module was begun. Because of the degree of flexibility incorporated into the functional design, no serious problems arose from this approach.

Integration and checkout were accomplished on an incremental basis. Each module was audited for physical conformance to the documentation prior to entering module test. The module test essentially verified the proper signal flow through the module. In order to minimize isolation problems, integration was accomplished on an incremental basis. As each module was added to the mainframe, the appropriate functions were verified. Detailed module test procedures may be found in Appendix A, MIME User's Manual.

Documentation was also accomplished incrementally throughout the entire project. The documentation was required to reflect the configuration of both the design and fabrication at all times and to facilitate the understanding and use of MIME.

## Organization of Thesis

Chapter I has introduced the problem and goal and has provided the background information necessary for understanding and evaluating the investigation. Chapter II and III contain the MIME functional and detail requirements respectively. These requirements served as the project specification during MIME design. Paragraphs in these chapters are numbered to facilitate correlation of the detail requirements with the functional requirements. Appendix A, MIME User's Manual, includes operating procedures, schematics, and a parts list which provide details of the hardware implementation. Chapter IV illustrates the application of microprogramming to an emulation problem. Chapter V presents the project results, conclusions, and recommendations.

Appendix B presents the details of the configuration management procedures used during the project and provides sample documentation.

Because of their volume, the wiring tables were not included in this document, but they are available at the School of Engineering, AFIT/ENG, Electrical Engineering Laboratory, Wright-Patterson AFB, OH 45433.

## II. Functional Requirements

2.0 Introduction. The contents of the Problem Definition and Goal sections were formalized to succinctly state the top level MIME requirement as an educationally oriented, user-microprogrammable small general purpose digital computer. This statement included three distinct facets. In order to insure that the final product would be appropriate for an educational environment, it was necessary that its intended application be given primary consideration throughout the design phase. Secondly, providing the user with the capability to microprogram MIME entailed specific design requirements in the computer control section. Lastly, it was necessary to generalize the architecture in order to design MIME to have a general purpose capability. Thus, three categories of subordinate requirements were identified. They are educationally oriented design requirements, user-microprogrammability requirements, and generalized architecture requirements. Each of these was then factored into component requirements at the next lower level and the process repeated until the functional requirements had been identified. The purpose of this chapter is to present the development of the functional requirements that must be fulfilled by MIME in order to accomplish the project goal. The hierarchy of functional requirements is shown in Figure 1.

The Problem Definition phase specifically addressed the need for laboratory equipment specifically configured for use in investigating computer control and microprogramming. Thus, it is intended that MIME

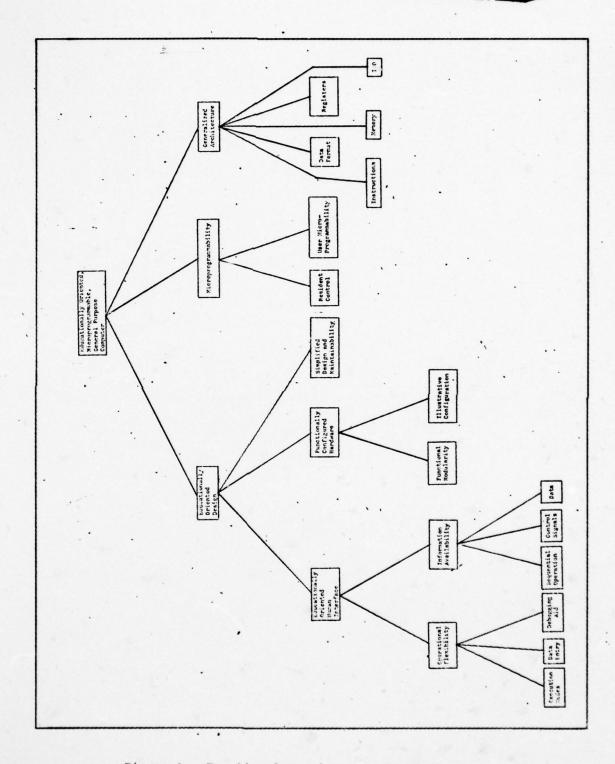


Figure 1. Functional Requirements Hierarchy

should have the capability to familiarize the user with basic principles of computer control and to demonstrate the applications and flexibility of microprogrammed control. Subsequently, MIME must allow the user to test his understanding by executing his own microprograms. This reflects the authors' opinion that in order for MIME to have utility in this area, it must contribute both to the user's understanding of theory and to his application of practical techniques.

Although MIME was conceived as a solution to a specific problem, it was also desired that it have potential for additional applications. The required data transfers are one facet to be considered in determining whether or not a computer is suitable for a particular application. These in turn dictate what data paths must be available in the computer hardware. Thus, the fact that it was desirable for MIME to be general purpose required that the architecture allow the implementation of an many types of transfers as possible.

In order to limit the scope of investigation, it was necessary to define the generalized architecture to be that which would allow implementation of a specified set of operations. As indicated in the Plan of Attack in Chapter I, the capabilities of three small commercial digital computers and an example from AMD literature constituted that specified set.

2.1. Educationally Oriented Design. Regardless of whether MIME is employed as a demonstration tool or as a test-bed for microprograms, the user must be able to provide stimuli to MIME and observe the response. The structure of MIME must allow the user to visualize the interaction of the hardware and firmware, and the hardware itself must be as simple as possible.

An educationally oriented design also includes maintainability considerations such as fault isolation and component replacement. Thus, the requirements for an educationally oriented design were divided into the categories of an educationally oriented human interface, functionally configured hardware, and maintainability considerations.

2.1.1. Educationally Oriented Human Interface. The interface between the user and MIME must allow straightforward and convenient interaction between them. It must be straightforward in order that the user is not frustrated by the effort required to use MIME. Convenience is necessary so time required for data entry or retrieval is minimized.

Because of the importance of the human interface, it was designated as a major MIME function and its design was undertaken first. This approach was also advantageous in that the requirements relative to other MIME modules would be available before they were designed.

2.1.1.1. Operational Flexibility. The operational flexibility requirement addresses the need for MIME to allow the user to accomplish his purpose with minimal laboratory setup or initialization. Thus, time available for realizing learning objectives is maximized.

2.1.1.1.1. Execution Modes. Depending on his objectives, a user may employ MIME in one of several ways. For example, he may desire to run an applications program, investigate a specific control sequence, or test a microinstruction. Thus, execution modes to support these objectives are required.

- 2.1.1.1.2. Data Entry. In order to enhance operational flexibility, it is required that MIME provide a front panel data entry capability. The user shall have the capability to select the level and type of information to be entered.
- 2.1.1.3. Debugging Aid. Because MIME will be used in an experimental environment, features that will facilitate software and firmware debug are desirable. Therefore, MIME shall provide means to monitor software and firmware program flow.
- 2.1.1.2. Information Availability. It is required that information concerning MIME control signals, sequential operation, and data processing be readily available to the user. In addition, because user-microprogrammability allows MIME to be controlled at the register transfer level, commensurate signal availability is required. This information is necessary in order to present a comprehensive picture of MIME operation and allow the data flow to be monitored. It is required that this information be clearly identified to avoid confusion.
- 2.1.1.2.1. Sequential Operation. In order for the user to understand the sequential nature of computer operation, information identifying the machine state at any arbitrary time is required. This illustrates the logical flow of the processing.
- 2.1.1.2.2. Control Signals. Control Signal availability is required to demonstrate the mechanisms by which data transfers are initiated and controlled. The user must be able to determine whether failure of an attempted operation was due to improper control signals or system malfunction.

- 2.1.1.2.3. Data. It is required that all data locations be accessible to the user at any time during MIME operation. This information is required to allow the user to observe intermediate computation and processing results.
- 2.1.2. Functionally Configured Hardware. The requirement for functionally configured hardware expresses the authors' philosophy that, from an educational viewpoint, a computer system is most easily understood when functions can be uniquely associated with discrete hardware. This requirement allows advantage to be taken of the fact that most students are introduced to digital processing and computer hardware by means of a functional block diagram. These diagrams typically contain five functional units: Arithmetic, Control, Memory, Input, and Output (Refs 6:27, 7:3). This approach facilitates visualization of the data processing and transfers in terms of hardware.
- 2.1.2.1. Functional Modularity. It is required that the hardware be segregated according to the major function which it supports in order to facilitate the association of the hardware with the function being performed. The required modules shall be determined from the functional grouping of the detail requirements specified in Chapter III.
- 2.1.2.2. Illustrative Configuration. Hardware implementation of MIME functional requirements shall facilitate the visualization and understanding of the function being performed. Consistent with educational purposes, MIME configuration shall be representative of commercial architectures and functional implementations in order to illustrate current hardware design approaches.

2.1.3. Simplified Design and Maintainability. It is required that the MIME design be the least complex which can perform all the specified functions. It is the authors' opinion that unnecessary sophistication would only obscure the fundamental principles which MIME is intended to demonstrate. Therefore, only those functions which directly result from specified requirements shall be included.

The ease with which hardware malfunctions can be isolated and corrected is closely associated with design complexity. Ease of maintenance is important because it has a direct impact upon the availability of MIME for use as an educational tool. Therefore, in addition to the requirement for a simplified design, MIME shall be structured to enhance the isolation of failures to the functional module. Signal visibility and accessibility shall also be provided to facilitate fault isolation to the component level. Specific troubleshooting procedures are included in the MIME User's Manual, Appendix A.

- 2.2. Microprogrammability. Microprogrammability requires that control of MIME be accomplished using microprogramming rather than random logic to decode and execute machine instructions. Motivation for inclusion of this requirement was discussed in Chapter I.
- 2.2.1. Resident Control. It is required that MIME include provision for nonvolatile microprogram storage. Thus, MIME can be used to demonstrate computer, operation under microprogrammed control without the necessity of loading a microprogram each time.
- 2.2.2. User-Microprogrammability. Provision for the user to apply microprogramming techniques to computer control must be included in

MIME. Therefore, it is required that MIME contain alterable microprogram storage accessible to the user.

2.3. Generalized Architecture. The initial step in defining the requirements for a generalized architecture was the determination of the functional requirements necessary to achieve equivalency to the capabilities of the PDP-11/03, Nova, HP21MX and AMD computers (Refs 8, 9, 10, 5). This analysis yielded four separate sets of characteristics and capabilities which were obtained with the aid of the following checklist (Ref 11):

Memory

Registers

Data

Instructions

Special Features

Program Status
I/O
Interrupts
Masking
Protection
Timers
States
Microprogrammability

These separate sets were then combined to form a single set describing the required MIME capabilities and characteristics. Within this set the following broad categories of requirements which are discussed below were identified: instructions, data format, memory, registers, and input/output. Each of these categories was analyzed to yield the factors that impacted MIME architecture.

2.3.1. Instructions. In order for MIME to have an instruction capability equivalent to the target machines, it must execute the following classes of instructions:

Program Control

Double Precision/Word/Byte
Arithmetic, Logic and Shift

Word/Byte Data Transfers

2.3.1.1. Program Control. MIME is required to execute both conditional and unconditional versions of the following classes of program control instructions: Branch, Jump, Jump to Subroutine, Trap, and Skip. Consequently, it is necessary that MIME have the capability to test all signals which are used conditionally by the target machine.

2.3.1.2. Arithmetic/Logic/Shifting. The arithmetic and logic instructions required for equivalency to the target machines are listed in Table I. The required shift and rotate capabilities are shown in Figure 2 and Figure 3 respectively.

Table I
Arithmetic/Logic Capabilities

Arithmetic	Logic
Add	AND
Subtract	OR .
Compare	EX-OR
2's Complement	Complement
Increment	
Decrement	

2.3.1.3. Data Transfers. In order to accomplish the previously discussed instructions, several types of information transfers are

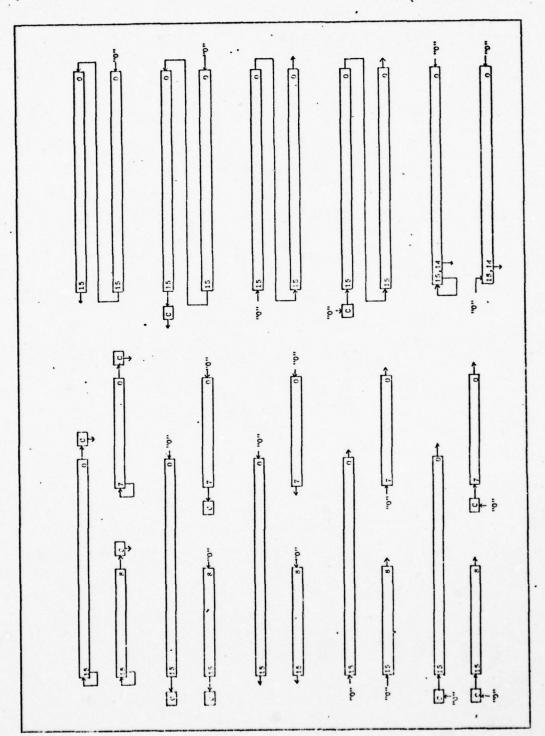


Figure 2. Required Shifting Capabilities

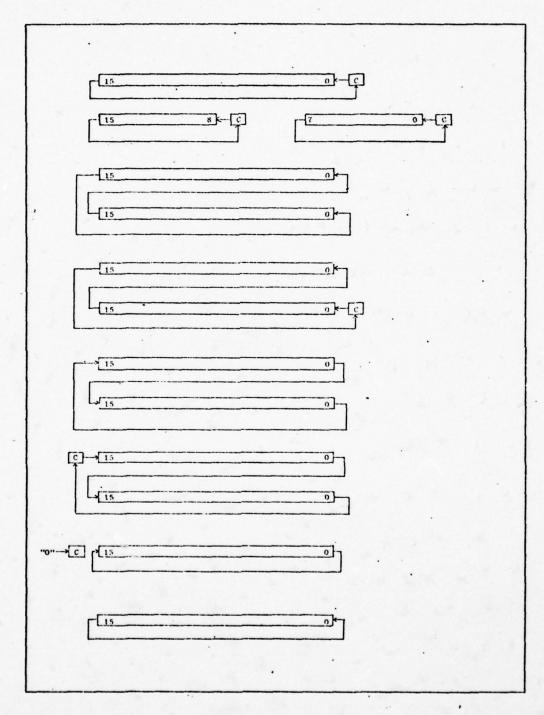


Figure 3. Required Rotate Capabilities

required. MIME must have the capability to control information transfers between itself and peripheral devices. In addition, MIME must be capable of internal register-to-register and register-to-memory transfers.

- 2.3.2. Data Format. A 16 bit word length and fixed point, sign plus 2's complement representation of negative numbers were common characteristics of the target machines. Because fixed point and 2's complement are a function of the instruction set capabilities, the only constraint upon MIME architecture was the 16 bit word length. Because a 16 bit word length was representative of the commercially available architectures and also provided sufficient precision for the intended application, MIME was required to have a 16 bit word length.
- 2.3.3. Memory. As a result of having a 16 bit word length, the addressing capability of the target machines was 64K words. In addition, they also included the ability to address individual eight bit bytes. MIME was required to include capability for a 64K X 16 bit word addressable memeory. Pseudo byte addressability results from the byte operation capability of the processor.
- 2.3.4. Registers. The target machines contained both general and special purpose registers. Special purpose registers consisted of those dedicated for use as a Program Counter (PC), Memory Address Register (MAR), Memory Buffer Register (MBR), and Instruction Register (IR), accumulators, indexing registers, and stack pointer. Also included in the target machines were a maximum of six general purpose registers. It was required that registers sufficient to fulfill the same functions be included in MIME.

2.3.5. Input/Output. Requirements under paragraph 2.1.1. specified that comprehensive data entry and display capability be included in the human interface in order to provide flexibility and convenience to the operator. However, paragraph 2.1.1. did not specify the capability desirable for loading complete programs into MIME using an assembly or higher order language. In order to provide the capability of interfacing with external devices, it is required that MIME be capable of performing DMA and vectored priority interrupt I/O information transfers.

#### Summmary

This chapter has presented the functional requirements determined to be requisite for meeting the project goal. These functional requirements will be used as the basis for the development of detail requirements presented in the next chapter.

## III. Detail Functional Requirements

- 3. Introduction. The purpose of this chapter is to provide the detail requirements which were derived to satisfy the functional requirements identified in Chapter II. This chapter is organized by functional categories in consonance with the functional modularity requirement of Chapter II. Table II illustrates the relationship between the functional and detail requirements.
- 3.1. Bussing. The target machines included both single and multiple bus structures. Because the required information transfers could be implemented in either structure, the architectural generalization imposed no constraints. However, it was the authors' opinion that separate busses would facilitate visualization of the information transfers. Thus, it was required that MIME include a Data Bus (DB), Address Bus (AB), Microaddress Bus (MAB), and Microdata Bus (MDB).
- 3.2. Front Panel. The requirement for a human interface shall be met by the MIME Front Panel (FP) module. It shall have the following characteristics and capabilities.
- 3.2.1. Debugging Aid. The FP shall provide a stand-alone capability without dependence on other MIME modules. It was desired that the FP always be available to the user without the necessity of having resident software or firmware.

Table II

Detail Requirements	Chapter III Paragraph	Chapter II Paragraph
AB, DB, MAB, MDB	3.1.	2.1., 2.1.3., 2.3.
Handwired FP	3.2.1.	2.1.1.1.3., 2.1.2.1., 2.1.3.
Power Control	3.2.2.	
Operating Modes	3.2.2.	2.1.1.1.1.
Hexadecimal Micro Data Entry	3.2.3.	2.1.1.1.2., 2.1.2.3.
Hex/Octal Macro Data Entry	3.2.3.	2., 2.3.2.
Register Load Capability	3.2.3.	2.1.1.1., 2.1.1.1.2.
Memory Location Load Capabil-	3.2.3.	2.1.1.1., 2.1.1.1.2.
Register Display Capability	3.2.4.	2.1.1.1.3., 2.1.1.2.2. 2.1.1.2.3., 2.1.1.2., 2.1.3.
Memory Location Display Capability	3.2.4.	2.1.1.1.3., 2.1.1.2.2., 2.1.1.2.3., 2.1.1.2., 2.1.3.
FP Display Registers	3,2,4.	2.1.1.2., 2.1.3.
State Indicators	3.2.4.	2.1.1.2.1.
Condition Code Indicators	3.2.4., 3.3.	2.1.1.1.3., 2.1.1.2., 2.1.3.
Test Points	3.2.4.	2.1.1.1.3., 2.1.1.2., 2.1.3.
Macro Breakpoint Registers	3.2.4.	2.1.1.1.3.
Word/Byte/Double Precision ALU	3.3.	2.3.1., 2.3.2., 2.3.3.
General Purpose Registers	3.3.	2.1., 2.1.3., 2.3.1., 2.3.4.
Auxiliary Shifting Register	3.3.	2.3.1.
Data Transfers	3.3.	2.1., 2.3.1.

Table II (Continued)

Detail Requirement	Chapter III Paragraph	Chapter II Paragraph
Microword Mask/Constant	3.3.	2.3.1.
Memory Capacity	3.4.	2.3.2., 2.3.3.
MAR, MBR	3.4.	2.3.3., 2.1.2.1., 2.1.2.2.
PC, IR	3.5.	2.1.2.1., 2.1.2.2., 2.3.4.
Decoding and Sequencing	3.5.	2.1., 2.1.2.1., 2.3.1.
Clock Generation	3.5.	2.3.
Mapping	3.5.	2.1., 2.1.1.2., 2.3.
Microinstruction Capabil- ities	3.5.	2.3.1.
Microinstruction Pipelining	3.5.	2.1.2.2.
Microbreakpoint Register	3.5.	2.1.1.1.3.
User Writable CS	3.6.	2.2.2.
Read Only CS	3.6.	2.2.1.
Vectored Priority Interrupt	3.7.	2.3.1., 2.3.5.
WCR, BAR, DFF	3.7.	2.1.2.2., 2.3.1., 2.3.5.
MIME Portability	3.8.	2.1.
Chassis	3.8.	2.1., 2.1.3.

Table III
MIME Operating Modes

Mode	Use	
RUN	Continuous automatic program execution	
Auto Step	Execute macroinstructions at an observable rate	
Single Step	Execute one macroinstruction on each manual actuation	
Auto Microstep	Execute microinstruction at an observable rate	
Single Microstep	Execute one microinstruction on each manual actuation	
Pause	Interrupts clock without changing state of MIME	
Reset	Reinitialize MIME for program start	
Halt	Halts program execution in the fetch state	

Because the FP could be independently verified to be operational, it could be used in the checkout of other MIME modules and trouble-shooting would be simplified.

3.2.2. Control. The FP shall provide means to control the application of power to MIME. It shall also allow selection of the operating modes given in Table III. These modes were required to provide the operational flexibility specified in 2.1.1.1.

Table IV
Displays

Macro Level	Micro Level	
All Registers	Micro Address	
ALU Output	cs	
DB	PL Register	
AB	Microbreakpoint Register	
Memory	Keyboard Entry	
Keyboard Entry		

3.2.3. Data Entry. Micro level data shall be entered in hexadecimal format in order to minimize the number of characters required for a microword. The user shall have the option of entering macro level data in either hexadecimal or octal format. An octal format is required for consistency with the target machines, but the hexadecimal format is required for future flexibility.

So that the operator is given as much flexibility as possible, the capability to load any register or memory location from the front panel is required.

3.2.4. Displays. In order to support the functional requirements of Chapter II, the FP shall provide the operator with the capability to selectively display the items listed in Table IV. This comprehensive display capability is required in order to provide visibility for all facets of internal MIME operations and facilitate malfunction identification. However, it is also desirable to limit the complexity

of the FP design and limit the quantity of information to that which can be easily assimilated by the operator. Thus, it is required that the FP include only one display register each for the macro and micro level.

The FP shall provide indicators which identify to the operator the source of the current display or the destination of the keyboard entry. This is necessary in order to avoid confusion between various parameters.

For display purposes, two of the general purpose registers shall be designated as breakpoint registers. This provision is a debugging aid which allows the operator to halt MIME when the contents of the PC and breakpoint register match. Although any of the general purpose registers could be used, two shall be designated for this purpose as a convenience to the operator. Indicators to advise the operator of the machine state and arithmetic condition codes are also required in order to provide the user with information concerning the processing status.

In order to enhance debugging capability as well as routine monitoring of MIME operations, it is required that any control signals not displayable on the front panel be accessible via test points for logic analyzer or oscilloscope display. These signals shall include clock, synchronization, and interrupt request signals.

3.3. Arithmetic Logic Unit (ALU). The processing requirements identified in Chapter II shall be fulfilled by the Arithmetic Logic Unit (ALU). This module shall contain a processor capable of performing 16 bit word, 8 bit byte, and double precision operations in accordance with paragraph 2.3.1. requirements.

The target machine processors include such special purpose registers as accumulators, index registers, and stack pointers, and as many as six general purpose registers. However, because each target machine has a different set of these special purpose registers, greater flexibility is obtained by using general purpose registers. General purpose registers are also required for the microprogrammer's use without disturbing the contents of registers currently in use of the macro level. Therefore, the ALU shall include 16 general purpose registers and 1 auxiliary shifting register.

It shall be possible to transfer data between the DB and general purpose registers and to obtain operands from the DB or registers. Results of operations shall be stored in the ALU registers or output directly to the DB. This allows the greatest possible flexibility for the user. The ALU shall also be capable of gating 16 bits of the pipeline onto the DB for use as a macro level constant or mask.

The ALU shall make available flags that indicate the results of arithmetic operations. These flags may be used by the Computer Control Unit as the basis for conditional branches. The ALU shall accept control signals which determine the type of operation, operand source(s), and result destination.

3.4. Memory. The Memory module shall provide for main program storage. It shall have a maximum capacity of 64K x 16 bit words. The module shall include a Memory Address Register (MAR) to latch the address of the memory location being referenced and allow either synchronous or asynchronous operation. The module shall also include a Memory Buffer

Register (MBR) to isolate the memory and DB from each other. The MBR serves to protect the memory and also facilitates the illustration of information flow during a memory reference. The MAR and MBR shall be implemented as discrete hardware registers to facilitate illustration of transfers and to allow hardwired signal accessibility. In order to simplify the module circuitry, the memory shall be static type random access storage.

3.5. Computer Control Unit. The Computer Control Unit (CCU) module shall exercise overall control over MIME operations and shall provide signals to control all information transfers. The CCU shall contain the Program Counter (PC) and Instruction Register (IR). The PC is required to hold the address of the currently executing instruction and the IR to contain that instruction. The PC and IR shall be able to act as either a source or destination for data relative to the DB. These registers shall be implemented as discrete hardware registers to facilitate illustration of their function and to allow hardwired signal accessibility.

The CCU shall provide decoding of macroinstructions, microinstruction sequencing, and control signal decoding. It shall also generate master clock pulses.

In order to provide flexibility, the CCU shall be able to map macroinstruction operation codes into microroutine starting addresses. Microinstruction sequencing capabilities of conditional branching, conditional looping, and four-level conditional nested subroutining are required to illustrate representative microprogramming techniques. To illustrate the pipelining technique of overlapping the fetch and

execution cycles, the CCU shall include first-level pipelining of microinstructions (Ref 12).

As a debugging aid to the microprogrammer, the CCU shall include a micro breakpoint register and provision for halting MIME when the microaddress matches the register contents.

3.6. Control Store. The Control Store (CS) module shall provide microprogram storage. It shall include both user-writable and read-only memory to allow user microprogrammability and resident control respectively. An input/output buffer shall interface the microdata bus with the CS.

3.7. Input/Output. The Input/Output (I/O) module shall handle all data transfers between MIME and external devices. It shall include an Input/Output Buffer (IOB) register which shall be used as the data interface with external devices.

The I/O module shall provide eight levels of vectored priority interrupt. Because MIME is intended for use in the educational environment, the authors do not foresee any occasion which will require more than eight levels of interrupt priority. In addition, the technique for handling more than eight levels remains essentially the same. Thus, the authors feel that eight levels provide sufficient capability and adequately demonstrate interrupt driven I/O. Therefore, MIME shall include provision for handling up to eight levels of vectored priority interrupts.

The I/O module shall notify the CCU of pending interrupts and identify the highest priority device requiring service by providing an interrupt vector. The module shall provide the capability for

interrupt nesting and selective interrupt marking. It shall be possible to display and load the registers containing the mask and status information. This provides the user access to the fundamental components of I/O processing.

The I/O module shall include a Word Count Register (WCR), Base Address Register (BAR), and Direction Flip Flop (DFF) for use in accomplishing DMA (I/O) transfers.

3.8. Chassis. MIME shall be self-contained, requiring only connection to 110 vac, 50-60 Hz for operation. It shall be housed in a portable cabinet configured to allow access to all internal components for troubleshooting and replacement. These requirements provide the flexibility needed for use in the educational environment. Cooling shall be provided by a chassis mounted fan.

## Summary

This chapter has presented MIME detail requirements by functional category which were derived from the functional requirements of Chapter II. The derivation may be traced using Table II and Figure 1. Hardware was then selected to implement the detail requirements as discussed in the next chapter.

## IV. Hardware Realization

### Introduction

Chapters II and III have presented the functional and detail requirements respectively which MIME was designed to fulfill. The detail requirements presented in Table II of Chapter III were then used as the basis for hardware design. This chapter presents an overview of the hardware realization and discusses the significant implementation choices. The reader is referred to Appendix A for a complete description of the hardware. Figure 4 illustrates the completed MIME hardware.

#### Architecture

Figure 5 contains a functional block diagram illustrating the MIME architecture which resulted from the functional grouping of the detail requirements described in Chapter III and summarized in Table II. MIME is a bus oriented, functionally modularized digital computer having the general characteristics summarized in Table V. The implementation of each module will be discussed briefly.

Front Panel. The FP was designed to meet the requirements specified in paragraph 3.2. Because of the quantity of parts required, it was physically implemented on two circuit cards. The displays and controls which form the cabinet front panel along with some logic circuitry were mounted on a circuit card designated FP1. The remaining components were mounted on a circuit card designated FP2. The reader is referred to Appendix A for a complete description of front panel operation.

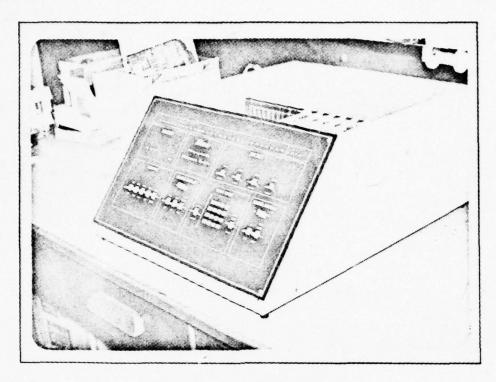


Figure 4. MIME Hardware

# Table V MIME Characteristics

16 bit data word 16 general purpose registers (16 bits) 10 special purpose registers (16 bits) machine instruction capabilities program control double/precision/word/byte arithmetic, logic, and shift word/byte data transfers 64K words main memory capacity synchronous memory references 8 levels vectored priority interrupt 64 bit microword 4K microwords Control Store capacity 1.43 MHz clock 110 vac, 50-60 Hz, 2 amps 21 amp @ 5 v 1.6 amp @ -5 v

2.4 amp @ 12 v

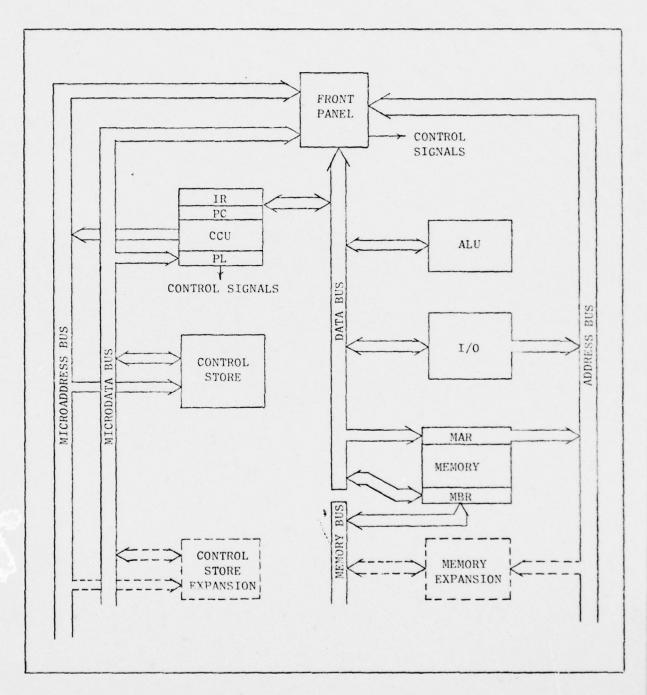


Figure 5. MIME Architecture

Arithmetic Logic Unit. The ALU circuit card contains all the circuitry necessary to meet the specifications of paragraph 3.3. The ALU is built around four Am2901 microprocessor chips (Ref 4:5-16) and includes various multiplexers and registers. It incorporates lookahead carry using the Am2902 (Ref 4:17-18).

Computer Control Unit. The CCU was designed to meet the specifications of paragraph 3.5. This module was also implemented on two circuit cards which were designated CCU1 and CCU2. The heart of the CCU capability results from the use of the Am29803, Am29811, Am2909, and Am2911 (Ref 12:2-2 to 2-21). These components provide the decoding, decision making, and sequencing capabilities required for the CCU.

Control Store. The CS module provides the microprogram storage specified in paragraph 3.6. and is contained on one circuit card designated CS1. It also includes the circuitry necessary for micro-address decoding. It consists of both RAM and EPROM storage for the reasons discussed in the detail requirements. In anticipation of CS expansion (See Recommendations, Chapter VI), this card was designated CS1, and an appropriate card rack position was left vacant for a second CS card.

Memory. The MEM module provides the main program storage for MIME and consists of RAM elements as specified in paragraph 3.4. It is designated MEM1 in anticipation of expansion and contains the circuitry necessary to decode addresses and implement the MAR and MBR.

<u>Input/Output</u>. The I/O module contains the BAR and WCR and provides eight levels of vectored priority interrupt as specified in paragraph 3.7. for use in accomplishing I/O transfers. The Am2914 (Ref 4:66-73) provides the interrupt capability.

## Parts Selection

There were a number of times during the design phase when more than one specific hardware implementation appeared capable of satisfying the specified requirements. When this occurred, it was necessary to determine the most desirable alternative. This section summarizes those choices deemed significant and the criteria applied in the decision process.

Am2900 Family. It would have been possible to consider microprocessor families other than the Am2900 series. However, the choice of the Am2900 integrated circuit family as the basic building blocks of MIME was the result of the following considerations: As indicated in Chapter I, the authors were familiar with it from a previous project. More significantly, the Am2900 family represented commercially available state-of-the-art technology, provided the most powerful capabilities available in microprogrammable microprocessors, and illustrated the use of bit-slice technology.

Control Store Memory Selection. In keeping with the requirement for flexibility specified in paragraph 3.6., the CS included both read/write and read-only storage. This approach allowed for both user experimentation and a nonvolatile resident control function.

Static type random access memory was chosen for the read/write portion of CS in order to minimize support circuitry required for dynamic RAM (Ref 13:3-19). Even though a read-only capability was required, it was still desirable to have the capability to alter the resident control or to implement additional instruction sets. Thus an electrically programmable, ultraviolet erasable, Programmable Read-Only Memory was chosen as the read-only portion of CS. It was also desired that the EPROM be

compatible with a Read-Only Memory (ROM) to allow substitution of ROM as an optional means of decreasing CS access time.

It was determined from commercial data that a representative instruction set required approximately 1K of CS for microprogrammed implementation (Ref 10:1-1). Thus, MIME was initially provided with 1024 words of EPROM storage in CS.

Because it was the authors' opinion that the writable CS would be used primarily for experiments and debugging, it was decided to provide only 256 words initially. Additionally, because CS is manually loaded from the front panel keyboard in hexadecimal format as specified in paragraph 3.2., it was felt that no more than 256 words would be utilized.

Selection of the actual memory chips involved tradeoffs among access time, bit density, pin configuration, and cost. It was necessary that the access time be sufficient to meet the overall timing goals discussed under Clock Considerations. Bit density and pin configuration were significant factors in minimizing the required circuit card area and it was desired to obtain the lowest feasible cost per bit.

Component Mounting and Interconnection. Wire wrap circuit boards with built-in IC sockets were used for all cards except FP1. These were mounted in a card rack and interconnected using edge and cable connectors. Augat 8136-URG5 cards were chosen for the following reasons:

- 1. Convenient IC replacement.
- 2. Built-in VCC and ground planes.
- 3. Large capacity edge connectors.
- 4. Rugged construction.
- 5. Available mounting rack.
- 6. Available extender card.

These characteristics were deemed desirable because of the one-of-a-kind nature of MIME and its intended laboratory use.

<u>Clock Considerations</u>. Information transfers between MIME modules are synchronously controlled using a single phase symmetrical clock. The decision to utilize synchronous transfers was considered carefully by the authors. Asynchronous transfers would have allowed MIME to operate at the fastest speed possible by basing the clock frequency on the fastest module and skipping clock cycles to accommodate the slower modules. A disadvantage of asynchronous operation was that it required additional logic to control the clock.

Synchronous operations base the clock frequency on the slowest operation which results in a simpler but slower machine. Table VI lists approximate speeds of the MIME modules which impacted this decision. The CCU/CS entries are the sum of CCU next microaddress computation time and CS access time. Thus, each CCU/CS entry is the total time required to compute the address of and fetch the next microword. This time is the minimum clock cycle utilizable with the particular CS implementation.

Based on this information, the fastest possible operation mode is achieved with a ROM CS implementation and asynchronous memory references. The slowest mode is achieved using synchronous operation with EPROM CS implementation. Approximate microinstruction execution rates are 3.33 MHz and 1.43 MHz respectively. The EPROM CS implementation was chosen and the substitution of ROM left as a potential enhancement. The required clock was therefore determined to be 1.43 ± 0.05 MHz. Provision for asynchronous control was included in the CCU to provide flexibility. This approach provided the simplicity desired for an educational environment and also the potential for future increases in operating speed.

Table VI

Module Cycle Time
(Approximate)

Modules	Cycle Times
ALU	300 ns
MEM	400
CCU/CS(EPROM)	675
CCU/CS(RAM)	475
CCU/CS(ROM)	300

#### Power Considerations

Power requirements were determined for each circuit card individually by summing the typical power requirements for each IC. All IC's required a VCC of plus 5 volts except the EPROM's which also required minus 5 and plus 12 volts. The voltage and current requirements are given in Table VII.

Power was distributed to each circuit card in the card rack (see Chassis section which follows) via the edge connectors and wire-wrap wire. No information concerning the current carrying capacity of 30 gauge wire-wrap was available so the authors experimentally determined that a single wire 12-18 inches in length could carry .5 amp over an extended time period without discernable heat build-up. The number of power connections to each card was then determined using .5 amp as the wire capacity and the requirements listed in Table VII.

Table VII

Power Requirements

	Voltage (v)	Current (amp)
FP2	5	2.0
CS1	5	1.5
CS1	-5	1.62
CS1	12	2.34
CCU1	5	1.9
CCU2	5	1.9
ALU	5	1.55
MEM1	5	6.0
1/0	5	2.05
FP1	5	4.3

Table VIII
MIME Cost Summary

FP1	\$ 668.00
FP2	243.00
ALU	295.00
MEM1	207.00
CS1	380.00
CCU1	250.00
CCU2	243.00
1/0	217.00
Wire	75.00
Extender Cord	58.00
Fabrication	
Electrical	3,200.00
Chassis	680.00
Chassis	
Card Rack	48.00
Edge Connectors	75.00
Ribbon Cable	10.00
Connectors	35.00
Fan	15.00
Miscellaneous	25.00
Total	\$ 6,724.00

#### Chassis

Figure 6 is a representation of the chassis configuration which was designed to satisfy the requirements of paragraph 3.8. The circuit card positions in the card rack are illustrated in Figure 7. All circuit cards are rack mounted except for FP1 which is directly attached to the hinged cabinet front panel. The optimum angle for the front panel is such that it is perpendicular to the user's line of sight (Ref 14:42). The actual front panel slope was determined experimentally based on anticipated bench top operation and the viewing angle for an individual of medium height.

The area at the rear of the chassis is reserved for installation of power supplies which are not yet available. The cabinet was vented and provision made for a chassis mounted fan in order to assure adequate cooling.

#### Cost

Table VIII contains a breakdown of the estimated costs for MIME.

The estimate for each circuit card includes the cost of the card and the components mounted on it. The estimated total costs for wire and fabrication are also included in Table VIII. Fabrication is divided into two categories: electrical and cabinet.

#### Summary

This chapter has presented a brief description of the MIME hardware that resulted from the design and fabrication effort. In addition, the areas of significant design decisions have been described. Appendix A contains the complete description of the hardware and operating procedures.

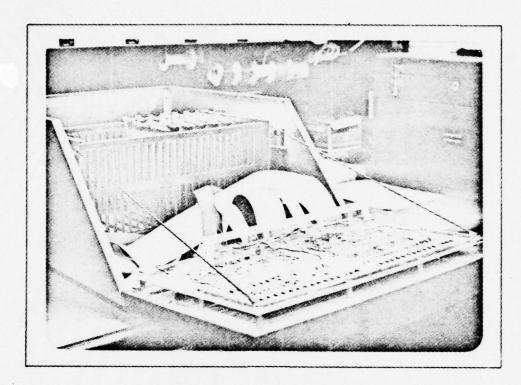


Figure 6. MIME Chassis

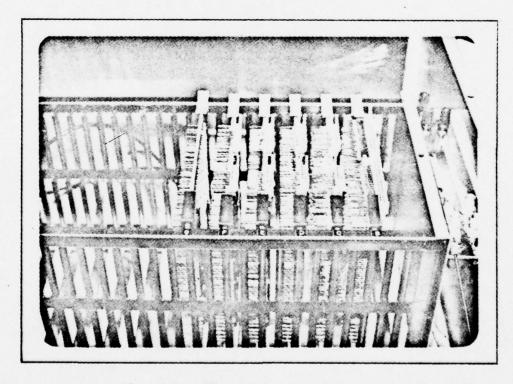


Figure 7. Circuit Card Positions

## V. Emulation Example

## Introduction

One significant application for microprogramming is emulation, which may be defined in a number of ways. It may be defined as the use of microprogramming to reproduce some of the hardware functions of the target machine not present on the host machine (Ref 15:265). Alternatively, emulation may be defined as the ability of one machine to execute the machine language instructions of another machine (Ref 16:15), or the combined hardware/software interpretation of the machine instructions of one machine by another (Ref 6:475).

Emulation is of interest in the military environment because of its potential for achieving software compatibility among different machines and mitigating the effects of rapid hardware obsolescence (Ref 17:29). The significance of emulation relative to the educational purposes of this project is the demonstration of the concepts of microprogramming applied to emulation. Although execution timing equivalency would also be required for a valid emulation in a realtime environment, it is not necessary for demonstration of the concept. Thus, the net effect of emulation would be the capability of running the target machine language programs on another machine with identical processing results. Therefore, for the purposes of this project, emulation has been defined as the ability of MIME to execute the machine instructions of another machine in a way such that the processing results are equivalent. The remaining sections of this chapter

discuss the relationship between emulation and microprogramming, a general approach to emulation, and a specific emulation example.

## Microprogramming and Emulation

A specific sequence of operations are necessary in order to execute each machine language instruction of a program. First, the instruction must be fetched from the memory. Then the op code portion of the instruction must be decoded to determine the desired operation.

Finally, the control signals necessary to accomplish the required transfers must be generated. The first two steps, fetch and decode, are essentially identical for all instructions of a given machine. The final step, control signal generation, is unique for each particular instruction. In a microprogrammed machine such as MIME, fetch and decode are controlled by a microprogram executive which branches to the particular micromodule (series of microinstructions) required to control the transfers of each machine level instruction. Thus, each machine instruction is implemented as a micromodule at the register transfer level.

In order to emulate a particular instruction set, the same three steps are necessary: fetch, decode, and execution. Emulation is possible only if the emulator hardware is capable of fetching and decoding the instruction controlling transfers within its architecture to arrive at results equivalent to those of the target machine. Thus, the first requisite for emulation is the availability of a versatile architecture, one which is in fact capable of the necessary decoding and processing.

Given this, one must devise a method of controlling the required register transfers in a flexible manner. As discussed in Chapter I, a

microprogrammable machine such as MIME has an inherent flexibility at the register transfer level. This gives the microprogrammer complete control of every information transfer possible within the emulator hardware and makes it possible to emulate equivalent register transfers of the target machine. Thus, the utility of microprogramming applied to emulation is readily demonstrated.

## General Approach to Emulation

Assuming that the emulator hardware is capable of emulating the target machine, the first step is to specify the high level microprogram flow necessary for instruction fetch, decode, and execution. The example shown in Figure 8 includes interrupt I/O handling as specified in paragraph 3.7.

The next step is to express the fetch, decode, and interrupt handling routines in Register Transfer Language (RTL). An example of this is included in the PDP-11/03 example at the end of this chapter.

Next, each machine instruction must be described in RTL. The authors found the following three step process useful:

- 1. Read instruction description in target machine handbook.
- 2. Represent target machine transfers in RTL.
- 3. Represent emulator transfers in RTL.

The most difficult step is the transition from target machine RTL to emulator RTL. There is, not necessarily a one-to-one correspondence between the transfers. The end result of the processing must be the same, but the intermediate steps may be different. This process must be repeated for each instruction of the target machine.

As the last step, the RTL for the emulator is converted to appropriate microcode. This, of course, may be done incrementally as each instruction is specified in RTL.

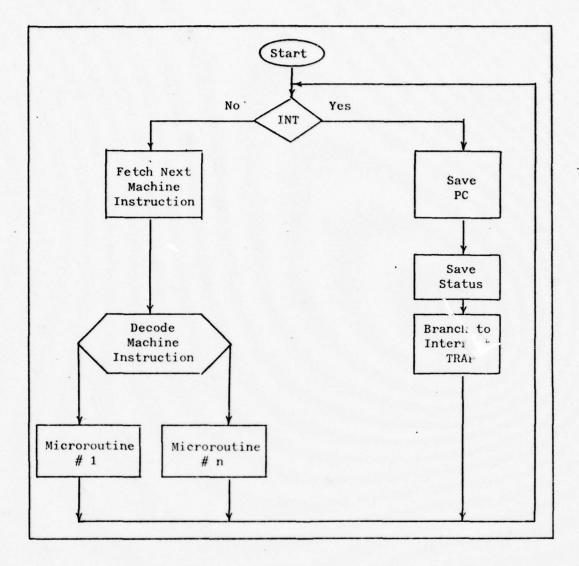


Figure 8. Microprogram Flow

## Emulation Example

In order to demonstrate the flexibility of microprogramming and its application to emulation, this section presents the emulation of several sample instructions using the MIME architecture. As discussed in the introduction to this chapter, emulation is considered to be the capability of MIME to execute the instructions of another machine with the same processing results.

Table IX
Sample PDP-11/03 Instructions

Instruction Type	Mnemonic	Instruction	Op Code
Single Operand	COM(B)	Complement Destination	/051DD
Double Operand	MOV(B)	Move Source to Destination	/1SSDD
Signed Condi- tional Branch	BGE	Branch if ≥ 0	002000
Program Control	RTS	Return from Subroutine	00020R
Trap	TRAP	Trap	104400 <b>–</b> 104777
			/ ÷ 1/0

As a result of the development approach discussed in Chapter I, the authors were familiar with the instruction sets of four minicomputers. Of these, the PDP-11/03 instruction set was considered to be the most flexible and powerful. Therefore, sample instructions for emulation were drawn from it (Ref 8:3.1-5.15). The particular instructions chosen are listed in Table IX. These were chosen in order to illustrate a variety of microprogramming techniques.

The authors used the approach discussed in the previous section to emulate the selected instructions. Therefore, the discussion of this example consists of two parts: High Level Microprogram Flow and Individual Instruction Modules.

High Level Microprogram Flow. The flowchart of Figure 9 shows the microprogram structure used to emulate the PDP-11/03. Each named

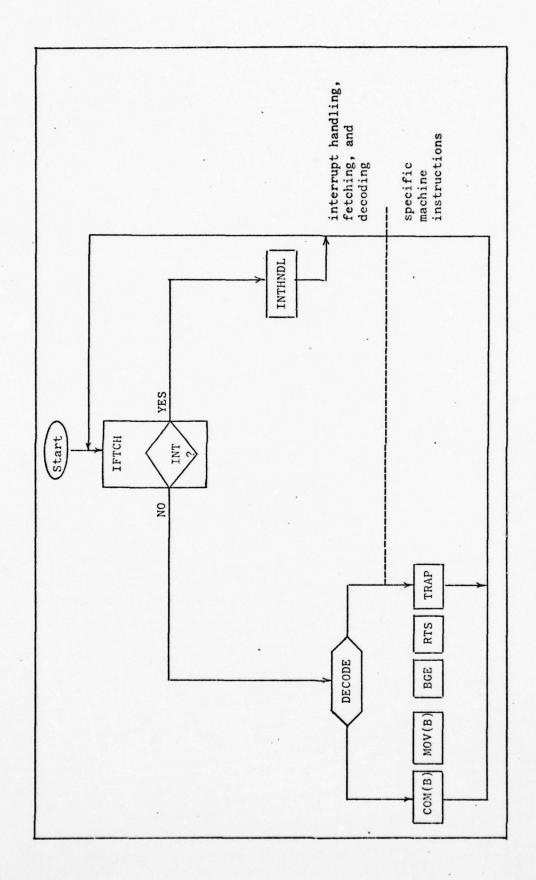


Figure 9. PDP-11/03 Emulation Structure

block represents a microcode module. Modules above the division line control interrupt handling, fetching, and decoding for all machine instructions. Modules below the line are unique to a particular machine instruction.

Emulation of a particular machine instruction begins with the Instruction Fetch module (IFTCH) which fetches the next instruction from memory if no interrupts are pending. As shown in Figure 10, IFTCH shifts the PC right one place before loading it into the MAR. This is necessary in order to map the PDP-11/03 memory address space into the MIME address space. The corresponding memory word is then fetched from memory to the MBR and subsequently loaded into the IR. The PC is then incremented by two so that it points to the next sequential instruction.

The DECODE module illustrated in Figure 11 controls the decoding of the instruction op code to arrive at the corresponding micromodule starting address. This is accomplished in part by using a PROM to map the op code portion of the IR into starting addresses of other micromodules. If the op code is octal 0002, IR bits 5, 4, and 3 are tested. If IR5,4,3, equals octal 0, a branch to the RTS instruction module is accomplished. Otherwise a branch is made to one of 16 condition code set/clear modules by testing IR bits 3, 2, 1, and 0. If the op code is octal 0000, IR bits 5, 4, and 3 are again tested. In this instance, if IR5,4,3 equals 0, IR bits 2, 1, and 0 are tested to control a branch to one of 8 instruction modules. An invalid instruction has been specified if IR 5,4,3 equals 0. If the op code is other than 0000 or 0002, the mapping PROM output is the starting address of a particular instruction module.

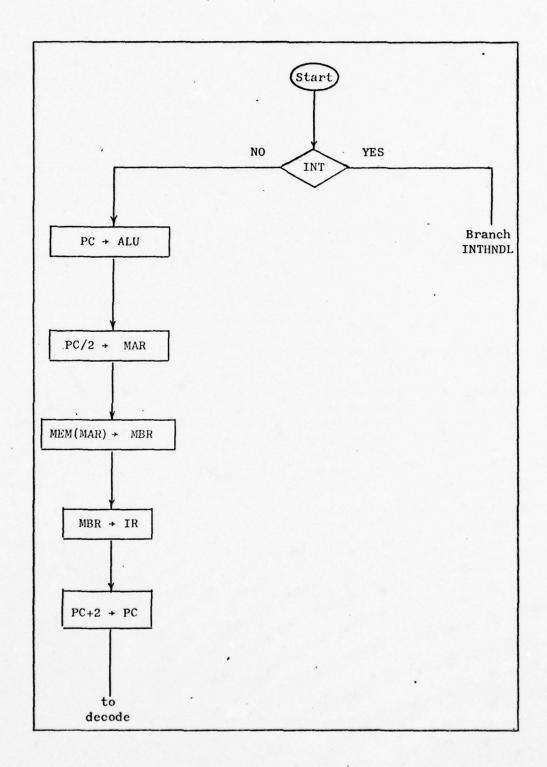


Figure 10. IFTCH Flowchart

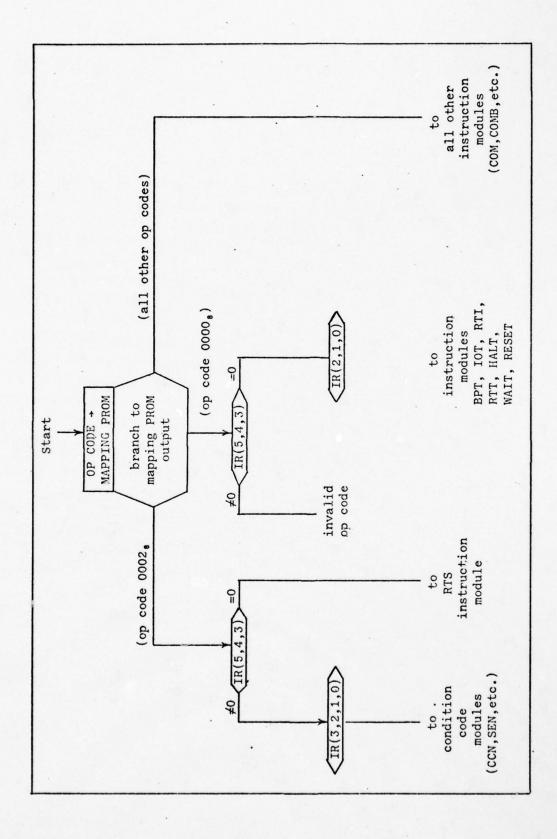


Figure 11. Decode

The Interrupt Handler (INTHNDL) module stacks the current PC and CCR in memory and loads a new PC and CCR from pre-assigned memory locations. The PC then contains the address of the first instruction of the machine language interrupt service routine. Referring to Figure 12, this is accomplished by first calling the micro subroutine PUSH. PUSH decrements R6 (used as the stack pointer) by two, loads the new contents of R6 into the MAR, stores the PC in the memory location addressed by the MAR, and returns. The PC is then stored in the memory addressed by R6. The CCR is similarly pushed onto the stack. The interrupting device is identified by an interrupt vector (IV2,1,0). This vector is used to branch to the particular module necessary to load the MAR with the address of the new PC. The new CCR is in the next sequential location. The PC now points to the machine language interrupt service routine. To execute this instruction, a branch back to IFTCH of Figure 10 is accomplished. After testing for higher priority interrupts, this instruction is executed using the emulation structure discussed in the preceeding paragraphs.

<u>Individual Instruction Modules</u>. The following paragraphs discuss the micro level modules used to implement the register transfers required for each emulated PDP-11/03 instruction of this example.

COM(B) replaces the word (byte) contents of the destination address with its logical complement. Using the decoding algorithm discussed in the previous section, COM and COMB are decoded to separate starting addresses. Thus, they will be discussed as separate modules. As shown in Figure 13, COM begins by calling the DSTDCD micro subroutine to compute and load the MAR with the effective address of the operand (memory reference mode). The reader is referred to the PDP-11/03

Processor Handbook for a comprehensive discussion of instruction formats

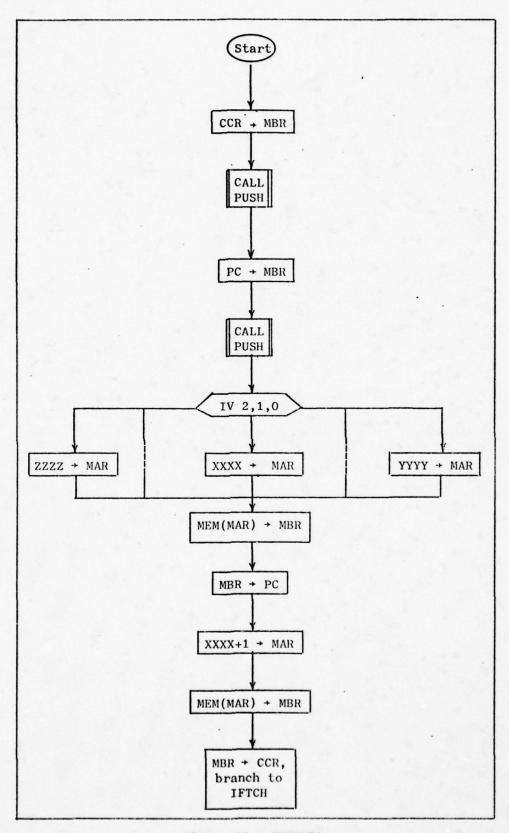


Figure 12. INTHNDL

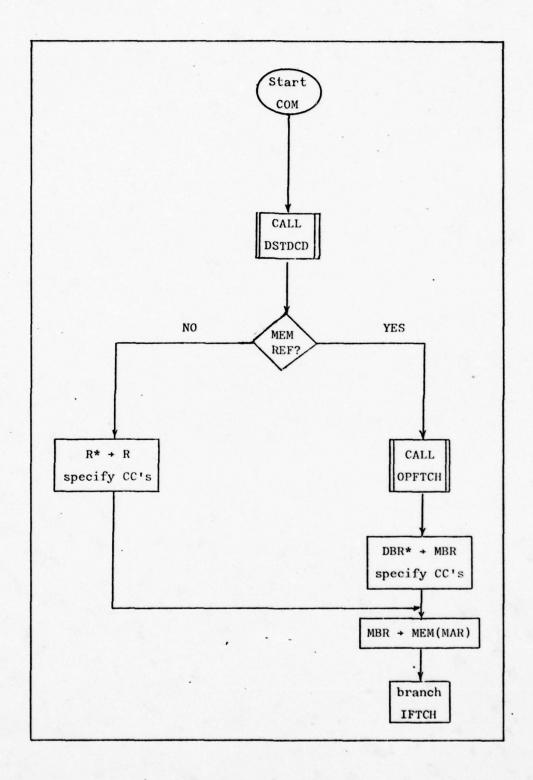


Figure 13. COM Flowchart

and addressing modes (Ref 8:3.1-3.19). If the operand is located in memory, micro subroutine OPFTCH is called to fetch the operand and load it into the ALU Data Buffer Register (DBR). The operand is then complemented and loaded into the MBR. Condition codes specified by COM are generated and stored in the CCR at this time. The MBR is then stored in the initial memory location. This completes execution of memory reference COM so the COM module branches back to the IFTCH. Register reference COM as shown in Figure 13 is similar to the memory reference, but it omits the memory read and write cycles. COMB is also shown in Figure 14. It differs from COM in that only the specified byte is complemented. Register reference implies lower byte, whereas the least significant MAR bit must be tested to find the applicable memory reference byte.

MOV(B) transfers the source operand to the destination location.

As shown in Figure 15, MOV calls SRCDCD to find the source operand.

OPFTCH is called if memory reference, resulting in the operand being loaded into the ALU DBR. Register reference operands are also loaded into the DBR. The operand is then placed in the Q register and appropriate condition codes generated. DSTDCD is called to determine the destination location, and the operand is stored accordingly. Finally, MOV branches back to IFTCH. As shown in Figure 16, MOVB differs in several respects. First, memory reference sources and destinations require testing to determine the pertinent byte. Second, the source byte must be aligned with the destination byte using SWABQ if they are not both upper or lower. In addition, only a single byte of memory is written into for memory reference destinations. Finally, MOVB requires sign extension through the upper byte for register destinations.

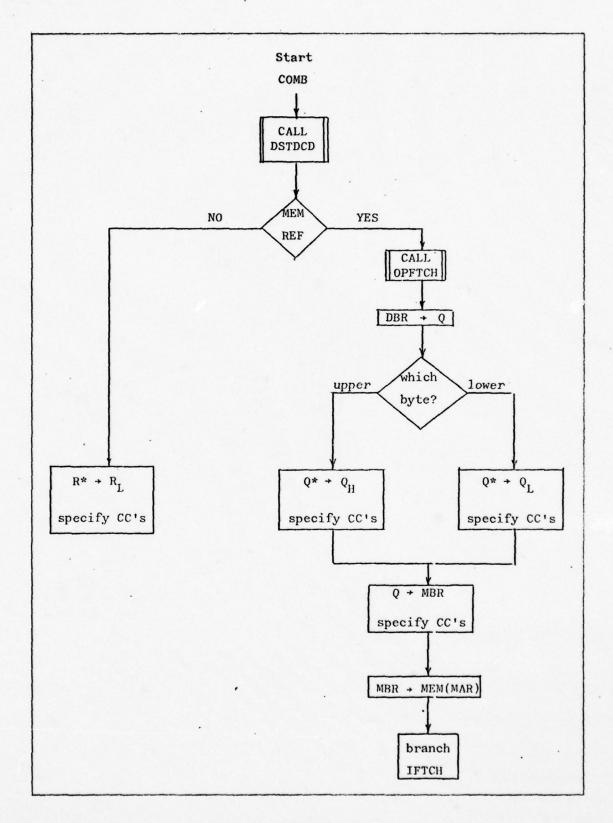


Figure 14. COMB Flowchart

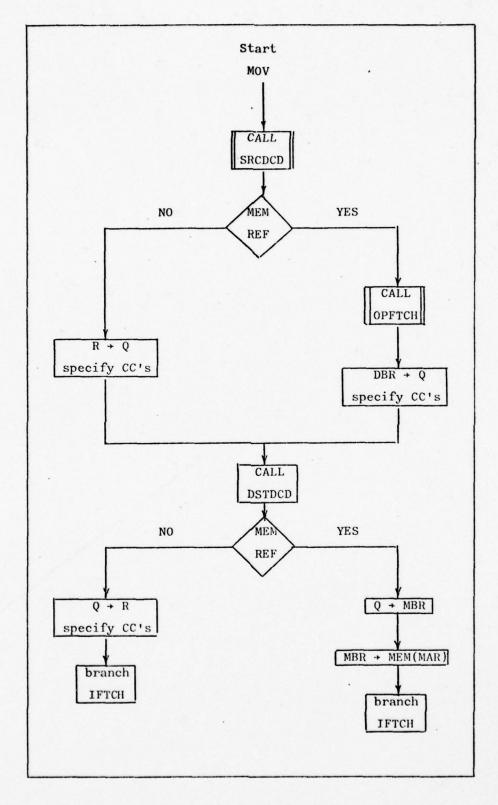


Figure 15. MOV Flowchart

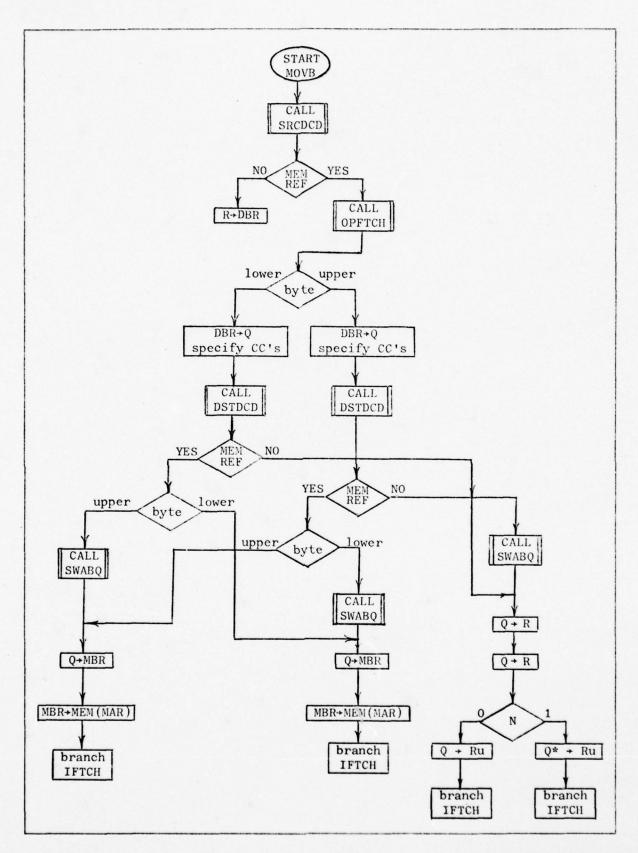


Figure 16. MOVB Flowchart

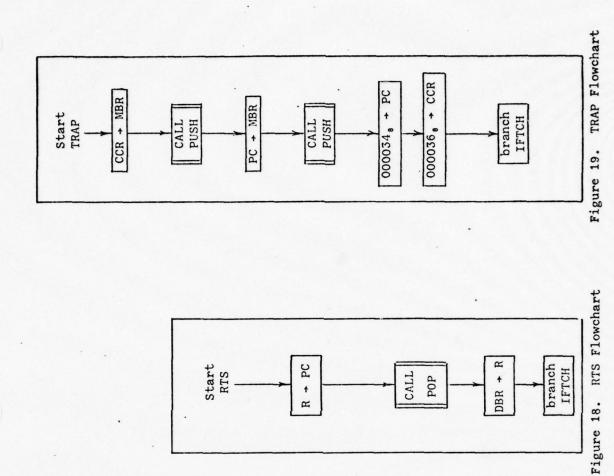
BGE is a conditional branch if greater than or equal to zero which adds two times the offset (sign extended) to the PC if condition codes N and V are both set or clear. The BGE module, shown in Figure 17, begins by testing condition codes N and V. If they are not both set or clear, the module branches back to IFTCH. Otherwise, the IR is multiplied by 2 and loaded into the lower byte of ALU general purpose register 13 (R13) while the PC is loaded into the DBR. Based on IR bit 7, the lower byte of R13 is sign extended through the upper byte. R13 is then added to the DBR which contains the PC and the result loaded back into the PC. Micro branching back to IFTCH allows the macro branch to occur when the new PC is used to fetch the next instruction, assuming no interrupt.

RTS, return from subroutine, loads the contents of the specified register into the PC, and pops the memory stack into the register. Referring to Figure 18, the RTS module first loads R into the PC and then calls micro subroutine POP to retrieve the top element of the stack. This is then loaded in the register and a branch to IFTCH initiated.

TRAP stacks the current CCR and PC and loads a new CCR and PC from memory locations octal 000036 and 000034 respectively. As shown in Figure 19 this is accomplished by twice loading the MBR and calling PUSH and then loading the PC and CCR with the required constants. As will be discussed further in Appendix A, these constants are stored as part of the microword.

### Summary

This chapter has presented a definition of emulation, discussed microprogramming as applied to emulation, and shown an emulation example using PDP-11/03 instructions and the MIME architecture. Appendix A contains details of the example emulation, including representative microcode.



Start

BGE

Dranch

IFTCH

Dranch

IFTCH

O O O 11

EXDBR + R13

PC + DBR

O TR7

DBR+A + PC

Hold CC'S

DBR+A + PC

DBR+A + PC

Hold CC'S

60

### VI. Results, Recommendations and Conclusions

### Results

The purpose of this section is to summarize the significant project results. However, these results were a product of the development approach chosen by the authors. Therefore, before discussing the results, factors that significantly impacted the development will be presented. Results of the hardware realization and emulation example will then be presented.

Development Factors. The literature search which was conducted as the first step yielded no evidence of previous work on a user-microprogrammable general purpose minicomputer specifically designed for educational purposes. It was found that several commercial products were available for use in microprocessor familiarization and microprogramming instruction (Ref 3:18). However, none included the scope of capability envisioned in the problem statement of the thesis. Therefore, the authors attempted to combine the best features of commercial equipment while adding features specifically designed to solve the stated problem.

A second factor of great importance to the development was the schedule estimates. When the schedule was devised, the specified goals were deliberately limited to provide schedule slack for unforeseen difficulties. This provision proved invaluable as a result of the underestimation of the logistics effort required in support of the primary project tasks. The principal components of the logistics effort consisted

of selecting and ordering parts and arranging for cabinet fabrication.

A probable parts list was compiled early in the requirements definition phase and regularly updated. This allowed difficulties to be identified in time to minimize their impact. The schedule slack originally included allowed time for parts delays and coordination with shop facilities on cabinet fabrication without ultimate impact on the project objectives.

The documentation generated throughout the effort was a third highly significant factor in the accomplishment of the design and fabrication. Three types of documentation were used to maintain configuration control: wiring tables, schematic drawings, and parts list.

The wiring tables presented a complete description of the configuration in terms of component pin numbers. The schematics provided a diagrammatical representation of the electrical connections. A complete parts list was maintained as a key to the designated component numbers.

The sheer volume of the wiring tables would have made their generation nearly impossible and their accuracy uncertain had it not been for the automated procedures described in Appendix B. The ready availability of this data facilitated corrections and modifications and minimized the problems encountered during integration and checkout. The FP module, which consists of two circuit cards, was a specific example. One card was designed and constructed before the configuration management procedures were fully implemented, but the design and fabrication of the other was fully controlled. During checkout of the FP wiring problems were encountered only in the first card.

Hardware. Chapters II and III presented the requirements and Chapter IV provided significant details concerning the hardware

implementation. Complete wiring tables, schematics, and parts list are included in Appendix A. Also included is the detailed test procedure which was devised to verify that MIME had met the requirements and was fully operational. The two basic test approaches used are described below.

The FP module was checked using test instruments to verify correct circuit operation. This consisted of either comparing a signal level or a waveform present at a particular point to that prescribed by the test procedures. The test order was designed so that each succeeding test was built on those previously successful. An unsuccessful test suspended the procedure until the fault was corrected.

After the FP was certified operational it was used to conduct the test procedures specified for the remaining MIME modules. These consisted of using the front panel capability to load or display various quantities and comparing the result to that specified by the test procedures. When a discrepancy occurred, the procedure was suspended and the fault isolated using the troubleshooting techniques and functional descriptions contained in the MIME User's Manual, Appendix A.

The successful completion of the test procedures demonstrated that the hardware was operational and that it met the specified requirements. These tests were conducted as the final step of the hardware checkout and the results recorded in a test log.

Emulation. One facet of the thesis goal specified in Chapter I was to provide the microcode necessary to demonstrate a representative sample of MIME's capabilities. The application of the emulation approach described in Chapter V required microcode to be generated in two areas:

for the implementation of the emulation structure discussed in Chapter V and for implementation of specific sample macroinstructions. For reasons discussed in Chapter V, PDP-11/03 instructions were used as test macroinstructions.

Test procedures consisted of entering the microcode into the CS and then attempting to execute the emulated instructions. After the execution of each macroinstruction the contents of the appropriate registers and memory locations were compared against the correct values specified by the procedure. The test results were recorded in the test log and the successful completion of the test demonstrated that this facet of the goal had been accomplished.

### Recommendations

The recommendations which resulted from this project fall into two categories: enhancements and applications. MIME has the potential for expansion and increased cpability with only relatively minor additions or modifications, and the authors recommend several. MIME was specifically created as an educational tool so the authors have recommended several applications where they feel MIME might best be utilized.

Enhancements. The enhancements recommended for MIME are in the following categories: Control Store, Memory, Arithmetic and Logic Unit, I/O, and Emulation.

Although only 1K of CS EPROM was initially provided, MIME had the capacity for a total of 4K words of CS. It is recommended that the CS be expanded to full capacity in order to allow more complex or multiple emulations to be resident in MIME. Multiple resident emulations would also require multiple mapping PROMS or physical substitution for each different emulation.

Substitution of Read-Only-Memory (ROM) for EPROM would increase microinstruction execution speed by a factor of two when operated in the asynchronous mode with a faster clock. It is recommended that the feasibility of doing so be investigated thoroughly before implementation. The increased speed could improve emulation performance or merely provide a greater potential for waiting.

MIME memory may also be expanded from the initially provided 1K to a maximum of 64K. Although a need for the total capacity is unlikely, it is recommended that memory be expanded to a minimum of 8K. This is the minimum that would be required to provide the capability of using operating system software written for the emulated machine (Ref 19: Sect. 2,1-1).

At the time parts were being selected for MIME, Advanced Micro Devices had just released data on a new microprocessor, the Am2903 (Ref 20). This chip represented a substantial increase in capability over the Am2901. For example, it includes hardware multiply and divide and provision for an expandable register file. However, its anticipated availability fell too late in the project schedule to allow it to be used. It is recommended that the feasibility of replacing the Am2901's in MIME with Am2903's be investigated.

Although an RS 232 interface has been provided (Ref 21), MIME has the capacity to handle additional peripherals. It is recommended that an interface for a mass storage unit such as a cassette be provided. This would expand MIME processing capability as well as provide a second example of an I/O interface.

As addressed earlier, only representative PDP-11/03 instructions were emulated and verified. In order to provide MIME with a complete

resident assembly language instruction set, it is recommended the emulation be completed and stored in the CS EPROM.

Applications. The authors feel that MIME will have greatest applications as the subject of student projects in support of the AFIT digital engineering/computer science curriculum. It is recommended that MIME and the system documentation be used in conjunction with lecture and structured laboratory instruction. MIME was designed for educational purposes, but the system documentation was written assuming that users will have a basic understanding of the principles of computer operation and architecture. Also, the system documentation does not include learning goals or experimental procedures. However, once they have been defined, the documentation does provide the user with all the information necessary for employing MIME to achieve his objectives. Therefore, in order for the user to obtain the greatest benefit, it is important that theoretical background and laboratory guidance be provided. It is anticipated that MIME will prove most useful in the following areas: support of course objectives in EE 6.87 (Ref 22:60) both directly and indirectly. It is an example of a general purpose minicomputer constructed using current LSI technology, and it can be used to demonstrate techniques of computer control and microprogramming applied to I/O processing. The analysis required to generate microcode for handling programmed, interrupt, and DMA type I/O transfers will contribute to the user's understanding and exploration of various I/O techniques.

MIME can be used for general purpose instruction in microprogramming

mailed to the many facets of computer control. An analysis of the micro
mailed to the many facets of computer operation should yield an

mailed to the many facets of computer operation should yield an

mailed to the many facets of computer operation should yield an

68

This discussion is also applicable to investigation of emulation with the addition of a specified instruction set as a target.

### Conclusion

The scope of this project included activities that on a small scale closely paralleled the Air Force development cycle (e.g. requirements definition, conceptual phase, design/cost tradeoffs, development, fabrication, test and integration, and turnover and transition). Because such a varied range of activities, encompassing both theory and practical application, was required, the benefit derived was much greater than anticipated.

MIME has been used as the subject of projects in support of two courses, EE 6.87 and EE 6.88 (Ref 22:60). The EE 6.87 project consisted of the design of hardware and microprograms necessary to implement an RS232 interface (Ref 21). This project allowed students to apply microprogramming as a means of controlling I/O transfers. The EE 6.88 project utilized MIME to familiarize students with the concepts and applications of microprogramming. This project consisted of having students emulate various minicomputers and microprocessors using the MIME architecture.

The degree to which MIME possesses a generalized architecture and is educationally configured is a subjective evaluation ultimately left to the reader. However, that MIME has utility for graduate level investigations in the areas of computer control and microprogramming was demonstrated by the projects discussed above. As a result, the authors have concluded that the objective of the investigation as stated in Chapter I has been accomplished.

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### Appendix A

#### MIME User's Manual

### Preface

MIME (Microprogrammable Minicomputer Emulator) is an educationally oriented, user microprogrammable, general purpose minicomputer. It was designed and constructed as a master's thesis project at the Air Force Institute of Technology specifically for use in laboratory instruction and student design projects in the areas of computer control, microprogramming, and emulation (Ref 1).

This manual has several purposes: describe MIME characteristics, provide the information necessary for effective utilization of MIME, and facilitate maintenance and modifications. Section I, System Description, introduces the architecture and system hardware, summarizes the possible information transfers, and concludes with detailed description of each functional module. Sections II and III provide operating procedures and microprogramming techniques respectively. Section IV concludes with maintenance information. A complete list of terms and abbreviations is included on page 77. The authors believe that MIME will provide valuable hands—on experience that will greatly contribute to the student's understanding of computer control and microprogramming.

## Contents

,						Page
Preface					•	. 70
List of	Tables					. 73
List of	Figures	• ,			•	. 75
List of	Terms	•		•	•	. 77
I.	System Description	•		•		. 80
	Introduction					. 80
	Architecture and Hardware					. 80
	Information Transfers					. 85
	Micro Level Transfers					. 85
	Macro Level Transfers					. 86
	Module Descriptions					
	Front Panel					
	CONTROL					
	MACRO DISPLAY					
	DATA ENTRY					
	MICRO DISPLAY					
	ALU					
	Memory					. 95
	Computer Control Unit					. 97
	Control Store					
	Input/Output					
	Chassis Details					
			•	Ť		
II.	Operation	•		•	•	.106
	Macroprogram Loading					.106
	Microprogram Loading					
	Program Execution					.106
111.	Microprogramming					
	Min					100
	Microword Fields					
	Microaddress Sequencer	•				
	Bus Destination	•				.108
	Bus Source	•				.112
	Command	•				
	ALU A and B Addresses					
	Input/Output		100			.112
	ALU Function, Source, and Destination					
	UB* and LB*					.112
	CC*					
	Micro Loop Counter Load					
	Microbranch Address					
	CENMUX, RMUX, and QMUX					.115
	I/OTC, ALUTC, CCUTC, and POL					.115

		CARI	RY,	, :	ZE	RO	,	0V	R,	a	nd	N	EG													115
		CIN																								119
*		Bran	ncł	1	Co	nt	ro	1 :	and	d i	Bra	an	ch	M	ux											119
		Cons	sta	an	t																					119
*		Microw																								
																										119
																										122
																										122
																										122
		Sample																								
		Emu]	lat	ii	on	St	tr	uc	tur	re																122
		Indi	ivi	di	ıa.	1 :	In	st	ruc	et:	ion	n I	Mod	du.	les	s .										129
		Summary																								
IV.	Mai	ntenand	e																							142
																	•									
		Introdu	ict	ii	on																					142
		Trouble																								
		Module																								
																										145
																										149
																										156
																										159
		MEMI																								
																										166
										Ĭ			•		•		•	•	•	•	•	•	•	·	•	
List of	Ref	erences								-																170
							Ť			Ť		•		•		•	•	Ť		•	•	·	•	•		
Appendix	x 1:	Schem	at	ii	es																					171
PP		2 2						•		•	•	•	•	•	•	•	•	•	•	•	•	•	•	•		
Appendi	x 2:	Parts	, I	is	st																					183
				-			-		-																	

# List of Tables

<u>Table</u>		Page
AI	MIME Characteristics	.82
AII	Circuit Card Identifiers	83
AIII	Microaddress Sequencer Field	110
AIV	Command, Bus Source, Bus Destination Fields	111
AV	Input/Output Field	113
AVI	Am2901 Processor Fields	114
AVII	Shifting Linkage Fields	116
AVIII	Test Condition Fields	117
AIX	ALU Condition Code Fields, Carry-In Field	118
AX ·	16-Way Branch Fields	120
AXI	Sample PDP-11/03 Instructions	124
AXII	Sample Microcode	. 141
IIIXA	Testpoint Array	143
VIXA	FP Test Equipment and MIME Setup	145
AXV	FP Tests	146
IVXA	CCU Test Equipment and MIME Setup	149
AXVII	CCU Tests	150
AXVIII	CS1 Test Equipment and MIME Setup	156
AXIX	CS1 Tests	157
AXX	ALU Test Equipment and MIME Setup	. 159
AXXI	ALU Tests	160
IIXXA	MEM1 Test Equipment and MIME Setup	163
AXXIII	MEM1 Tests	164
VIXXA	I/O Test Equipment and MIME Setup	166
AXXV	I/O Tests	167

AXXVI	FP1 Parts List	84
IIVXXA	FP2 Parts List	86
AXXVIII	MEM1 Parts List	86
AXXIX	ALU Parts List	87
AXXX	CCU1 Parts List	88
AXXXI	CCU2 Parts List	89
TIXXXA	CS1 Parts List	89
AXXXIII	I/O Parts List	90
AXXXIV	Chassis and Miscellaneous Parts List	90

# List of Figures

Figure	, <u>P</u> i	age
A1	MIME Architecture	31
A2	MIME Hardware	33
А3	Card Rack Mounting	34
A4	Card Positions	34
A5	Micro Level Transfers	86
A6	Macro Level Transfers	37
A7	FP Block Diagram	88
. A8	MIME Front Panel	9
A9	ALU Block Diagram	3
A10 .	MEM1 Block Diagram	6
A11	CCU Block Diagram	8
A12	CS Block Diagram	2
A13	I/O Block Diagram	13
A14	Microword Definition	19
A15	Representative Microword Formats	1
A16	PDP-11/03 Emulation Structure	3
A17	IFTCH Flowchart	5
A18	DECODE Flowchart	6
A19	INTHNDL Flowchart	8
A20	PUSH Flowchart	9
A21	COM Flowchart	0
A22	DSTDCD Flowchart	1
A23	DPCDCD Flowchart	2
A24	OPFTCH Flowchart	3
A25	COMB Flowchart	4

A26	MOV	Flo	wcha	rt	•	•	•	•	•		•	•	•	•	•	•	•	•	•	•	•	•	•	• •	135
A27	SRCI	OCD/	SPCD	CD	F1	.OW	ıch	aı	rt								••								136
A28	MOVE	B F1	owch	art	;				•.			•	•		•										138
A29	SWAI	3Q F	lowc	har	t	•																		•	139
A30	BGE	Flo	wcha	rt				• •				•	•			•								• .	140
A31	RTS	Flo	wcha	rt																					140
A32	POP	Flo	wcha	rt	•	•	•			•														•	140
A33	TRAF	P F1	owch	art	;	•					•	•	•			•		•	•	•	•				140
A34	FP1	Sch	emat	ic			•				•		•					•							172
A35	FP2	Sch	emat	ic	•	•	•		•			•			•	•		•					•		176
A36	ALU	Sch	emat	ic				•								•							•	•	177
A37	MEM1	l Sc	hema	tic	:							•			•		•		•						178
A38	ccui	l Sc	hema	tic	:	•			•			•										•		•	179
A39	CCU2	2 Sc	hema	tic	;	•	•								•			•						•	180
A40	CS1	Sch	emat	ic	•			•								•			•						181
A41	1/0	Sch	emat	ic																					181

### List of Terms

AB Address Bus

ALAT A address latch

ALB A less than B (Comparison of bytes A & B)

ALU Arithmetic Logic Unit

AMD Advanced Micro Devices

AMUX A address mux

backplane Wiring between edge connectors

BAR Base Address Register

BLA B less than A (Comparison of bytes A & B)

BLAT B address latch

BMUX B address mux

BP Breakpoint

BRMUX Branch mux

CCR Condition Code Register (macro level)

CCU Computer Control Unit

CS Control Store

CSB Control Store Buffer

DB Data Bus

DBR Data Buffer Register: buffers DB to D inputs of Am2901's

DC Display code

DMA Direct Memory Access

EPROM Electrically programmable read-only memory

FP Front Panel

hex Hexadecimal

i Subscript used to indicate integer

IMUX Instruction mux: chooses input to 2901's

I/O Input/Output module

IR Instruction Register (CCU)

KYBRD Keyboard

L.S. Least Significant

MAB Microaddress Bus

macro Designation of the machine language level of operation

MAR Memory Address Register (MEM1)

MB Memory Bus

MBR Memory Buffer Register (ALU)

MCCR Micro Condition Code Register (ALU)

MDB Microdata Bus

MEM1 Memory module: main program storage

MEMFF Memory flip-flop: specifies read or write

micro The microprograms level of operation

microword Group of bits used to generate control signals

MIME Microprogrammable Minicomputer Emulator

MR. Mask Register (in Am2914)

MLC Micro Loop Counter (CCU)

MPMUX Mapping mux

MPROM Mapping PROM

MSKB Mask Buffer: buffers PL 63-56 to DB

M.S. Most Significant

MSP Miscellaneous Signal Panel

MTCM Micro Test Condition Mux (ALU)

mux Multiplexer

N.A. Not Applicable

PC Program Counter

PI. Pipeline Register (CCU)

POLMUX Polarity Mux (CCU)

Q egister in Am2901's

RAM Random Access Memory

Ri One of 16 2-port RAM locations in Am2901's

DFF Direction Flip-flop (I/O)

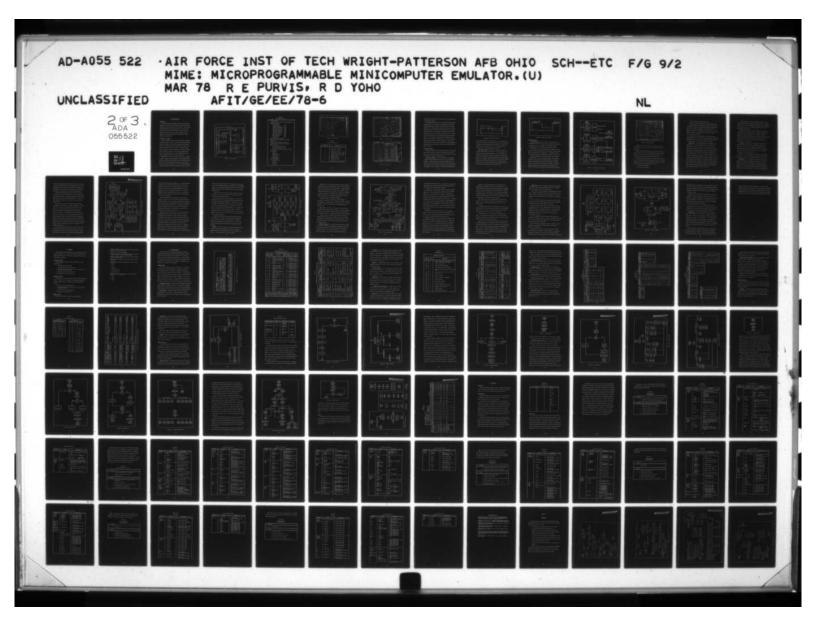
SR. Status Register (Am2914)

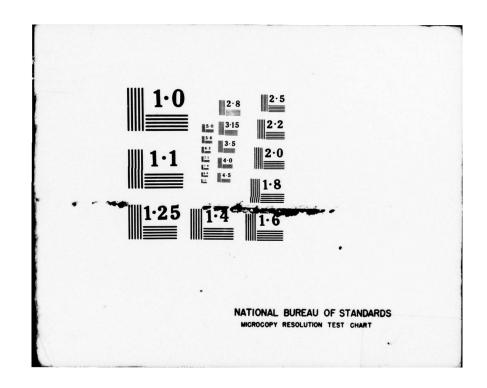
TCM Test Condition Mux (ALU)

TCRB Test Condition Register Buffer (ALU)

WCR Word Count Register (I/O)

YBFR y Buffer: buffers output of Am2901's to DB





### I. System Description

### Introduction

This section presents information necessary for understanding MIME operation, and it provides the basis for the operating, microprogramming, and maintenance sections which follow. The Architecture and Hardware subsection addresses MIME structure in terms of the functional modules and their organization; Information Transfers summarizes the data flow that is possible utilizing the MIME architecture; and Module Descriptions presents details of module implementation and operation.

### Architecture and Hardware

Figure A1 contains a functional block diagram which illustrates the MIME architecture. MIME is a bus oriented, functionally modularized digital computer having the general characteristics listed in Table AI. The functional modules are implemented on circuit cards having the designations listed in Table AII. The MIME hardware is shown in Figure A2. Except for Front Panel 1 (FP1) which is affixed to the cabinet front panel, all circuit cards are rack mounted as shown in Figure A3 and Figure A4. Terms and acronyms used in the manual are summarized in the list of terms on page 77.

MIME makes use of a 16 bit data word, Data Bus (DB), and Address Bus (AB) for register and memory transfers. The front panel module provides the operator with the capability to control MIME's operating mode as well as load and display macro (machine) level and micro level register and memory contents. The ALU performs the arithmetic/logic operations and contains the general purpose registers, the Data

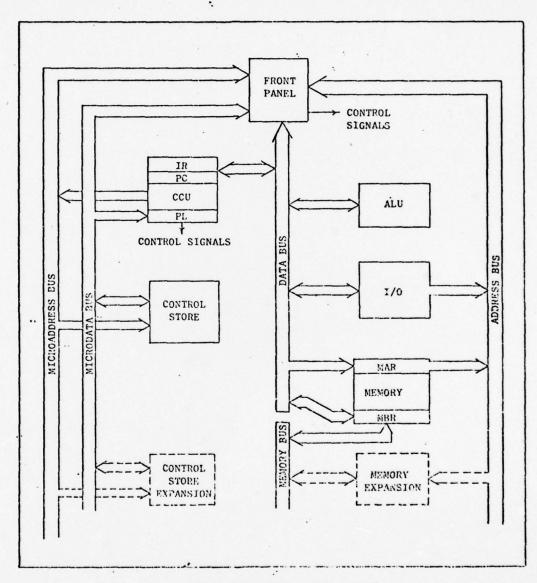


Figure A1. MIME Architecture

Table AI
MIME Characteristics

16 bit data word	
17 general purpose registers (Q, RO th	hrough R15)
Dedicated registers	
Program Counter (PC)	
Instruction Register (IR)	
Memory Address Register (MAR)	
Memory Buffer Register (MBR)	
Data Buffer Register (DBR)	
Condition Code Register (CCR)	
Base Address Register (BAR)	
Word Count Register (WCR)	
Status Register (SR)	
Mask Register (MR)	
64K words main memory capacity	
Eight levels of vectored priority into	errupt
1.43 MHz clock	
Synchronous memory reference operation	ns
4K microword maximum Control Store ca	pacity
64 bit microword	
12 bit microaddress bus (MAB)	
64 bit pipeline register (PL)	
8 bit micro condition code regis	ter (MCCR)
Operating modes	
automatic	
single step	
auto single step	
micro step	
auto micro step	
Power requirements	
110V, 50-60Hz, 2A	
21A @ 5V	
1.6V @ -5V	
2.4 @ 12V	

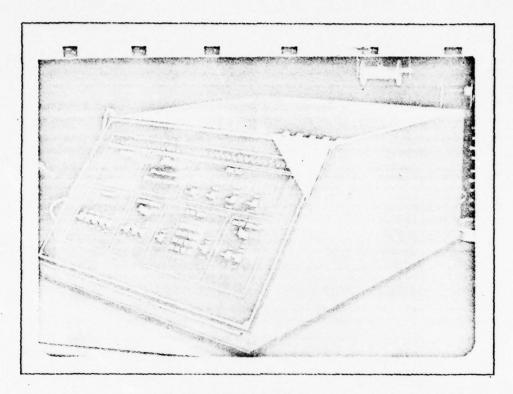


Figure A2. MIME Hardware

Table AII
Circuit Card Identifiers

Identifier	Circuit Card
А	Control Store 2 (CS2)*
В	Front Panel 2 (FP2)
С	Control Store 1 (CS1)
D	Computer Control Unit 1 (CCU1)
E	Computer Control Unit 1 (CCU2)
F	Arithmetic Logic Unit (ALU)
G	Memory 1 (MEM 1)
н	Input/Output (I/O)
Р	Front Panel 1 (FP1)
	* Reserved for future expansion

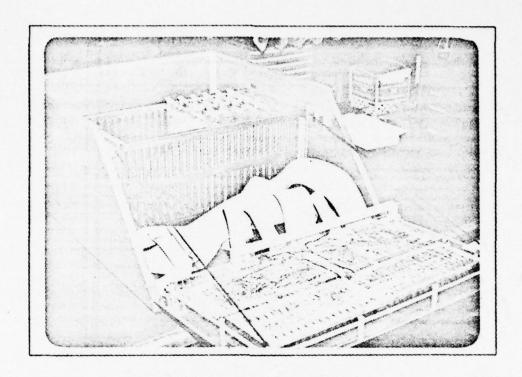


Figure A3. Card Rack Mounting

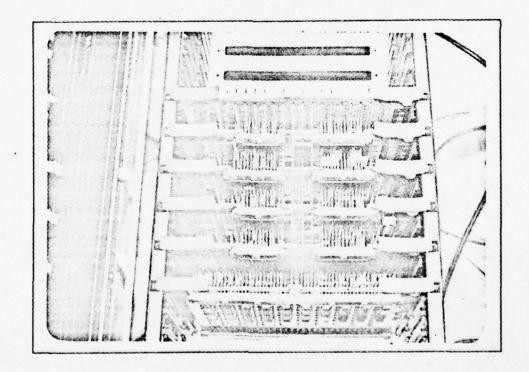


Figure A4. Card Positions

Buffer Register (DBR), Condition Code Register (CCR), and Microinstruction Code Register (MCCR).

The memory module (MEM1) provides a random access memory for main program storage. It also contains the Memory Address Register (MAR) and Memory Buffer Register (MBR) which provide buffers to the buses.

MIME operation is controlled by the Computer Control Unit (CCU) which contains the Instruction Register (IR), Program Counter (PC) and Pipeline Register (PL). The CCU decodes the instruction which came from the location specified by the PC and is contained in the IR. Execution is then accomplished by the control signals generated by the contents of the PL. The PL contains a microword which was fetched from the Control Store (CS) module. The Input/Output (I/O) module provides the means necessary for MIME to interface peripherals. It contains the hardware necessary to provide the vectored priority interrupt capability and the Word Count Register (WCR) and Base Address Register (BAR) used in DMA transfers.

### Information Transfers

Information transfers within MIME may be divided into two classes: micro level and macro level. Micro level transfers are defined as those between CS and CCU and macro level as those between any of the 16 bit registers of MIME (e.g. IR, MBR, RO, etc.).

Micro Level Transfers. Micro level transfers are essentially successive fetches of microwords from CS to the PL via the microdata Bus (MDB). Using the first level pipelining technique (Ref 2), a single microword is fetched from CS concurrently with the execution of the previous microword. Referring to Figure A5, the current microword is clocked into the PL at point A, the clock low-to-high transition,

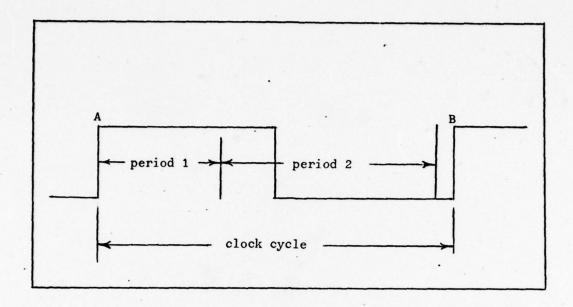


Figure A5. Micro Level Transfers

and is executed during the clock cycle from A to B. Concurrently, the address of the next microword is calculated during period 1 and applied to the MDB. The addressed microword is fetched from CS during period 2 and clocked into the PL at point B. Thus, one microinstruction is executed and another fetched during each clock cycle.

Macro Level Transfers. Macro level transfers are accomplished using three 16 bit buses: DB, AB, and MB. As shown in Figure A1, the DB is the transfer path between registers in the CCU, ALU, MEM, and I/O modules. The MB and AB are used for transfers to and from memory. Control of macro transfers is accomplished using control signals derived from the PL. As shown in Figure A6, these control signals are available shortly after the beginning of any particular clock cycle until the end of the cycle. This allows ALU functions to be computed and routed to the destination register during a single clock cycle.

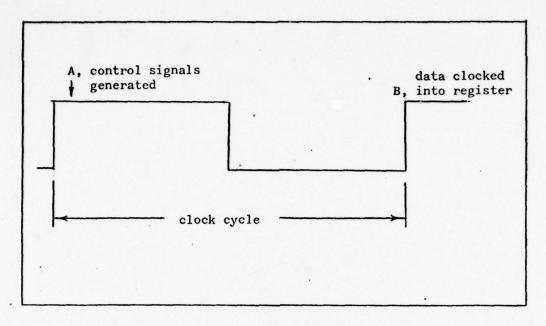


Figure A6. Macro Level Transfers

## Module Descriptions

Front Panel Module. Figure A7 depicts a block diagram of the Front Panel designed for MIME, while Figure A8 presents the Front Panel as it appears to the user. Appendix 1 of this manual contains detailed schematics of the two front panel cards, FP1 and FP2.

FP1 contains all of the front panel switches, displays, and logic shown in the block diagram, except the Display Multiplexer (MUX) logic, which is contained in FP2. Consequently FP1 is attached directly to the hinged chassis front panel, while FP2 is mounted in the card rack.

As shown in Figures A7 and A8 the Front Panel logic is grouped in the same manner as the FP1 switches and displays. Separate logic submodules are used for each of the primary front panel functions: Control, Macro Display, Data Entry, and Micro Display. The Display Mux logic is provided to allow selection of any MIME bus for display. Front panel operation will be discussed from the viewpoint of the specific occurrances resulting from each front panel switch activation.

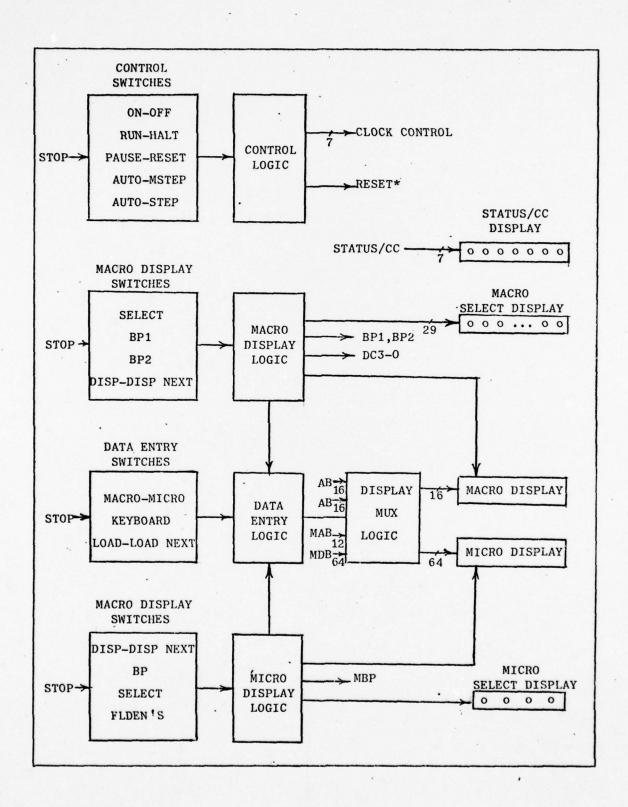


Figure A7. Front Panel Block Diagram

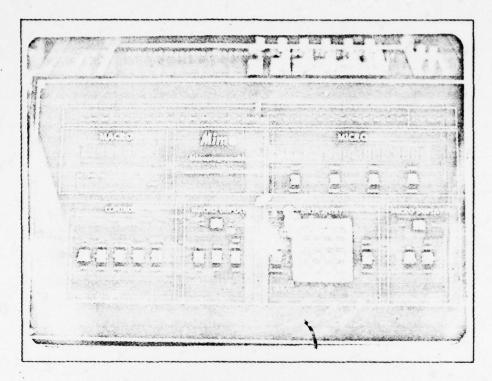


Figure A8. MIME Front Panel

CONTROL. Turning the ON-OFF switch ON applies power to the built in power supplies (when installed). Turning the switch off removes power.

Momentarily depressing RUN causes the CCU to synchronously place MIME in the RUN mode on the next high-to-low master clock transition. Similarly, HALT causes the CCU to synchronously place MIME in the HALT mode when MIME enters the instruction fetch routine.

Momentary PAUSE synchronously halts MIME on the next high-to-low master clock transition, and resets the clock mode to fast. Nomentary RESET generates the master clear pulse RESET\*. RESET\* is also generated during power-up and accomplishes the following:

- 1. places MIME in HALT mode
- 2. loads initial microaddress

- 3. clears PC, MEMFF, MAR, WCR, BAR, CCR, DBR
- 4. selects PC and A for macro and micro display respectively

If MIME is halted, a momentary STEP causes only a single machine instruction to be fetched and executed before MIME is returned to the HALT state. Similarly, a momentary AUTO STEP causes successive machine instructions to be fetched and executed once each 1.5 seconds. MIME will then halt under program control or when HALT, PAUSE, or RESET is momentarily activated.

Initial actuation at MSTEP changes the clock mode to manual.

Subsequent MSTEP's can then be used to single-step through microroutines.

AUTO MSTEP provides a 0.7 Hz clock. MSTEP and AUTO MSTEP should not be activated while MIME is running in the fast clock mode.

MACRO DISPLAY. The Macro Display Select switch designated in Figure A8 by <> selects the particular macro level register to be loaded or displayed by the front panel. The selected register is indicated by the illuminated LED above the macro display. Loading/displaying the MBR loads/displays the memory location addressed by the MAR. Loading the ALU loads the ALU DBR, while displaying the ALU displays the ALU output. Since Q, Ri, and BPi are located within the ALU, the ALU DBR must first be loaded to load these registers. Q, Ri and BPi may be displayed directly. For operator convenience, R14 and R15 are designated BP1 and BP2 on the front panel. Identification of the selected register is encoded into a four bit Destination Code (DC) which is routed to the CCU and ALU. A fifth bit is used to differentiate between the sixteen Am2901 general purpose registers and the discrete dedicated registers (e.g. IR, PC, etc.).

BP1 and BP2 enable the macro level breakpoint registers. When enabled, MIME is halted by the CCU whenever the PC matches the contents of BP1 or BP2. This is accomplished under firmware control by comparing the PC with the contents of the enabled breakpoint register(s) and halting MIME if they are equal.

DISP gates the contents of the selected register onto the DB/AB and then into the macro display register. DISP NEXT accomplishes the same function and also increments the MAR if MBR is the selected register. This allows convenient display of sequential memory locations. Both DISP and DISP NEXT are operational only in the HALT mode. The selected register is automatically displayed after each STEP, AUTO STEP, MSTEP, or AUTO MSTEP cycle.

DATA ENTRY. Macro and micro level programs are loaded from the front panel using the hexadecimal (hex) KEYBOARD. Successive hex digits are shifted into the least significant (rightmost) macro or micro display as specified by the MACRO/MICRO switch. Each character of the selected display shifts one position to the left as new data is entered; the leftmost character is last.

Contents of the selected display are loaded into the specified macro/micro level register by momentarily depressing LOAD. LOAD NEXT does the same, as well as incrementing the MAR (macro) or A (micro).

MICRO DISPLAY. The Micro Display switch selects the micro level register to be loaded or displayed by the front panel. The micro-address register (A) and micro breakpoint register (BP) are 12 bits long and require only three hex displays; the remaining displays are blanked out. Control Store (CS) and Pipeline (PL) are 64 bits long, requiring the entire micro display. BP controls the micro breakpoint

feature, which halts MIME when the microaddress matches the contents of the micro breakpoint register. DISP displays the contents of the selected micro level register, whereas DISP NEXT also increments the microaddress if CS is displayed. The selected micro level register is automatically displayed after each MSTEP or AUTO MSTEP cycle.

Each of the FLD ENA switches selectively enables one quarter of the micro display, allowing any quarter(s) of the display (and CS) to be independently changed. Enabling any particular field (four hex characters) of the display disables each NORM field. The entire display is enabled by placing all four switches in either the NORM or FLDEN positions.

ALU. Figure A9 depicts the ALU configuration and a schematic of a schematic of the ALU module is included in Appendix 1. As shown in Figure A9, the 16 bit ALU is based on two identical 8 bit byte processors with shifting linkages, condition code selection, and other ancillary functions provided by associated multiplexers, registers, and buffers. This configuration allows autonomous upper and lower byte arithmetic, logic, or shifting operations as well as full word operations when the two byte processors are simultaneously enabled. Each byte processor consists of two Am2901 four-bit bipolar microprocessor slices having combined resources of a 16 word by 8 bit two-port RAM, an 8 bit Q register, an 8 bit ALU element, and associated shifting, decoding, and multiplexing circuitry. The Am2901 is fully described in Reference 3.

The ALU Data Buffer Register (DBR) accepts data from the 16 bit DB on the low-to-high transition of CP1 when ALULD\* is low, and it is then immediately available at the D inputs of all Am2901's. A and B addresses for the two-port RAM are available from the AMUX and BMUX1

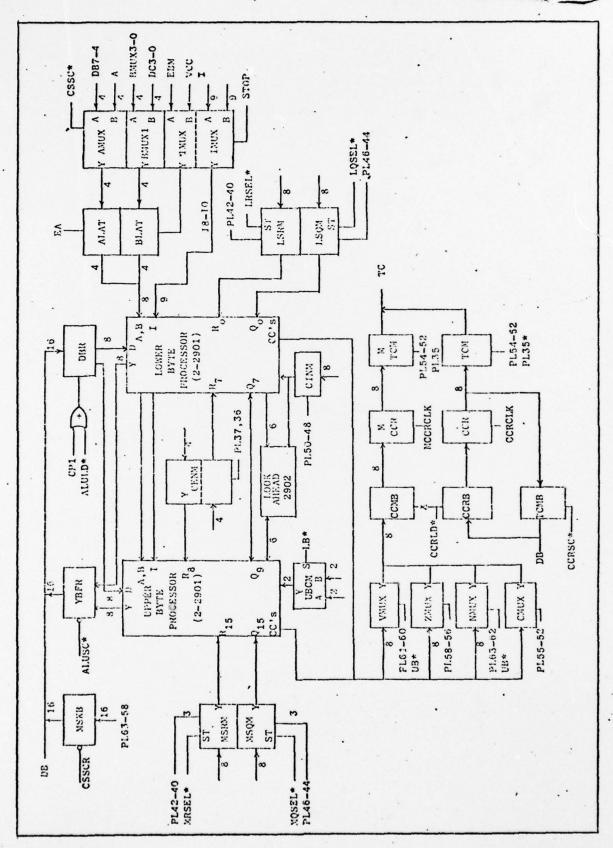


Figure A9. ALU Block Diagram

and are latched by ALAT and BLAT respectively. As specified by CSSC\*, the AMUX selects the A address from either the PL or DB, and it is latched into ALAT by EA on the low-to-high transition of CP1 when either ALTLD\* or ABLTLD\* is low. BMUX1 and BMUX2 (see CCU module description) select the B address from the PL, DB, or front panel Display Code \*DC) as specified by CSSC\* and STOP. The B address is latched into BLAT during the RUN mode when either BLTLD\* or ABLTLD\* is low. BLAT is transparent.

Nine microinstruction bits are required to control processor operations. These bits enter the ALU module through the Instruction Multiplexer (IMUX) to provide front panel load and display capabilities while in the STOP mode. Both byte processors receive the same control bits and hence perform the same function. Autonomous byte operations are possible because only the processor whose clock is enabled will store the resultant data in its internal RAM or Q register. Data generated by the nonenabled processor is lost.

Byte processor construction allows a one bit right or left shift of computational results during each clock cycle before storage in the internal RAM or Q registers. Ri and Qi connections serve as tri-state bidirectional ports for the most and least significant bits of each byte. Shift linkages to these ports are provided by an array of tri-state multiplexers. During right shifts, the Most Significant RAM Mux (MSRM) selects the scurce of RAM bit 15 while the Most Significant Q Mux (MSQN) selects the source of Q bit 15. During left shifts, the sources of RAM bit 0 and Q bit are selected by LSRM and LSQM respectively. The Center Mux (CENMUX) is used to select the source of RAM bit 8 during left shifts and RAM bit 7 during right shifts.

Q bits 7 and 8 are directly connected. Microinstruction bits used to control shift linkage multiplexers are discussed in the microprogramming section. Note that MRSEL\* and MQSEL\* are generated by CCU to prevent inadvertant enabling of MSRM and MSQM during left shifts and likewise for right shifts.

Data is output to the DB from the Am2901 Y outputs via the YBFR when ALUSC\* is low, and it is clocked into the destination register by the next CP1 low-to-high transition.

The Carry-In Mux (CINM) selects an appropriate value to be the look-ahead carry inputs for the upper byte during word operations and ripple carry inputs during byte operations. The overflow (V), zero (Z), negative (N), and carry (C) condition codes may be selected from the results of arithmetic operations, or they may be set or cleared using the VMUX, ZMUX, NMUX, or CMUX multiplexers. A less than B (ALB), B less than A (BLA), and the LSB of the ALU output (YO) are also available as condition codes. Condition codes may be stored in either the macro (CCR) or micro (MCCR) level condition code register when PL35 is low or high respectively.

Multiplexers TCM and MTCM select the particular condition code to be output as a test condition. To facilitate interrupt handling, the CCR is gated onto the DB by TCRB when CCRSC\* is low. MSKB is provided for gating PL63-56 on to the DB when CSSC\* is low as a means of transferring masks and constants stored in the microword to other MIME modules.

MEMORY. As shown in Figure A10, the MEM1 module contains 1K words of RAM, the MAR, the MBR, and the byte write logic. Information transfers necessary for read and write cycles in the run mode will be explained. Stop mode operation will also be discussed.

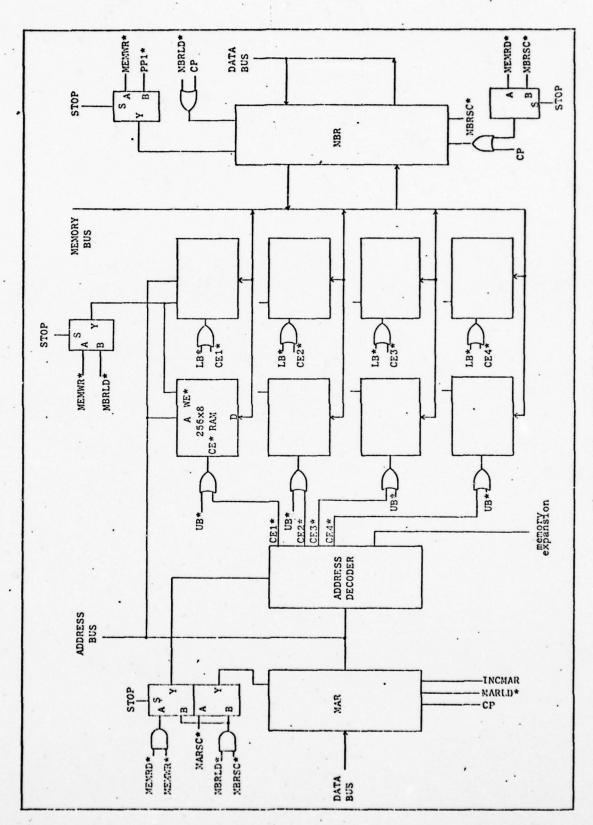


Figure A10. MEM1 Block Diagram

Data which is to be written into memory must first be loaded into the MBR from the DB using signal MBRLD\*. Next, the effective memory address must be loaded into the MAR using MARLD\*. A memory write cycle is then initiated using MARSC\*, UB\* and/or LB\*, and MEMWR\*. MARSC\* gates the MAR contents onto the address bus, allowing it to be decoded to enable the appropriate 256x8 RAM block(s) as indexed by the byte enable signals UB\* and LB\*. MEMWR\* gates MBR data onto the MB and into the addressed word of the enabled RAM block(s).

A memory read cycle is preceded by loading the MAR as in a write cycle. The read cycle is then initiated using MARSC\*, UB\* and/or LB\*, and MEMRD\*. Address decoding is accomplished as in a write cycle, and MEMRD\* is used to load the contents of the addressed work into MBR from the MB.

Memory data is loaded from the front panel in the stop mode by selecting MBR and depressing LOAD or LOAD NEXT. This gates an address onto the AB, clocks data into the MBR, and gates MBR onto the MB and into the addressed location. LOAD NEXT increments the MAR when released.

A memory location is similarly displayed from the front panel.

Depressing DISP or DISP NEXT gates an address onto AB, clocks memory data from MB into MBR and gates MBR onto the DB for FP display. Both UB\* and LB\* are held low while stopped allowing only full word front memory manipulations.

COMPUTER CONTROL UNIT. The CCU block diagram of Figure A11 depicts the CCU which is based upon Am2911/AM2909 microsequencers (Ref 2) and has associated logic used for initiating address generation and test condition selection. Also included are the IR, PC, PL, and Micro Breakpoint Register as well as control signal decoders and master

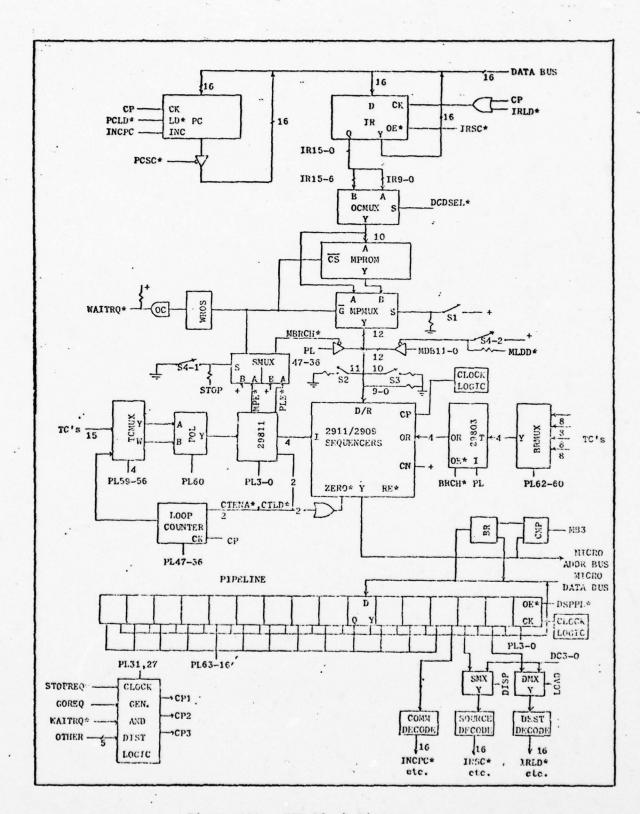


Figure A11. CCU Block Diagram

clock generation/distribution logic. CCU operation will be explained by examining typical transfers occurring chronologically during the fetch and decode of a single machine instruction.

Initially, the PC will be either incremented by INCPC or loaded from the DB by PCLD\*. This provides the address of the next machine instruction. Control signal PCSC\* will then be used to gate this address onto the DB for transfer to the memory. A memory read cycle yields the next instruction which is loaded from the DB into the IR on the next low-to-high clock transition when IRLD\* is low. As controlled by DCDSEL\*, OCMUX selects the op code portion of the IR and applies it to the address lines of the Mapping PROM (MPROM). MPROM contains a unique microroutine starting address for each particular op code thus allowing flexible CS organization. S1 controls MPMUX which allows the user to bypass MPROM and use the op code directly as the microroutine starting address.

The MPMUX tri-state outputs are one of three starting address sources. The other two sources are PL bits 47-36 and DB bits 11-0. The PL bits are used during micro-branching operations and the DB bits are used to load a starting address from the front panel.

Regardless of the source, the starting address is loaded into the Am2911/Am2909 microsequencer D/R inputs, routed to the Y output, and then gated onto the MAB. The corresponding microword is fetched from CS and loaded into the PL on the next low-to-high clock transition.

These PL bits are used as control signals throughout MIME. Three of the four-bit PL fields are decoded to provide 16 control signals each. To provide front panel load and display capabilities, the BUS SRC and BUS DST fields are routed through multiplexers SMX and DMS respectively and then decoded.

Addresses of subsequent microwords to be fetched from CS are generated by the microsequencers as controlled by PL bits 3-0. The Am2911/Am2909 architecture allows micro level straight line programming as well as conditional branching, looping, and subroutining. Which of these that occurs is controlled by 1 of 16 test conditions selected by the TCMUX and POLMUX. The selected test condition and PL bits 3-0 are inputs to the AM29811 which in turn controls the microsequencers, MPROM starting address source, and Micro Loop Counter (MLC).

When loaded with a value N, the MLC allows N+1 executions of a micro level loop. Reference 2 contains a detailed discussion of the Am29811 as well as the Am29803 discussed below (Ref 2:1-9 to 1-15, 2-11 to 2-21).

The Am29803 provides a method of simultaneously testing up to four condition codes selected by BRMUX and then branching to the microaddress specified by the test result. This is accomplished using the branch table technique discussed in section III of this manual.

Also included in the CCU is clock generation and distribution logic. This logic generates the master clock CP1 and two ALU clocks, CP2 and CP3. The latter two are controlled by PL or front panel control signals that specify the desired ALU operation.

Several features have been provided specifically for checkout and troubleshooting purposes. As previously discussed, S1 allows the user to bypass the MPROM during checkout of new microroutines or during module tests. Switch S4 inhibits front panel loading of starting addresses in order to allow the complete Am29811/29803 capabilities to be used for troubleshooting. Switches S2 and S3 allow the lowest address of the selected 1K block of CS to be used as the starting address when MIME is initialized or manually reset.

CONTROL STORE. Figure A12 depicts the CS1 module which contains

1K microwords of EPROM and 256 microwords of RAM. As in the memory

module, CS read and write cycles will be discussed.

In the run mode, one CS read operation is accomplished each clock cycle. The address generated by the CCU is decoded to enable one block of RAM or EPROM. The addressed word of the enabled block is routed through the Control Store Buffer (CSB) onto the MDB to be clocked into the PL.

CS is not presently writable in the run mode. Control line CSW may be used to write to CS under program control providing appropriate hardware buffers are added between data source and MDB.

Data may be written to the CS RAM in the stop mode by selecting CS and using LOAD or LOAD NEXT. Signal MDBOFF is low with CS selected. Depressing LOAD (NEXT) causes MDBOFF to go high, allowing CS portions selected by front panel FLDEN switches (Wi\*low) to be written into. MDBOFF inhibits nonselected CS portions (Wi\*high) by disabling corresponding CSB portions.

CS data is displayed from the front panel by depressing DISP or DISP NEXT. This latches the CS output into the micro display. Selecting PL, A, or MBP on the front panel causes MDBOFF to go high, disabling the CSB and isolating CS1 from the MDB.

I/O. The I/O module of Figure A13 contains the Am2914 Vectored Priority Interrupt Controller, the BAR, the WCR, I/O TC MUX, and Direction flip-flop (DFF).

The Am2914 (Ref 4) is used to control eight levels of vectored priority interrupt I/O operations. Interrupt requests are accepted on eight lines, and signal IRQ\* is pulled low if the highest priority non-masked request is greater than or equal to STR contents. The sixteen

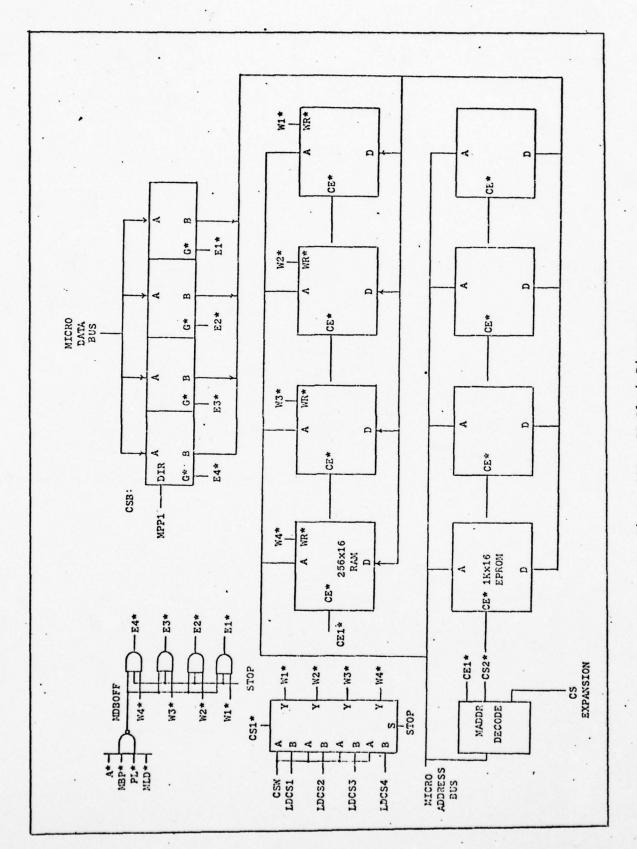


Figure A12. CS Block Diagram

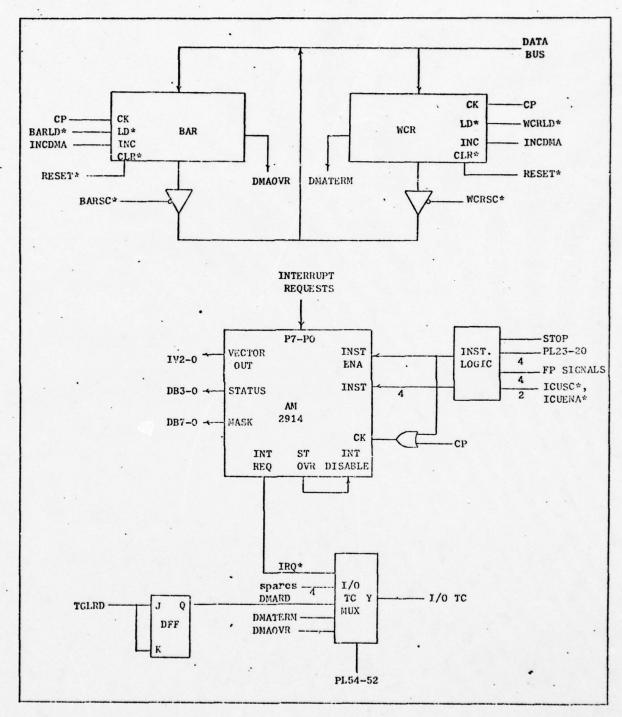


Figure A13. I/O Block Diagram

AM2914 instructions are summarized in the microprogramming section of this manual. Both the SR and MR may be loaded under program control with these instructions, or from the front panel. The instruction logic interfaces the AM2914 to the front panel and prevents inadvertent contention on the DB.

The BAR is loaded with the initial memory address while the WCR is loaded with the two's complement of the number of words to be transferred. The BAR is gated onto the AB for each DMA cycle, and then both the BAR and WCR are incremented. The DMATERM flag is used to indicate completion of the desire number of transfers. The DMAOVR flag is set if the memory address overflows.

The I/O TC MUX selects 1 of 8 I/O related condition codes for testing by the CCU. One of these codes is DMARD, the DFF output. DFF is loaded with the transfer direction during DMA initialization and is tested to determine direction of each subsequent DMA transfer.

CHASSIS DETAILS. The chassis was designed to provide maximum access to MIME components. The front panel is hinged (restricted to 130° travel) to allow access to FP1 wiring. Removal of the plexiglass faceplate allows access to all FP1 components. The remaining circuit cards are rack mounted and access to components and wiring may be obtained by card removal. An extender card has been provided to allow access to one card under operating conditions. Access to the backplane has been provided by a removable panel on the bottom of the MIME cabinet.

For user convenience, a Miscellaneous Signal Panel (MSP) has been provided which contains a HEX/OCTAL select switch (macro display), power connections and test points. The HEX/OCTAL switch determines whether data displayed on the macro level is in hexadecimal or octal

format. The power connections wer provided as a means of powering

MIME with laboratory power supplies until internal supplies are installed.

The power connections may then be used as a power source for external experimental setups. The test points which are discussed under troubleshooting were provided to allow easy access to dynamic signals of interest.

# II. Operation

This section presents procedures used to load and execute macro and micro level programs. It is assumed that the user is familiar with the System Description section of this manual. Capitalized words refer to FP1 switches and indicators.

### Macroprogram Loading

Machine language programs are loaded into MEM from FP1 in the following manner:

- Select Hex/Octal format (on MSP)
- 2. Select MAR (macro level register select)
- LOAD MAR with initial memory address (select macro level and enter value via KYBRD and LOAD)
- 4. Select MBR (macro level register select)
- 5. LOAD (NEXT) memory location with data

#### Microprogram Loading

CS contains both read-only and read/write memory for microinstruction storage. Read-only CS can be changed by removing and reprogramming the CS EPROM. Read/write CS can be loaded from FP1 using the following procedure:

- 1. Select A (micro level register select)
- 2. Load initial microaddress (select micro level and enter value via KYBRD and LOAD)
- 3. Select CS (micro level register select)
- 4. LOAD (NEXT) CS location with data

#### Program Execution

The following procedure is used to execute MIME programs:

- 1. Place CCU switches 1, 2, and 3 in desired positions (select CS block, see CCU Module Description)
- 2. RESET MIME to initialize microaddress
- 3. LOAD PC with address of first machine instruction (macro level register select enter value via KYBRD and LOAD)
- Select macro level register for auto display (STEP, AUTO STEP, MSTEP, or AUTO MSTEP modes)
- Select micro level register for auto display (MSTEP and AUTO STEP modes)
- 6. Begin program execution in desired mode by use of one of the following:
  - a. RUN
  - b. STEP
  - c. AUTO STEP
  - d. MSTEP, RUN, MSTEP
  - e. AUTO MSTEP, RUN
- 7. Program execution may be halted under program control or by activating one of the following:
  - a. HALT
  - b. PAUSE
  - c. RESET

### III. Microprogramming

This section presents information which enables the reader to implement machine instructions as microinstruction modules. The microword fields (related groups of bits) are defined first, and because many of these fields control multiple functions (i.e. they are formatted or serve more than one function), representative microword formats are then presented. As an example, these concepts are then applied to the emulation of several PDP-11/03 instructions.

### MICROWORD FIELDS

A total of 150 signals are used to control MIME. A 150 bit microword would have been extremely flexible but prohibitively expensive when realized in hardware. Therefore, the techniques of encoding and formatting were used to reduce the microword length to a more reasonable 64 bits. As shown in Figure A14, fields 2, 3, and 4 are encoded four bit fields which each provide 16 control signals through use of 1 of 16 decoders. The majority of the other fields are formatted, such that they each control two or more functions as specified by a set of steering bits.

Each field is discussed in detail below, and summarized in Tables AIII to AX.

MICROADDRESS SEQUENCER. This field controls microaddress sequencing using the Am29811 next address control unit in conjunction with Am2909/11 microinstruction sequencers (Ref 2:1.9-2.21). One of the sixteen Am29811 instructions shown in Table AIII must be specified in each microinstruction.

BUS DESTINATION. This field is decoded to control gating of DB information into 1 of 10 registers. As shown in Table AIV, it also controls MEM read and write cycles (in conjunction with UB\* and LB\* fields and MARS bus source).

							SEQ MADDR	0
							SI	3
		OAD	10	CEN	38 37-36		BUSDST	7 - 4
		MICRO LOOP COUNTER LOAD	MICRO BRANCH ADDRESS	R MUX	52 51 50 - 48 47 46 - 44 43 42 - 40 39 38 37-36		BUSSRC	11 - 8
		CRO LOOP	ICRO BRANC	O MUX	- 44 43 4		COMMAND	15 - 12
Г		MIC	M		18 47 46		ALU B ADDR	19 - 16
				CINMUX	51 50 -	0/1	ALU A ADDR	- 20
	TC MUX		ALU TC MUX	CARRY MUX	1		ALUSRC	26 - 24 23
LANT	BR CONTROL		CCU TC MUX	Z MUX	1-60 59 58 - 56 55		ALUFN *	30 - 28 27
CONSTANT	Χn		POL	MUX	09-		UB*	2 31
	BR MU			N MUX-V	63-62 61		ALUDST	35 34 - 32
		\	. \	-	۳			[N]
-						 		

Figure A14. Microword Definition

Table AIII
Microaddress Sequencer Field

		MICROADDRESS SE	QUENCER				
MNE- MONIC	MICRO CODE	INSTRUCTION	TEST INPUT	NEXT ADDR SRC.	FILE	CNTR	ENA (1)
JZ	0	Jump to address zero	Х	D	HOLD	-	PL
CJS	1	Conditional jump-to- subroutine; PL address	L H	MPC D	HOLD PUSH	HOLD	PL PL
JMAP	2	Jump to Mapping PROM Output	х	D	HOLD	HOLD	PROM
CJP	3	Conditional jump to PL	L H	MPC D	HOLD	HOLD	PL PL
PUSH	4	Push file; condition- ally load counter	L H	MPC MPC	PUSH PUSH	HOLD LOAD	PL PL
JSRP	5	Jump-to-subroutine; address conditionally R or PL	L H	R D	PUSH PUSH	HOLD	PL PI
CJV	6	Conditional jump to initial micro address (CCU S2 and S3)	L H	MPC D	HOLD	HOLD	N.A.
JRP	7	Jump to address; conditionally R or PL	L H	R D	HOLD	HOLD HOLD	PL PL
RFCT	8	Repeat loop if counter ≠ 0. (Must test CT*)	L H	F MPC	HOLD POP	DEC HOLD	PL PL
RPCT	9	Repeat PL if counter ≠ 0. (Must test CT*)	L H	D MPC	HOLD	DEC HOLD	PL PL
CRTN	A	Conditional return- from-subroutine	L H	MPC F	HOLD POP	HOLD	PL PL
CJPP	В	Conditional jump to PL and POP File	L H	MPC D	HOLD POP	HOLD	PL PL
LDCT	С	Load counter and continue	x	MPC	HOLD	LOAD	PL
LOOP	D	Repeat loop if condition ≠ 1	L H	F MPC	HOLD POP	HOLD	PL PL
CONT	E	Continue to next addr.	х	MPC	HOLD	HOLD	PL
JP	. <b>F</b>	Jump to PL address	X	D	HOLD	HOLD	PL

(1) Notes: ENA gates specified data to D/R 2911/09 inputs. D may be selected as next address source on same clock cycle. R is loaded on clock + and may be selected on next clock cycle. MPC contains current address +1. F = file output. PL = microbranch field.

Table AIV

Command, Bus Source, and Bus Destination Fields

<u>u</u>	PCS MARS MBRS IRS MSTP  ALUS CCRS	CODE 2 2 3 3 4 4.	Gate PC onto DB. Gate MAR onto AB. Gate MBR onto DB. Gate IR onto DB. Halt Command	MNEM PCL MARI	CODE	FUNCTION
Increment PC. Increment MAR Increment WCR BAR Toggle READ F Enable 16-way branch Reset Memory I Load A address latch Load B address latch Load B address latch Load B address latch Load B address latch Coad B address latch Load B address latch Coad B address latch Coad B address latch		Ø 11 02 10 10 10 10 10 10 10 10 10 10 10 10 10	Gate PC onto DB. Gate MAR onto AB. Gate MBR onto DB. Gate IR onto DB. Halt Command	PCL		
		t 2 & 4 & 0	Gate MAR onto AB. Gate MBR onto DB. Gate IR onto DB. Halt Command	MARI	Ø	Load PC from DB.
		0 N 4 N O	Gate MBR onto DB.  Gate IR onto DB.  Halt Command	71111111	1	Load MAR from DB.
		ю 4. го Ф	Gate IR onto DB. Halt Command	MBRL	8	Load MBR from DB.
		4, 12 0	Halt Command	IRL	8	Load IR from DB.
		s 9	Shane	MEMR	4	Write to MEM from MBR
	ALUS	9	, indi	MEMW	Ŋ	Read from MEM to
	CCRS		Gate ALU output onto DB	DBRL	9	Load DBR from DB.
		7	Gate CCR onto DB.	CCRL	2	Load CCR from DB.
	1	<b>∞</b>	FP display of MKR	1	<b>∞</b>	FP load of MKR.
-	ICUS	б	Enable I/O IMC, RSR, RMR.	1	6	FP load of STR
A spare	BARS	A	Gate BAR onto DB.	BARL	A	Load BAR from DB.
B Spare	WCRS	В	Gate WCR onto DB.	WCRL	В	Load WCR from DB.
C Enable Am 2914	FPS	o	Gate FP data onto DB.	FPL	o	Load FP disp. from DB.
D Write to I/O device*	CSS	А	Gate CONSTANT onto DB.	1	Q	Spare
E Read from I/O	IOBS	ĸ	Gate IOBR onto DB*	IOBL	ы	Load IOBR from DB*
F No Operation	NOOP	Ľι	No Operation	NOOP	দ	No Operation

\* See Ref 6

BUS SOURCE. The bus source field, also shown in Table AIV, gates data onto the DB from 1 of 9 registers, and onto the AB from 1 of 2 registers. Both the bus source and destination fields must be specified for each microinstruction. In addition, memory read/write cycles require bus source MARS or BARS to gate addresses onto the AB. Bus source IOBS must be selected during specific Am2914 instructions discussed in the interrupt control field section.

COMMAND. The command field generates 1 of 16 miscellaneous control signals as summarized in Table AIV. This field must be specified for each microinstruction.

ALU A and B Address. These two field serve as a source of the ALU two-port RAM A and B addresses. A and B addresses must be loaded into the ALU ALAT and BLAT respectively using command mnemonic ALD, BLD, or ABLD. These latches, as discussed in the ALU module description, may also be loaded from the DB.

INPUT/OUTPUT. This field uses the instructions shown in Table AV to control the Am2914 Vectored Priority Interrupt Controller (Ref 4). This field must be used in conjunction with command ICU. In addition, bus source ICUS must also be used with IMC, RSR, and RMR to avoid multiple DB sources.

ALU SOURCE, FUNCTION, DESTINATION. As shown in Table AVI, these three fields control the ALU Am2901's. ALU source selects 1 of 8 operand pairs; function selects 1 of 8 operations; and destination controls shifting and destination of processing results.

<u>UB\* and LB\*</u>. These two 1 bit fields control upper and lower byte ALU and MEM storage respectively. As shown in Table AVI, ALU storage is enabled by selecting the appropriate ALU destination field with UB\* and/or LB\* low. MEM write is accomplished with MEMW, MARS, and UB\*

Table AV
Input/Output Field

		INTERRUPT CONTROL UNIT
MNEM	CODE	INSTRUCTION
MCL	0	Master clear: clear all interrupts, MR, and SR; Enable interrupt requests
CAI	1	Clear all interrupts
DBC	2	Clear interrupts from DB data
IMC	3	Clear interrupts from MR (uses DB)
CLV	4	Clear interrupt associated with last vector read
RDV	5	Read vector (IV2-0); load SR +1 into SR
RSR	·6	Gate SR onto DB
RMR	7	Gate MR onto DB.
SMR	8	Set MR (inhibits all interrupts)
LSR	9	Load SR from DB
ВСМ	Α	Bit clear MR from DB
BSM	. в	Bit set MR from DB
CMR	С	Clear MR (enables all interrupts)
DIR	D	Disable interrupt request
LMR	E	Load MR from DB
EIR	F	Enable interrupt request

Table AVI

Am2901 Processor Fields

RANDS	S	eg	00	Ci	a	a	CU,	CO		
PEI		0 reg	B reg	Q reg	ġ reg	A reg	A reg	Q reg	100	
SOURCE OPERANDS	R	A reg	A reg	100	80	100	DBR	DBR	DBR	
CODE		0	H	2	ь	4	٦	9	7	
MNEM		AQ	AB	96	ØB	ØA	DA	õ	ρØ	
ALU FUNCTION		R + S + C;	S + R* + C.	R + S* + C;	RVS	R A S	R* A S	R 😝 S	(R ¥ S)*	
CODE		0	1	2	ы	4	ß	9	2	
MNEM		ADD	S-R	R-S	OR	AND	NRAS	XOR	XNOR	
RAM/Q STORAGE		F + Q	no storage	F + B	F. + B	F/2+B,Q/2+Q	F/2 + B	2F+B, 2Q+Q	2F + B	
Y		Ŀ	(Z4	(A)	E4	(L)	(H	ĸ	Į.	
CODE		0	1	2	ы	4	ഹ	9	2	
MNEM		QOF	OF	BOA	BOF	RBQ	RB	LBQ	gı.	
	CODE Y RAM/Q STORAGE MNEM CODE ALU FUNCTION MNEM CODE	CODE Y RAM/Q STORAGE MNEM CODE ALU FUNCTION MNEM CODE	CODE Y RAM/Q STORAGE MNEM CODE ALU FUNCTION MNEM CODE  O F F + Q ADD O R + S + C <sub>1n</sub> AQ O	CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MNEM         CODE           0         F         F + Q         ADD         0         R + S + C <sub>in</sub> AQ         0           1         F         no storage         S-R         1         S + R* + C <sub>in</sub> AB         1	CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MNEM         CODE           0         F         F + Q         ADD         0         R + S + C <sub>in</sub> AQ         0           1         F         no storage         S-R         1         S + R* + C <sub>in</sub> AB         1           2         (A)         F + B         R-S         2         R + S* + C <sub>in</sub> ØQ         2	CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MNEM         CODE           0         F         F + Q         ADD         O         R + S + C <sub>in</sub> AQ         O           1         F         no storage         S-R         1         S + R* + C <sub>in</sub> AB         1           2         (A)         F + B         R-S         2         R + S* + C <sub>in</sub> ØQ         2           3         F         F + B         OR         3         R V S         ØB         3	CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MNEM         CODE           0         F         F + Q         ADD         0         R + S + C <sub>in</sub> AQ         0           1         F         no storage         S-R         1         S + R* + C <sub>in</sub> AB         1           2         (A)         F + B         R-S         2         R + S* + C <sub>in</sub> ØQ         2           3         F         F + B         OR         3         R V S         ØB         3           4         F         F/2+B,Q/2+Q         AND         4         R A S         ØA         4	CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MNEM         CODE           0         F         F + Q         ADD         0         R + S + C <sub>in</sub> AQ         0           1         F         no storage         S-R         1         S + R* + C <sub>in</sub> AB         1           2         (A)         F + B         R-S         2         R + S* + C <sub>in</sub> ØQ         2           3         F         F + B         OR         3         R V S         ØB         3           4         F         F/2+B,Q/2+Q         AND         4         R A A         4           5         F         F/2 + B, Q/2 + B         NRAS         5         R* A A         5	CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MNEM         CODE           0         F         F + Q         ADD         0         R + S + C <sub>in</sub> AQ         0           1         F         no storage         S-R         1         S + R* + C <sub>in</sub> AB         1           2         (A)         F + B         R-S         2         R + S* + C <sub>in</sub> $\emptyset$ Q         2           3         F         F + B         OR         3         R V S $\emptyset$ B         3           4         F         F/2+B, Q/2+Q         AND         4         R A A S $\emptyset$ A         4           5         F         F/2 + B         NRAS         5         R* A S $\emptyset$ A         5           6         F         ZF+B, 2Q+Q         XOR         6         R A ¥ S $\emptyset$ Q         6	1         CODE         Y         RAM/Q STORAGE         MNEM         CODE         ALU FUNCTION         MINEM         CODE           0         F         F + Q         ADD         O         R + S + Cin         AQ         O           1         F         no storage         S-R         1         S + R* + Cin         AB         1           2         (A)         F + B         R-S         2         R + S* + Cin         ØQ         2           3         F         F + B         OR         3         R V S         ØB         3           4         F         F/2+B, Q/2+Q         AND         4         R A S         ØA         4           5         F         F/2 + B, Q/2+Q         NRAS         5         R* A S         DA         5           6         F         ZF+B, 2Q+Q         XOR         6         R ¥ S         DQ         6           7         F         F         ZF+B         NOR         7         (R ¥ S)*         DQ         7

* E G G G G G G G G G G G G G G G G G G	Enable upper byte store, ALU Disable upper and MEM	<u> </u>	MNEM ON OFF	CODE 0	FUNCTION  FRABLE lower byte store ALU and MEM Disable lower byte store ALU
, <u>g</u>	and MEM				and MEM

CODE

UB\*

	*noo	*		
MNEM	CODE	FUNCTION	M	MNEN
22	0	Load CCR		NO
МСС	1	Load MCCR	0	OFF

and/or LB\* low. ALU storage may be disabled during MEM write with ALU destination OF. UB\* and LB\* must be specified for each microinstruction.

<u>CC\*.</u> CC\* determines whether the condition codes generated as the result of arithmetic operations are latched by the CCR (CC\* low) and the MCCR (CC\* high) as shown in Table AVI.

MICRO LOOP COUNTER LOAD. As shown in Figure A14, the Micro Loop

Counter Load field is a formatted field. The contents of this field is

loaded into the MLC when the Microaddress Sequencer field contains PUSH

or LDCT. M-1 is loaded to accomplish N loops.

MICROBRANCH ADDRESS. As shown in Figure A14, the Microbranch

Address field is also formatted. The contents of this field conditionally specifies the address of the next microinstruction when the Microaddress Sequencer field contains CJB, CJP, JSRP, JRP, RPCT, CJPP, or JP.

CENMUX, RMUX, QMUX. These fields are used with the ALU destination field to select appropriate shifting linkages as shown in Table AVII.

I/O TC, ALU TC, CCU TC, POL. As shown in Table AVIII, these fields select condition codes for testing by the CCU. I/O TC selects 1 of 8 condition codes generated in the I/O module, while ALU TC selects 1 of 16 generated in the ALU. Eight of the ALU condition codes are stored in the CCR and eight in the MCCR. CCU TC selects 1 of 16 condition codes, including those preselected by the I/O TC and ALU TC. POL specifies positive or negative test logic.

CARRY, ZERO, OVR, NEG. These fields select sources for ALU condition codes CARRY, ZERO, OVR, and NEG. As shown in Table AIX, UB\* is used with OVR and NEG to automatically select the correct byte when NRM is specified.

Shifting Linkage Fields Table AVII

RIGHT SHIFT RAM 7

LEFT SHIFT

RAM 8

						-	-			١
		QMUX				RMUX			CENMUX	_
		LEFT SHIFT	RIGHT SHIFT			LEFT SHIFT	RIGHT SHIFT			LE
MNEM	CODE	ØÒ	915	MNEM	CODE	RAMØ.	RAM15	MNEM	сорЕ	8
RRO	0	RAM 15	RAM Ø	RRO	0	RAM 15	RAM Ø	CLR	0	
QRO	-	0 15	øò	QRO	н	0 15	ØÒ .	υ	-	
S	~	CARRY	CARRY	o .	8	CARRY	CARRY	70	72	
CLR	ю	GND	GND	CLR	ю	GND	GND	NRM	ы	
SET	4	VCC	vcc	SET	4	NCC	vcc			
,	NO.	SPARE	SPARE	40	Ŋ	70	SPARE			
D15	9	SPARE	DBR 15	D15	9	SPARE	DBR 15			
R8	2	SPARE	RAM 8	ROB	2	RAM 7	RAM 8			

DBR 7

SPARE

CARRY

CARRY

GND

GND

RAM 8

RAM 7

Table AVIII

Test Condition Fields

	Polarity	Positive	Negative
POL	CODE	О Н	- N
	MNEM	POS	NEG

DMATERM

DMAT

MFØ

DMARD

DMAR

MALBT

STATUS

ST

MAGBT

MCRY

spare

spare

spare

9

MZERO

MOVR

IRQ\*

IRQ\*

MNEG

spare

FØ

CARRY

OVER

ZERO

NEG

AGBT

ALBT

DMAOVR

DMA0

Spare

ALUTC

ALU TC M	DE	0	7	2	ь	4	ນ	9	2	80	6	Ą	В	υ	Ω	ы	Ĺτι
	MNEM	ı	MFØ .	MAL	MAG	MC	MV	MZ	MN	1	FØ	AL	AG.	υ	>	2	Z
XI	၁၁	BP1	BP2	I/O TC	ALU TC	MARØ	MEM	cT*	IR4	IR5	IR7	IR15	spare	spare	spare	spare	vcc
J TC MUX	CODE	0	٦		ю	4	Ŋ	9	2	00	6	Ą	В	υ	Ω	দ্য	ţzı
noo	MNEM	BP1	BP2	1/0	ALU	MARØ	MEM	CT*	IR4	IRS	IR7	IR15	ı	ı	1	1	set

Table AIX

ALU Condition Code Fields, Carry In Field

MUX	C SOURCE	CARRY	CARRY*	spare	spare	spare	spare	AC1	CC	nc	RAMØ	RAM15	015	RAM7	RAM8	GND	VCC
CARRY N	CODE	0	1	8	ь	4	2	9	2	<b>&amp;</b>	6	A	В	υ	Ω	ы	[z4
	MNEM	ပ	*	ı	ı	ı	1	AC1	LB	<b>8</b> 5	RØ	R15	015	R7	R8	CLR	SET
	Z SOURCE	spare	spare	TZ	Zn	ZERO	WZ	GND	SOA								
ZERO MUX	CODE	0	1	8	8	4	ß	9	7								
	MNEM	1	ı	LB	gg	REP	WRD	CLR	SET								
IUX	OVR SOURCE	OVER	UOVR/LOVR	GND	VCC												
OVR MUX	CODE	0	н	2	13												
	MNEM	REP	NRM	CLR	SET												
IUX	NEG SOURCE	NEG	UN/EN	GND	vcc	,	Ail	Carry In	spare	RAM 7	MCRY	MCRY*	CARRY	CARRY*	GND	vcc	
NEG MUX	CODE	0	н	2	2		MIN MIN	CODE	0	1	8	ю	4	S.	9	7	
	MNEM	REP	NRM	CLR	SET			MNEM	ı	R7	MC	MC*	υ	*	CLR	SET	

<u>CIN</u>. CIN specifies the ALU carry in during word, upper byte, and lower byte operations. CIN is shown in Table AIX and must be specified for word or byte arithmetic operations.

Branch Control and Branch MUX. These two fields shown in Table AX are used to control the Am29802 16-Way Branch Control Unit (Ref 2:1.13-2.15). The branch control field specifies simultaneous testing of up to four condition codes selected from one of eight sets of four by the branch MUX. The Am29803 output is OR'ed with the four least significant next microaddress bits, resulting in a branch to 1 of 16 sequential locations in CS. Each of the 16 locations of this "branch table" could contain an additional branch instruction, resulting in 16-way branching capability.

Constant. This 16 bit field is gated onto the DB when the bus source field contains CSS, where it is available for use as a constant, ALU RAM A/B address, or interrupt MASK.

## Microword Formatting

Twenty four different microword formats are possible using various combinations of the functionally grouped fields. The authors have found that the four general purpose formats shown in Figure A15 are sufficient for most applications.

Arithmetic. The Arithmetic Format makes full use of the data processing capabilities of MIME. Complete arithmetic, logic, shifting, and condition code generation capabilities are available with this format. However, only unconditional microaddress sequencer commands may be used (JZ, JMAP, CONT, and JP).

Table AX

16 Way Branch Fields

	BRAN	CH MUX
MNEM	CODE	TEST CONDS.
IRO	0	IR3,2,1,0
IR3	1	IR6,5,4,3
IR6	2	IR9,8,7,6
IR9	3	IR12,11,10,9
IR12	4	IR15,14,13,12
IV	5	IV2,1,0
cc	6	z,N,C,V
-	7	SPARE

В	RANCH CON'	TROL					
MNEM.	CODE	TEST					
OFF	0	No test					
1	1	то					
2	2	T1					
3	3	T1,T0					
4	4	. T2					
5	. 5	T2,T0					
6	6	T2,T1					
7	7	T2,T1,T0					
. 8	8	Т3					
9	9	тз,то					
A	Α	T3,T1					
В	В	T3,T1,T0					
С	С	T3,T2					
D	D	T3,T2,T0					
E	E	T3,T2,T1					
F	F	T3,T2,T1,T0					

15 0	COMM, BUS, MS				COMM, BUS, MS		COMM, BUS, MS			COMM, BUS, MS	•		COMM, BUS, MS		
20 19 16 1	В	.4	ı		В		В			В			В		
35 24 23 20	A	I/0		*	A		A		0/1		0/1		A		
	PROCESSOR			(a) Microword	PROCESSOR	(b) Arithmetic Format	PROCESSOR		(c) Microsequence Format	PROCESSOR		(d) I/O Format	PROCESSOR		
36	MICRO BRANCH	COUNT LOAD	SHIFT		SHIFT	7 (9)	MICRO BRANCH	COUNT LOAD	(c) Mic	MICRO BRANCH	COUNT LOAD	3	MICRO BRANCH	COUNT LOAD	
48 47	CIN	-			CIN		CIN	H		CIN	H		-		
CONSTANT	TEST COND. C	16-WAY BRANCH	COND. CODES		conb. cobes c		TEST COND.	16-WAY BRANCH		TEST COND.			CONSTANT		
63															

Figure A15. Representative Microword Formats

Microsequencer. This format provides powerful microaddress sequencing features through use of the entire microaddress sequencer instruction set combined with 16-way branching capabilities. The test condition fields are used with the conditional sequencer instructions for micro level branching, looping, and subroutining. In addition, the Am29811 test input is forced high when 16-way branching is enabled, allowing instructions such as jump to 1 of 16 subroutines to be executed.

<u>I/O</u>. The I/O format is used during interrupt processing. The complete sequencer instruction set is utilizable with this format.

Constant. This field is used for transfer of the 16 bit Constant to be DBR, MKR, STR, or A and B address latches. The Am29811 test input is forced high at the same time, providing unconditional versions of the sequencer instructions.

### Sample Microprograms

In order to demonstrate the flexibility of microprogramming and its application to emulation, this section presents the emulation of the PDP-11/03 instructions shown in Table AXI using the MIME architecture. Emulation is defined to be the capability of MIME to execute the instructions of another machine with the same processing results.

The authors used the approach discussed in Chapter V of the MIME thesis (Ref 1) to emulate the selected instructions. The discussion of this example consists of two parts: High Level Microprogram Flow and Individual Instruction Modules.

Emulation Structure. The flowchart of Figure A16 shows the microprogram structure used to emulate the selected instructions. Each named block represents a microcode module. Modules above the division line

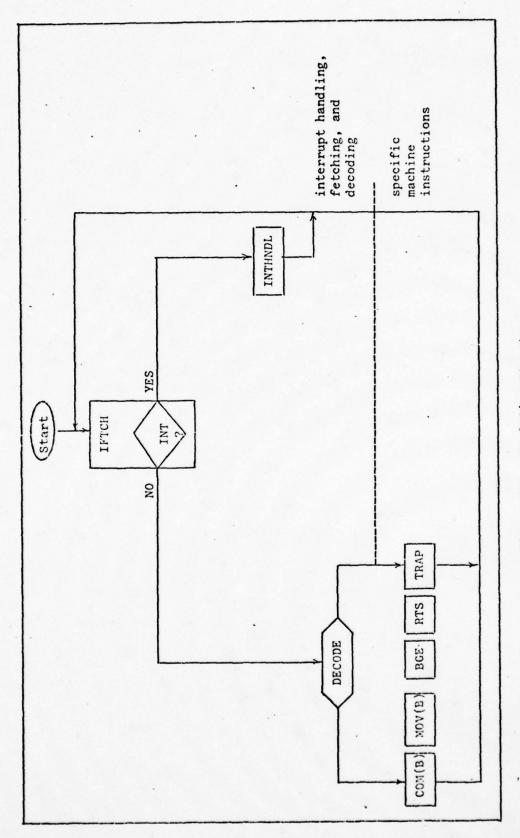


Figure A16. Emulation Structure

Table AXI
Sample PDP-11/03 Instructions

Instruction Type	Mnemonic	Instruction	Op Code
Single Operand	COM(B)	Complement Destination	/051DD
Double Operand	MOV(B)	Move source to Destina- tion	/1SSDD
Signed Condi- tional Branch	BGE	Branch if . ≥ 0	002000
Program Control	RTS	Return from subroutine	00020R
Trap	TRAP	Trap	104400 - 104777
			/ + 1/0

control interrupt handling, fetching, and decoding for all machine instructions. Modules below the line are unique to a particular machine instruction.

After initialization, emulation of a particular machine instruction begins with the Instruction Fetch module (IFTCH) which fetches the next instruction from memory if no interrupts are pending. As shown in Figure A17, IFTCH shifts the PC right one place before loading it into the MAR. This is necessary in order to map the PDP-11/03 memory address space into the MIME address space. The corresponding memory word is then fetched from memory to the MBR and subsequently loaded into the IR. The PC is then incremented by two so that it points to the next sequential instruction.

The DECODE module illustrated in Figure A18 controls the decoding of the instruction op code to arrive at the corresponding micromodule

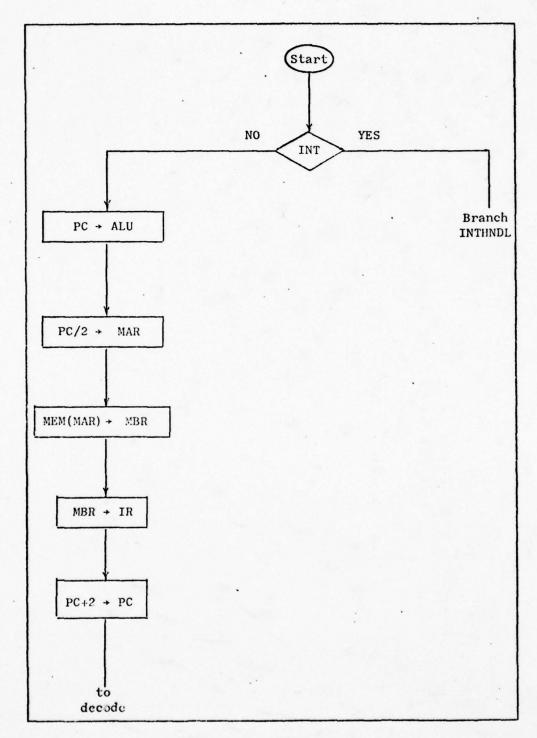


Figure A17. IFTCH Flowchart

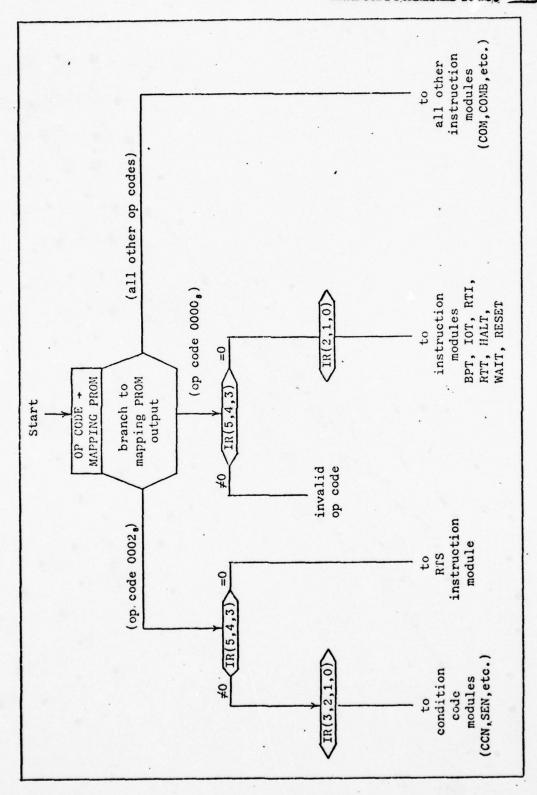


Figure A18. DECODE Flowchart

starting address. This is accomplished in part by using a PROM to map the op code portion of the IR into starting addresses of other micromodules. If the op code is octal 0002, IR bits 5, 4, and 3 are tested. If IR5,4,3 equals octal 0, a branch to the RTS instruction module is accomplished. Otherwise a branch is made to one of 16 condition code set/clear modules by testing IR bits 3, 2, 1, and 0. If the op code is octal 0000, IR bits 5, 4, and 3 are again tested. In this instance, if IR5,4,3 equals 0, IR bits 2, 1, and 0 are tested to control a branch to one of 8 instruction modules. An invalid instruction has been specified if IR 5,4,3 equals 0. If the op code is other than 0000 or 0002, the mapping PROM output is the starting address of a particular instruction module.

The Interrupt Handler (INTHNDL) module stacks the current PC and CCR in memory and loads a new PC and CCR from pre-assigned memory locations. The PC then contains the address of the first instruction of the machine language interrupt service routine. Referring to Figure A19, this is accomplished by first calling the micro subroutine PUSH. As shown if Figure A20, PUSH decrements R6 (used as the stack pointer) by two, loads the new contents of R6 into the MAR, and returns. The PC is then stored in the memory location addressed by R6. The CCR is similarly pushed onto the stack. The interrupting device is identified by vector IV2,1,0. This vector is used to branch to the particular module necessary to load the MAR with the address of the new PC. The new CCR is in the next sequential location. The PC now points to the machine language interrupt service routine. To execute this instruction, a branch back to IFTCH of Figure A17 is accomplished. After

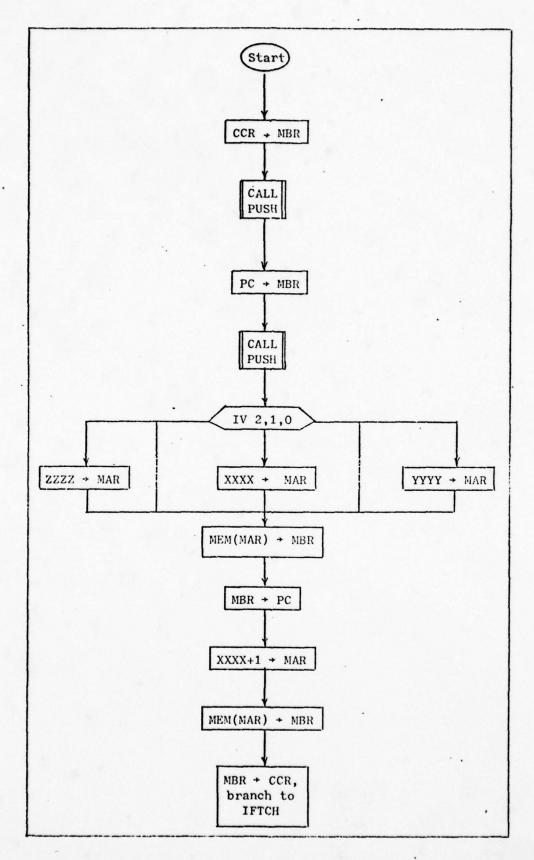


Figure A19. INTHNDL Flowchart

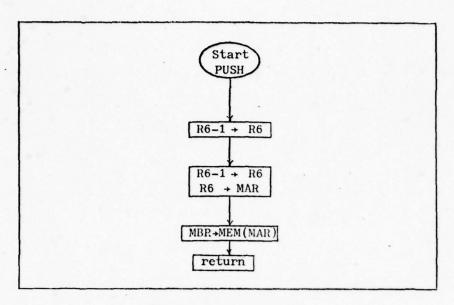


Figure A20. PUSH Flowchart

testing for higher priority interrupts, this instruction is executed using the emulation structure discussed in the preceeding paragraphs.

Individual Instruction Modules. The following paragraphs discuss the micro level modules used to implement the register transfers required for each emulated PDP-11/03 instruction of this example.

COM(B) replaces the word (byte) contents of the destination address with its logical complement. Using the decoding algorithm discussed in the previous section, COM and COMB are decoded to separate starting addresses. Thus, they will be discussed as separate modules. As shown in Figure A21, COM begins by calling the DSTDCD micro subroutine of Figure A22 to compute and load the MAR with the effective address of the operand (memory reference mode). Figure A23 depicts the DPCDCD module used in conjunction with DSTDCD. The reader is referred to the PDP-11/03 Processor Handbook for a comprehensive discussion of instruction formats and addressing modes (Ref 5:3.1-3.19). If the operand is located in memory, micro subroutine OPFTCH shown in Figure A24 is called to fetch the operand and load it into the ALU Data

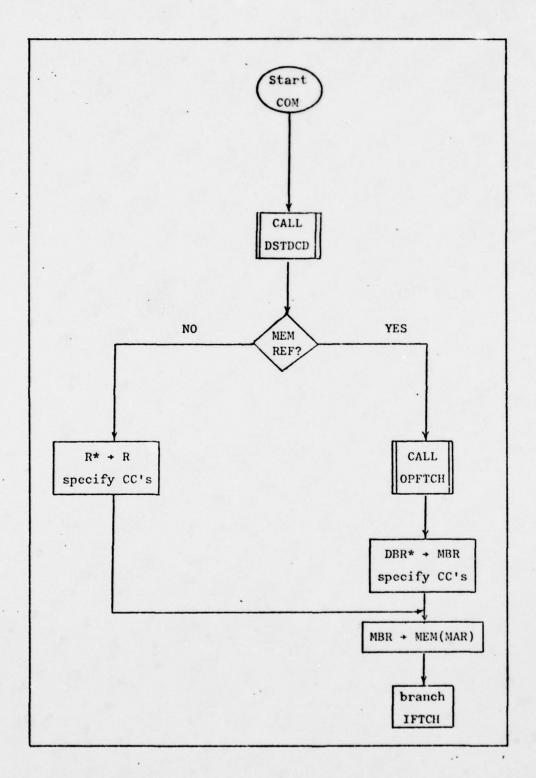


Figure A21. COM Flowchart

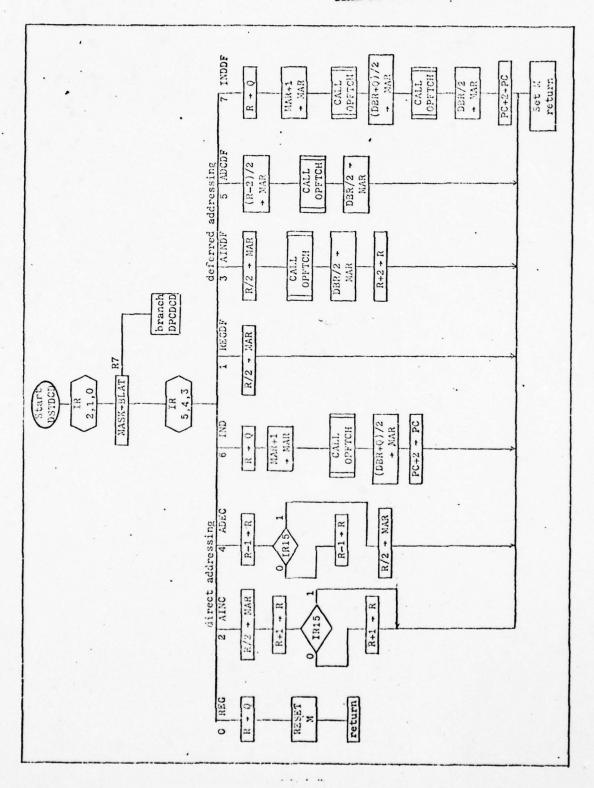


Figure A22. DSTDCD Flowchart

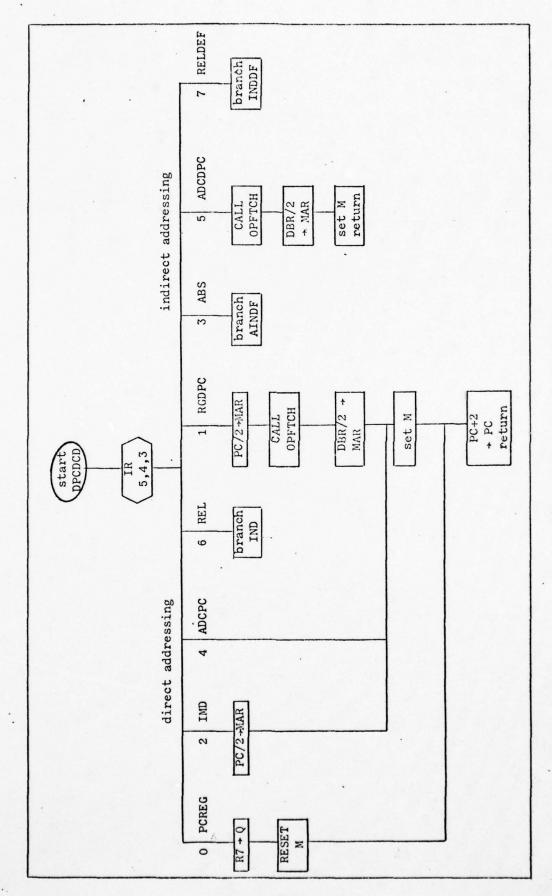


Figure A23. DPCDCD Flowchart

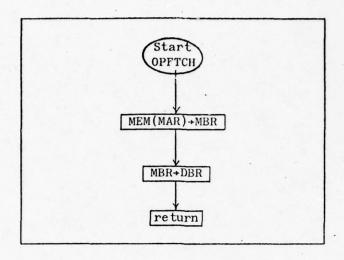


Figure A24. OPFTCH Flowchart

Buffer Register (DBR). The operand is then complemented and loaded into the MBR. Condition codes specified by COM are generated and stored in the CCR at this time. The MBR is then stored in the intial memory location. This completes execution of memory reference COM so the COM module branches back to IFTCH. Register reference COM as shown in Figure A21 is similar to the memory reference, but it omits the memory read and write cycles. CCMB is shown in Figure A25. It differs from COM in that only the specified byte is complemented. Register reference implies lower byte, whereas the least significant MAR bit must be tested to find the applicable memory reference byte.

MOV(B) transfers the source operand word (byte) to the destination location. As shown in Figure A26, MOV calls SRCDCD shown in Figure A27 to find the source operand. OPFTCH is called if memory reference, resulting in the operand being loaded into the ALU DBR. Register reference operands are also loaded into the DBR. The operand is then placed in the Q register and appropriate condition codes generated. DSTDCD is called to determine the destination location, and the operand is stored accordingly. Finally, MOV branches back to IFTCH. As shown

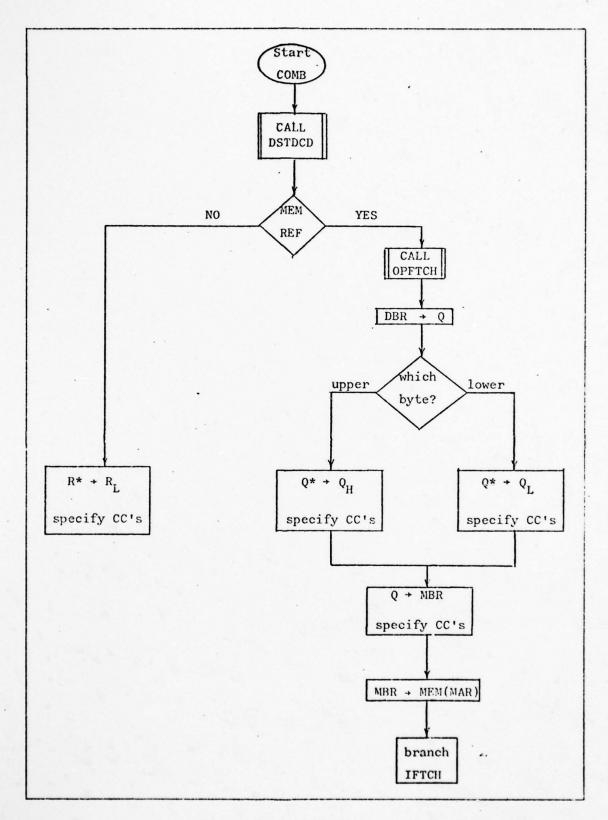


Figure A25. COMB Flowchart

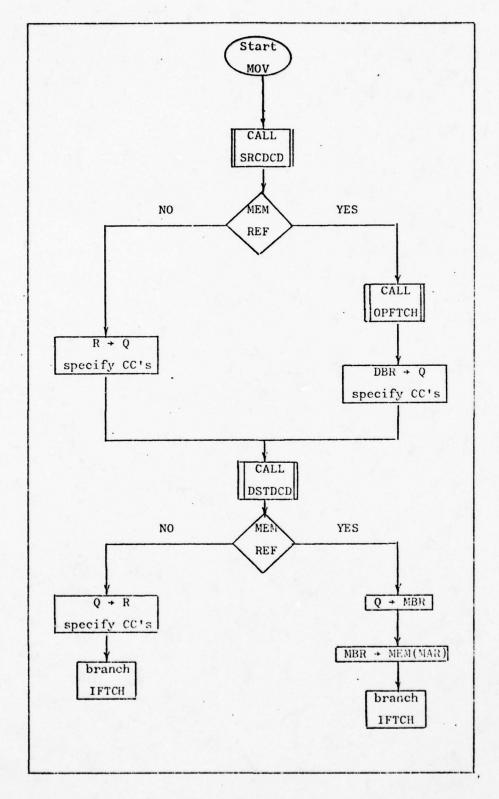


Figure A26. MOV Flowchart

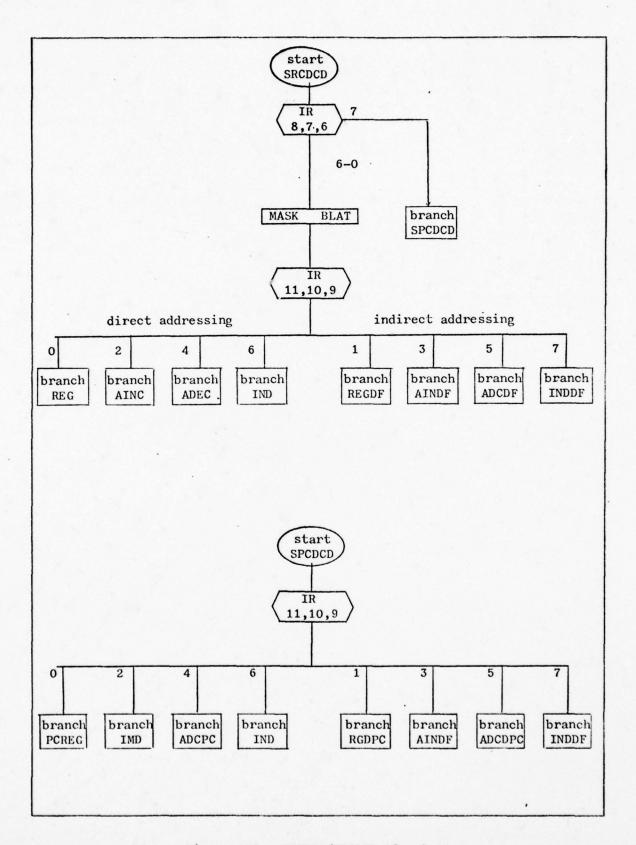


Figure A27. SRCDCD/SPCDCD Flowchart.

in Figure A28, MOVB differs in several respects. First, memory reference sources and destinations require testing to determine the pertinent byte. Second, the source byte must be aligned with the destination byte using SWABQ (Figure A29) if they are not both upper or lower. In addition, only a single byte of memory is written into for memory reference destinations. Finally, MOVB requires sign extension through the upper byte for register destinations.

which adds two times the offset (sign extended) to the PC if condition codes N and V are both set or clear. The BGE module shown in Figure A30 begins by testing condition codes N and V. If they are not both set or clear, the module branches back to IFTCH. Otherwise, the IR is multiplied by 2 and loaded into the lower byte of ALU general purpose register 13, R13 while the PC is loaded into the DBR. Based on IRO7, the lower byte of R13 is sign extended through the upper byte R13 is then added to the DBR which contains the PC and the result loaded back into the PC. Micro branching back to IFTCH allows the macro branch to occur when the new PC is used to fetch the next instruction, assuming no interrupt.

RTS, return from subroutine, loads the contents of the specified register into the PC and pops the memory stack into the register.

Referring to Figure A31, the RTS module first loads R into the PC and then calls micro subroutine POP in Figure A32 to retreive the top element of the stack. This is then loaded into the register and a branch to IFTCH initiated.

TRAP stacks the current CCR and PC and loads a new CCR and PC from memory locations octal 000036 and 000034 respectively. As shown in

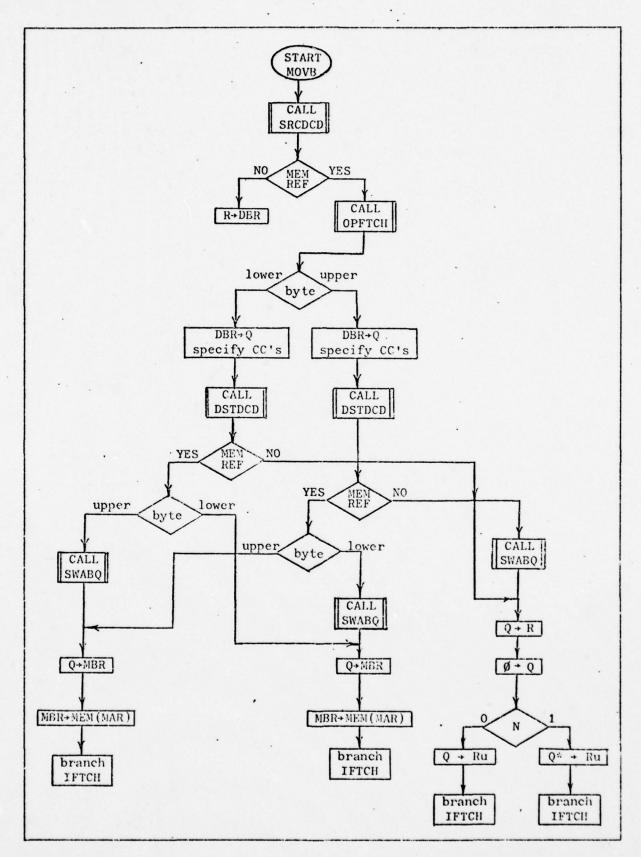


Figure A28. MOVB Flowchart

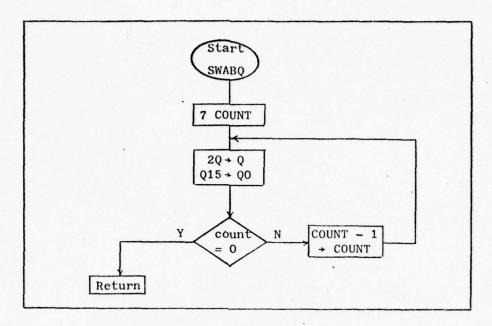


Figure A29. SWABQ Flowchart

Figure A33, this is accomplished by twice loading the MBR and calling PUSH and then loading the PC and CCR with the required constants. As will be discussed further in Appendix A, these constants are stored as part of the microword. Table AXII contains sample microcode generated to implement the emulated PDP-11/03 instructions discussed above.

#### Summary

The MIME microword was defined in the initial part of this section. Sample microword formats were then presented using various combinations of formatted fields. These two concepts were then illustrated by using microprogramming to emulate several PDP-11/03 instructions in the MIME architecture.

TRAP Flowchart

RTS Flowchart

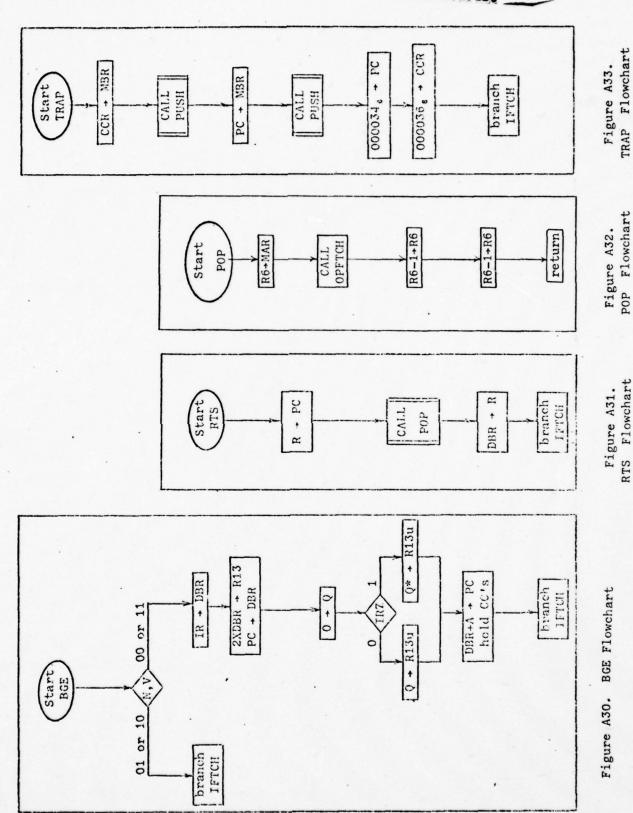


Table AXII Sample Microcode

			ADDR	3-0	cus		cus 3	C.S.s.	CONT	D; 14	g u	-
			BUS MADDR	7-4 3	11		NOP		HBRL C	S S	NOP F	 
			BUS	-	NOP		NOP		ALUS	MARS MEMR 1 5	NOF	
		٠	100	15-12	NOP	64	NOP	NOP	NOP	NOP	NOP	
			ALU B		×	×	××	××	××	××	××	
		1/0	-	23-20	×	×	××	××	××	××	××	
			ALU	-	×	×	××	**	00,DØ	on, x	on, øB	
			LI	3* 22					o No	NO NO	ő	
			ALU	30-28	×	×	××	××	ON, XNOR	8 8	on, xnor	
			UE	-						6	ON,	 
			ALU	.,	йсс, оғ	6	MCC, OF	MCC, OF	cc, OF	MCC, OF	cc, BOF	
	2, 5	ADDR ADDR	CEN	10	6	<b>о</b>	n n	пп	××	nn	nn	
	MICRO LOOP	MICHO BRANCH ADDR	R	10	8	<sub>®</sub>	BB	0 0	××	88	'e e	
	MIC	MICRO	O W	47-44	7	<b>!</b> ~	ທດ		××	00	00	
			CIN	143	×	×	××	××	××	××	×× ·	
IN	I/O TC MUX	ALU TC MUX	CARRY	56 55 - 52	×	×	××	××	SET	××	SET.	
CONSTANT	BR CONTR	CCU TC ALU TC NUX NUX	2	99 - 69	SET	í4	MEM 5	SET	WRD 5	××	KRD 5	
	BR MUX	10d	V V		S		C	· ·	CLR		CLR	
	-		NIN		POS	B	NEG 1	Pos	NRM, CLR	**	NRM, CLR 6	
				COMMENTS	CALL DSTDCD	address 789	Nem Ref Test	CALL OPFTCH address 123	DBR*+MBR,N:NRM Z:NRD,V:CLR, C:SET	MER-NEM(MAR), branch to IFICH (ØØ3)	Ri**Ri,N:NRM, Z:MHD,V:CLR, C:SET branch to IFTCH	,
				ADDA	500		201	562	593	25 25	10 10 10	

### VI. Maintenance

#### Introduction

This section has been included in the User's Manual for two reasons: first to review MIME troubleshooting features, and second to present procedures used in the initial integration and checkout of MIME.

#### Troubleshooting

Two features of MIME are particularly useful for troubleshooting: the hardwired front panel and the testpoint array. This section discusses the application of each of these features.

The front panel provides the capability to load and display the contents of registers within MIME and to single step through both macro and micro level programs. Once the user has ascertained that a problem is not caused by front panel malfunction, it may be used for further troubleshooting. Front panel capabilities allow the user to monitor information transfers occurring during program execution which aids isolation of malfunctions to particular circuit cards. Troubleshooting may then be continued at the card level using the test point array discussed below.

The testpoint array shown in Table AXIII is useful for monitoring critical signals within MIME, and in some instances tying these signals high or low for test purposes. The Module Test section contains examples of the use of this technique. If the malfunction cannot be isolated further using the testpoint array, more traditional scope and probe or firmware diagnostic techniques may have to be used.

Table AXIII
Testpoint Array

Testpoint	Function
TP1	+5 volts
TP2	GND
ТР3	-5 volts
TP4	+12 volts
TP5	GND
TP6	-12 volts
TP7	STOP*
TP8	WAITRQ*
ТР9	FETCH
TP10	MB3 (SYNCH)
· TP11	CP1
TP12	CP2
TP13	CP3

## Module Tests

In order to limit initial troubleshooting efforts to manageable proportions, MIME was powered-up and checked out incrementally. The front panel was brought up first so that it could be used in checking out the remaining modules. The CCU module was checked out next, providing microinstruction sequencing and decoding. The CS module was then integrated to provide microprogram storage for use with the CCU. The ALU was subsequently checked out by single stepping through microprograms stored in CS. Finally, the I/O module was checked out.

The following sections outline the operational checks performed by the authors to verify correct operation of each particular MIME module. Exhaustive checks of Memory, Control Store, and ALU were not practicable during initial integration because of the time required to do so manually. The authors recognized that diagnostic routines would have been helpful, so their generation was included as a recommendation in the MIME thesis.

Module tests are described using two types of tables. The first type as shown in Table AXIV lists required test equipment and describes set up of MIME cards, cables, and switches. The second type lists the actual test steps. As shown in Table AXV, the function column contains the function being tested, while the ACTION column lists user actions. Front panel switch activations are indicated by capitalized switch names. The OBSERVATION column includes front panel lights and displays, as well as some switching waveforms. The symbol X is used to specify "don't care". The symbols H and L refer to high (logic 1) and low (logic Ø) TTL levels respectively (Ref 7:3-8). The lower case symbols u and 1 refer to upper and lower byte of the subscripted register. Timing diagram tolerances are ± 50ns unless noted otherwise.

Front Panel. This series of tests checks cards FP1 and FP2 for proper operation. Table AXIV depicts equipment and setup requirements. Table AXV presents test procedures.

## Table AXIV

# FP Test Equipment and MIME Setup

Equipment:	
1.	Storage Oscilloscope (Tektronix 464 or equivalent)
2.	IC test clip (AP Products TC-16 or equivalent)
Setup:	
1.	Remove all cards except FP2 (card B)
2.	Check that cables 2 and 4 are connected
3.	Select OCTAL macro display format
4.	Remove red plexiglass front panel cover
5.	Tie Signal STOP* (TP7) to GND
6.	Select NORM micro field displays

Table AXV
FP Test Procedures

FUNCTION	ACTION	OBSERVATION
Control Logic Test	- Turn power on - RUN	- Following indicators will light: - all MACRO data displays - 3 least significant MICRO data displays - PC indicator - A indicator - HLT indicator - GOREQ (U10-13)
	- STOP* - VCC - HALT - STOP* - GND - RESET	- N/A - HALTREQ (U3-7) goes high - HALTREQ (U3-7) goes low
	- PAUSE	- PC and A indicators light - RESET* (U13-6)  - STOPREQ (U10-5)
18. 44	- STEP	- SSREQ (U11-13)
	- AUTO STEP	- ∿1Hz SSREQ (U11-13) pulse until RESET depressed
	- MSTEP	- MSTEPSEL (U3-4) goes high until RESET - MSTEP (U2-6) momentarily high
	- AUTO MSTEP	- AUTOSEL (U3-13) goes high until RESET
Macro Display Logic Test	- Macro >	<ul> <li>Macro select indicator moves one position each time switch is released. Two switch activations are required between Q and RØ.</li> <li>BP1 (PC305) - H</li> </ul>
	- BP2 on .	- BP2 (PC306) - H
	- MACRO DISP	- Macro display: 177777 DISP (U14-11) - H momentarily (except when DB, AB, or RØ-BP2 selected)

Table AXV (Continued)

FUNCTION	ACTION	OBSERVATION
	- MACRO DISP NEXT	- same as above, plus if MBR is selected:
		INCMAR1* 600ns (U94-1)  PP3 (U94-5) 300ns 300ns
Data	- MACRO	- N/A
Entry Logic Test	- KEYBOARD	- corresponding octal digits enter MACRO display (most significant display 1 or Ø only)
	- HEX	- 2 most significant MACRO displays blanked
	- KEYBOARD	- corresponding hex digits enter MACRO display
	- MICRO	- N/A
	- KEYBOARD	- corresponding hex digits enter MICRO display
	- FLDEN(S)	- N/A
	- KEYBOARD	- Hex digits enter enabled MICRO displays
	- LOAD	- MLDD* (U96-6) 600ns 600ns trigger on U92-5
		- MPP1* (U96-8) 900ns 300ns
	- LOAD NEXT	- same as above, plus if CS is selected INCMA (U66-1) - H momentarily
	- MACRO - LOAD	- N/A - LDD* (U96-3) 600ns 600ns trigger on U92-5
		- PP1 (U9-12) 900ns 300ns

Table AXV (Continued)

FUNCTION	ACTION	OBSERVATION
	- LOAD NEXT	- same as above, plus if MBR is selected:  INCMAR1* (U94-1) 600ns  PP3 (U94-5) 300ns 300ns
Micro Display Logic Test	- MICRO >  - BP on - DISP - DISP NEXT	<ul> <li>Micro select indicator moves one position each time switch depressed.         13 most significant MICRO displays blanked when in A or BP.     </li> <li>MBP (PC501) - H</li> <li>Micro display: FFFF,FFFF,FFFF</li> <li>same as above, plus if CS is selected:</li> <li>INCMA (U66-1) - H momentarily</li> </ul>

CCU. This series of tests checks cards CCU1 and CCU2 for proper operation. Equipment and set requirements are presented in Table AXVI, test procedures in Table AXVII. Mnemonics such as JZ in the FUNCTION column of Table AXXVIII refer to the particular microaddress sequencer instruction being tested. These same mnemonics are used in the OBSERVATION field beside their associated microinstructions. T = H or L refers to the test condition value associated with conditional sequencer instructions. Quantities in parenthesis such as (ABB+PC) refer to internal sequencer transfers as explained in Reference 2.

Table AXVI
CCU Test Equipment and Setup

Equipment	:
1.	Multimeter (Triplett 63Ø-NS or equivalent)
2.	Logic Clip (HP 1Ø528A or equivalent)
3.	Extender card
Setup:	
1.	Remove all cards except FP1, FP2(B), CCU1(D), and CCU2(E)
2.	Place CCU1 on extender
3.	Check that cables 2, 3, 4, and 5 are connected
4.	Select NORM micro field displays
5.	CCU:S1-OFF, S2-OFF, S3-OFF, S4-OFF

Table AXVII

## CCU Tests

FUNCTION	ACTION	OBSERVATION
PL Test	- Turn on Power (+5) - MSTEP - DISP PL	- HLT on, PC on, A on - N/A (change clock mode to manual) - Micro display: FFFF,FFFF,FFFF,FFF716
	- LOAD PL - change micro display - DISP PL	<ul> <li>Micro display: test data (user specified)</li> <li>Micro display: X</li> <li>Micro display: test data</li> </ul>
PC Test	- DISP PC - LOAD PC - change macro display - DISP PC - LOAD PL - RUN, MSTEP, MSTEP - DISP PC	- Macro display: ØØØØ16 - Macro display: test data - Macro display: X - Macro display: test data - Micro display:
IR Test	- LOAD IR - Change Macro display - DISP IR	- Macro display: test data - Macro display: X - Macro display: test data
Initial Starting Addr Test	- DISP A - S2 - ON, RESET - DISP A -S3 - ON, RESET - DISP A	- Micro display: CØØ - N/A - Micro display: 4ØØ - N/A - Micro display: ØØØ
Decode Test (without mapping PROM)	- S4 - ON , - LOAD IR - LOAD PL - DISP A - LOAD PL - DISP A	- N/A - Macro display: AA55 - Micro display: XXXX,XXXX,AFF2 - TP5(WAITRQ*) - Micro display: 255 (IR 9-Ø) - Micro display: XXXX,XXXX,XXXX,ØXX2 - Micro display: 2A9(IR15-6)

Table AXVII (Continued)

FUNCTION	ACTION	OBSERVATION
Sequencer Tests JZ	- LOAD PL - DISP A	- Micro display: XXXX,XXXX,XXXX,FFFØ (JZ) - Micro display: ØØØ
CJS, CRTN	- RESET - LOAD PL - DISP A - RESET (AAB+PC) - LOAD PL - DISP A - LOAD PL - DISP A - LOAD PL - DISP A - LOAD PL	- N/A - Micro display:     OFXX,AAAX,XXXX,FFF1 (CJS,T=H) - Micro display: AAA - N/A - Micro display:     IFXX,BBBX,XXXX,FFF1 (CJS,T=L) - Micro display: AAB (AAA+1) - Micro display:     IFXX,XXXX,XXXX,FFFA (CRTN,T=L) - Micro display:AAB - Micro display:     OFXX,XXXX,XXXX,FFFA (CRTN,T=H) - Micro display: 001
JMAP .	- LOAD IR - LOAD PL - DISP A	- Macro display: AA55 - Micro display: XXXX,XXXX,XXXX,FFF2 (JMAP) - Micro display: 2A9 (IR15-6)
CJP	- LOAD PL - DISP A - RESET (AAB+PC) - LOAD PL - DISP A	- Micro display:    OFXX,AAAX,XXXX,FFF3 (CJP,T=H) - Micro display: AAA - N/A - Micro display:    1FXX,BBBX,XXXX,FFF3 (CJP,T=L) - Micro display: AAB (AAA+1)
PUSH RFCT	- LOAD PL  - DISP A - RESET (AAC+F) - LOAD PL  - DISP A - RESET (AAD+PC) - LOAD PL  - DISP A	- Micro display:     OFXX,001X,XXXX,FFF4 (PUSH,T=H) - Micro display: AAB - N/A - Micro display:     16XX,XXXX,XXXX,FFF8 (count≠0) - Micro display: AAC (file) - N/A - Micro display:     16XX,XXXX,XXXX,FFF8 (RFCT, count=0) - Micro display: AAD (AAC+1)

Table AXVII (Continued)

FUNCTION	ACTION	OBSERVATION
JP,JRP	- LOAD PL - DISP A - RESET (555+R) - LOAD PL - DISP A - LOAD PL - DISP A	- Micro display:    XXXX,555X,XXXX,FFFF (JP) - Micro display: 555 - N/A - Micro display:    1FXX,AAAX,XXXX,FFF7 (JRP,T=L) - Micro display: 555 - Micro display:    0FXX,AAAX,XXXX,FFF7 (JRP,T=H) - Micro display: AAA
CONT, JSRP	- LOAD PL  - RESET (667+PC) - LOAD PL  - DISP A - RESET (668+PC,777+R) - LOAD PL  - DISP A - RESET (PUSH 668) - LOAD PL  - DISP A	- Micro display:    XXXX,666X,XXXX,FFFF (JP) - N/A - Micro display:    XXXX,777X,XXXX,FFFE(CONT) - Micro display: 667 - N/A - Micro display:    1FXX,BBBX,XXXX,FFF5(JSRP,T=L) - Micro display: 777 - N/A - Micro display:    0FXX,XXXX,XXXX,FFFA(CRIN,T=H) - Micro display: 668
JSRP	- LOAD PL - RESET (778+PC) - LOAD PL - DISP A - RESET (PUSH 778) - LOAD PL - DISP A	- Micro display:    XXXX,777X,XXXX,FFFE (CONT) - N/A - Micro display:    OFXX,CCCX,XXXX,FFF5 (JSRP,T=H) - Micro display: CCC - N/A - Micro display:    OFXX,XXXX,XXXX,FFFA (CRTN,T=H) - Micro display: 778
LDCT, RPCT	- LOAD PL  - DISP A - RESET (002+CT) - LOAD PL  - DISP A - RESET (DEC CT,AAB+PC) - LOAD PL  - DISP A	- Micro display:    XXXX,002X,XXXX,FFFC (LDCT) - Micro display: 778 - N/A - Micro display:    16XX,AAAX,XXXX,FFF9 - Micro display: AAA - N/A - Micro display:    16XX,AAAX,XXXX,FFF9 - Micro display:    16XX,AAAX,XXXX,FFF9 - Micro display: AAA

Table AXVII (Continued)

		Υ
FUNCTION	ACTION	OBSERVATION
LDCT, RPCT (cont)	- RESET (DEC CT, AAB+PC) - LOAD PL - DISP A	- N/A  - Micro display: 16XX,AAAX,XXXX,FFF9 (RPCT count=0)  - Micro display: AAB (AAA+1)
LOAD A	- S4 - OFF - LOAD A - DISP A	- N/A - Micro display: 006 - Micro display: 006
CJPP, LOOP	- RESET (007+PC) - S4 - ON - LOAD PL - RESET (PUSH 007) - LOAD PL - RESET (FOD+PC) - LOAD PL - RESET (PUSH FOD, FOE+PC) - LOAD PL - DISP A - RESET (POP FOD) - LOAD PL - DISP A - RESET (008+PC) - LOAD PL - DISP A - RESET (008+PC) - LOAD PL	- N/A - N/A - Micro display:     XXXX,XXXX,XXXX,FFF4 (PUSH) - N/A - Micro display:     XXXX,FOCX,XXXX,FFFF (JP)  - Micro display:     XXXX,XXXX,XXXX,FFF4 (PUSH) - N/A - Micro display:     OFXX,777X,XXXX,FFFB (CJPP,T=H) - Micro display:     1FXX,777X,XXXX,FFFB (CJPP,T=L) - Micro display:     1FXX,777X,XXXX,FFFB (CJPP,T=L) - Micro display:     1FXX,XXXX,XXXX,FFFD (LOOP,T=H) - Micro display:     0FXX,XXXX,XXXX,FFFD (LOOP,T=L) - Micro display:     0FXX,XXXX,XXXX,FFFD (LOOP,T=L) - Micro display:     008
Microbreak	- S4 - OFF - LOAD BP (micro)	- N/A - Micro display: ABC

Table AXVII (Continued)

FUNCTION	ACTION	OBSERVATION
Microbreak (cont)	- DISP BP - LOAD A	- Micro display: ABC - MB3 (TP10) - L - Micro display: ABC - MB3 - H
Clock Logic	- RESET - MSTEP - RUN - MSTEP - PAUSE (hold) - MSTEP, release PAUSE - MSTEP - RUN, MSTEP - RUN, MSTEP - WAITRQ* (TP8) - GND - MSTEP - MSTEP - TP5 - REMOVE GND - MSTEP - MSTEP - MSTEP - MSTEP	- N/A - N/A - N/A - N/A - RUN on ; - CP1 (TP11) - H momentarily - N/A - HLT on - N/A - RUN on - N/A - RUN on - N/A - CP1 - H momentarily - CP1 - L - N/A - CP1 - L - CP1 - H momentarily
SS Logic (including front panel)	- RESET - FETCH (TP9) - GND - AUTO MSTEP - RESET - RUN - FETCH - remove GND - HALT - FETCH - GND - AUTO STEP - FETCH - remove GND - FETCH - remove GND - FETCH - GND - FETCH - GND	- N/A - N/A - N/A - CP1

Table AXVII (continued)

FUNCTION	ACTION	OBSERVATION
16 Way Branch	- S4 - ON - LOAD IR - LOAD PL	- N/A - Macro display: FFFØ <sub>16</sub> - Micro display: ØFXX,AAØX,XXXX,5FFF (JPL)
	- DISP A	- Micro display: AAØ
	- LOAD IR	- Macro display: FFFA
	- DISP A	- Micro display: AAA
	- LOAD PL	- Micro display: ØAXX,AAØX,XXXX,5FFF (JPL)
	- DISP A	- Micro display: AA2
	- LOAD PL	- Micro display: ØAXX,AAØX,XXXX,FFFF (JPL)
	- DISP.A	- Micro display: AAØ

CS1. These tests verify proper operation of the RAM portion of CS1. EPROM operation may be verified using similar procedures.

Table AXVIII lists equipment requirements and MIME setup procedures.

Test procedures are presented in Table AXIX. Quantities in parentheses beside CS contents are the address of that microword.

## Table AXVIII

## CS1 Test Equipment and MIME Setup

Equipment	:
1.	Storage oscilloscope (Tektronix 464 or equivalent)
2.	Logic clip (AP Products TC-16 or equivalent)
Setup:	
1.	Remove ALU, I/O, and MEM1 cards
2.	Place CS1 card on extender
3.	Check that cables 1, 2, 3, 4, 5, and 7 are connected
4.	Select NORM micro field displays
5.	CCU2: S1 - OFF, S2 - ON, S3 - ON, S4 - OFF
6.	Select MICRO data entry

Table AXIX

## CS1 Tests

FUNCTION	ACTION	OBSERVATION
Front	- Turn on Power (+5v)	- HLT on, PC on, A on
Panel LOAD and DISP	- LOAD A	- Micro display: ØXX (test addr., Ø to 253 <sub>10</sub> )
	- LOAD NEXT CS	- Micro display: AAAA,5555,AAAA,55555 (ØXX)
	- LOAD NEXT CS	- Micro display: 5555,AAAA,5555,AAAA (ØXX+1)
	- DISP A	- Micro display: ØXX+2
	- LOAD A	- Micro display: ØXX
	- DISP NEXT CS	- Micro display: AAAA,5555,AAAA,5555 (ØXX)
	- DISP CS	- Micro display: 5555,AAAA,5555,AAAA (ØXX+1)
	- DISP A	- Micro display: 0XX+1
	- LOAD A	- Micro display: 4YY (test addr)
	- LOAD CS.	- Micro display: 1111,0000,1111,0000 (4YY)
	- DISP CS	- Micro display: FFFF,FFFF,FFFF (4YY)
Front	- LOAD A	- Micro display: OXX
Panel FLDEN	- FLDEN (least sig.)	- N/A
	- LOAD CS	- Micro display: N/A (trigger MLD* - CU38-05, U14) - E4*(CU37-12,R16)
		∿900ns 300ns (±50ns)
		- E3*(CU36-6,P13) ~900ns 300ns (±50ns)
		- E2*(CU36-8,N12)
		∿900ns 300ns
		- E1*(CU36-12,N16)

Table AXIX (Continued)

FUNCTION	ACTION	OBSERVATION
Front Panel FLDEN (cont)	- FLDEN (2nd least sig.) - LOAD CS  - FLDEN(3rd least sig.) - LOAD CS  - FLDEN (most sig.) - LOAD CS	- N/A  - Micro display: N/A  - E4* ~900ns 300ns (±50ns)  - E3* ~900ns 300ns (±50ns)  - E2*  - E1*  - N/A - Micro display: N/A - E4* ~900ns 300ns (±50ns)  - E3* - E2* - E1*  - N/A - Micro display: N/A - E4* - E3* - E2* - E1* - E4* - F3* - E2* - E1*
EPROM Protect, asynch. logic	- NORM (all fields) - LOAD A - LOAD A - LOAD A	- N/A  - Micro display: 4XX (an address in EPROM)  - Micro display: N/A (trigger MLD* - CU38-05,U14)  - E4* \( \square\)900ns \( \square\)300ns  - E3* \( \square\)900ns \( \square\)300ns  - E2* \( \square\)900ns \( \square\)300ns  - E1* \( \square\)900ns \( \square\)300ns  - Micro display: \( \square\)XX (an address in RAM)  - WAITRQ*(TP9) \( \square\)250ns \( (+50ns,) \)  - Micro display: 4XX  - WAITRQ* \( \square\)450ns \( (+50ns,) \)

<u>ALU.</u> This series of tests checks ALU operation. Equipment requirements and setup procedures are presented in Table AXX, and test procedures in Table AXXI.

## Table AXX

## ALU Test Equipment and MIME Setup

Equi	pment:
	- Extender card
Setu	ıp:
	1. Remove I/O and MEM1 cards
	2. Place ALU card on extender
	3. Check that all cables are connected
	4. Select NORM micro field display
	5. CCU2: S1 - OFF, S2 - ON, S3 - ON, S4 - OFF

Table AXXI

# ALU Tests

FUNCTION	ACTION .	OBSERVATION	
Front Panel	- Turn on Power (+5v)	- HLT on, PC on, A on	
Interface	- LOAD ALU	- Macro display: test data A	
	- LOAD Q - Change macro display	- N/A - Macro display: -	
	- DISP Q	- Macro display: test data A	
	- LOAD ALU	- Macro display: test data B	
	- LOAD R9 - Change macro display	- N/A - Macro display: -	
	- DISP R9	- Macro display: test data B	
	- DISP CCR	- Macro display: XXØØ <sub>16</sub>	
	- LOAD CCR - Change macro display	- Macro display: test data C - N/A	
	- DISP CCR	- Macro display: test data C	
MSKB Test	- LOAD PL	- Micro display: AA55,XXXX,XXXX,FDFF	
	- DISP DB	- Macro display: AA55	
	- RESET	- N/A	
	- DISP DB	- Macro display: FFFF	
Arithmetic Tests micro-	- RESET - LOAD ALU - LOAD R5	- N/A - Macro display: ØØ55 - Macro display: ØØ55	
program	- LOAD ALU - LOAD RIØ - LOAD A	- Macro display: AAØØ - Macro display: AAØØ - Micro display: Ø11	
(QOF,ADD,AB)	- LOAD NEXT CS	(initial microaddress)  - Micro display: E7E6,XXXØ,Ø15A,8F6E (Ø11)	
(BOF,S-R,AQ)	- LOAD NEXT CS	- Micro display: B6F1,XXX3,1Ø52,8F6E (Ø12)	
	- RESET - LOAD A	- N/A - Micro display: Ø11	

Table AXXI (Continued)

FUNCTION	ACTION	OBSERVATION	
Arithmetic	- Select DB display	– DB on	
Tests Micro- Program (cont)	- MSTEP, RUN, MSTEP	- Micro display: Ø11; RUN on - Macro display: FFFF, N=Ø,Z=Ø,C=Ø,OVR=Ø	
	- MSTEP	- Micro display: Ø12 - Macro display: AA55,N=1,Z=1,C=Ø,OVR=Ø	
	- MSTEP	- Micro display: Ø13 - Macro display: AAØØ, N=0,Z=0,C=1,OVR=1	
	- RESET - DISP R2 - DISP R5 - DISP Q	- HLT on - Macro display: AAØØ - Macro display: ØØ55 - Macro display: AA55	
Logic Test Micro-	- LOAD ALU - LOAD R7 - LOAD ALU	- Macro display: AAAA - Macro display: AAAA - Macro display: 5555	
Program	- LOAD A	- Micro display: ØAØ	
(QOF, AND, DA)	- LOAD NEXT CS	- Micro display: XXXX,XXXØ,457X,8FFE (ØAØ)	
(QOF,OR,DA)	- LOAD NEXT CS - RESET - LOAD A	- Micro display: XXXX,XXXØ,357X,8FFE (ØA1) - N/A - Micro display: ØAØ	
	- Select ALU display	- ALU on	
	- MSTEP, RUN, MSTEP	- Micro display: ØAØ ; RUN on - Macro display: FFFF	
	- MSTEP	- Micro display: ØA1 - Macro display: ØØØØ	
	- MSTEP	- Micro display: ØA2 - Macro display: FFFF	
	- RESET	- HLT on	

Table AXXI (Continued)

FUNCTION	ACTION	OBSERVATION
Shift/ Byte tests	- LOAD ALU - LOAD R1 - LOAD ALU - LOAD Q - LOAD CCR	- Macro display: 781B - Macro display: 781B - Macro display: 5555 - Macro display: AAAA - Macro display: XXX8
rotate word R and Q right, carry	- LOAD A - LOAD NEXT CS	- Micro display: ØBC - Micro display: XXXX,223C,37ØF,8FFE (ØBC)
rotate word R and Q left, one	- LOAD NEXT CS	- Micro display: XXXX,443E,37ØE,8FFE (ØBD)
rotate lower byte right	- LOAD NEXT CS	- Micro display: XXXX,XXØD,B3Ø1,8FFE (ØBE)
rotate upper byte left	- LOAD NEXT CS  - RESET - LOAD A - Select ALU display - MSTEP, RUN, MSTEP - MSTEP - MSTEP - MSTEP - MSTEP	- Micro display:    XXXX,XXØF,3BØØ,FFFE (ØBF) - N/A - Micro display: (ØBC) - ALU on  - Micro display: ØBC; RUN on - Macro display: FFFF - Micro display: ØBD - Macro display: 5555 - Micro display: ØBE - Macro display: ØBF - Macro display: 781B - Micro display: ØCØ - Macro display: 78ØD
	- RESET	- HLT on
	- DISP R1	– Macro display: FØØD
	- DISP R14 - DISP R15	- Macro display: 5555 - Macro display: AAAA
	- DISP Q	- Macro display: 5555

MEM 1. These tests verify proper operation of the MEM 1 card. Equipment requirements and MIME set up procedures are presented in Table AXXII. Table AXXIII contains the test procedures.

## Table AXXII

MEM 1 Test Equipment and MIME Setup

Equipment	:
- E	xtender card
Setup:	
1.	Remove I/O card
2.	Place MEM1 card on extender
3.	Check that all cables are connected
4.	Select NORM micro field display
5.	CCU: S1 - OFF, S2 - ON, S3 - ON, S4 - OFF

Table AXXIII
MEM1 Tests

FUNCTION	ACTION	OBSERVATION
Front	- Turn on Power (+5v)	- HLT on, PC on, A on
Panel LOAD and	- LOAD MAR	- Macro display: ØØA5
DISP	- LOAD MBR	- Macro display: 44BB (ØØA5)
	- DISP MAR	- Macro display ØØA5
	- DISP MBR	- Macro display: 44BB (ØØA5)
	- LOAD MAR	- Macro display: Ø123
	- LOAD NEXT MBR	- Macro display: FEED (Ø123)
	- LOAD NEXT MBR	- Macro display: BABE (Ø124)
	- DISP MAR	- Macro display: Ø125
	- LOAD MAR	- Macro display: Ø123
	- DISP NEXT MBR	- Macro display: FEED (Ø123)
	DISP NEXT MBR	- Macro display: BABE (Ø124)
Program	- LOAD MAR	- Macro display: Ø25A
Control	- LOAD MBR	- Macro display: ØØØØ
	- LOAD ALU	- Macro display: ØØCD
	- LOAD RØ	- Macro display: ØØCD
	- LOAD ALU	- Macro display: ABØØ
	- LOAD R1	- Macro display: ABØØ
	- LOAD A	- Micro display: Ø77
(RØ+MBR)	- LOAD NEXT CS	- Micro display: XXXX,XXX1,33XØ,762E (Ø77)
(MBR→MEM <sub>L</sub> )	- LOAD NEXT CS	- Micro display: XXXX,XXX1,8ØXX,F15E (Ø78)
(R1→MBR)	- LOAD NEXT CS	- Micro display: XXXX,XXX1,33X1,762E (Ø79)

Table AXXIII (Continued)

OAD NEXT CS ESET OAD A ELECT DB display	- Micro display: XXXX,XXX1,Ø8XX,F15E (Ø7A) - N/A - Micro display: Ø77
OAD A	
	- Micro display: 977
Dubor DD arbpray	- DB on
STEP, RUN, MSTEP	- Micro display: Ø77; RUN on - Macro display: FFFF
STEP	- Micro display: Ø78 - Macro display: ØØCD
STEP	- Micro display: Ø79 - Macro display: FFFF
STEP	- Micro display: Ø7A - Macro display: ABØØ
STEP	- Micro display: Ø7B - Macro display: FFFF
ESET	- HLT on
ISP MBR	- Macro display: ABCD
	STEP STEP STEP ESET

I/O. This series of tests checks I/O card operation. Table AXXIV contains equipment requirements and MIME setup procedures. Table AXXV contains test procedures.

## Table AXXIV

# I/O Test Equipment and MIME Setup

Equ	ipment:
	- Extender card
Set	up:
	1. All cards in place
	2. Place I/O card on extender
	3. Check that all cables are connected
	4. Select NORM micro field display
	5. CCU: S1 - OFF, S2 - ON, S3 - ON, S4 - OFF

Table AXXV

FUNCTION	ACTION	OBSERVATION
Front Panel	- Turn on Power (+5v)	- HLT on, PC on, A on
Integration	- LOAD MR	- Macro display: XXAA
	- LOAD SR	- Macro display: XXX5
	- DISP MR	- Macro display: FFAA
	- DISP SR	- Macro display: FFF5
	- LOAD WCR	- Macro display: 57AB
	- LOAD BAR	- Macro display: BA75
	- DISP WCR	- Macro display: 57AB
	- DISP BAR	- Macro display: BA57
Program	- LOAD WCR	- Macro display: FFFE
Control Operation	- LOAD BAR	- Macro display: FFFD
	- LOAD ALU	- Macro display: XXØ8
	- LOAD Q	- Macro display: XXØ8 (For use as Mask)
	- LOAD ALU	- Macro display: XXX2 (For use as Status)
	- LOAD A	- Micro display: Ø55
MCL	- LOAD NEXT CS	- Micro display: XXXX,XXX9,XXØX,CFFE (Ø55)
LMR	- LOAD NEXT CS	- Micro display: . XXXX,XXX9,32EX,CFFE (Ø56)
LSR .	- LOAD NEXT CS	- Micro display: XXXX,XXX9,379X,C6FE (Ø57)
continue	- LOAD NEXT CS	- Micro display: XXXX,XXX9,XXXX,FFFE (Ø58)

Table AXXV (Continued)

RDV	(Ø59)
- LOAD A - LOAD NEXT CS - Micro display:	
RMR - LOAD NEXT CS - Micro display:  XXXX,XXX9,XX7X,C9FE  - RESET - N/A  - LOAD A - Micro display: Ø55  - DB on - Micro display: Ø55  - DB on - Micro display: Ø55  - Macro display: FFFF  MCL - MSTEP - Micro display: Ø56  - Macro display: FFFF  LMR - MSTEP - Micro display: Ø57  - Macro display: XXØ8  - Micro display: XXØ8  - Micro display: XXØ8  - Micro display: XXØ8  - Micro display: XXX2  - N/A  (int. req Momentarily GND P4 (HU31-26,H36)  - MSTEP - Micro display: Ø59  - Macro display: Ø59  - Macro display: FFFF	(40.1)
XXXX,XXX9,XX7X,C9FE  - RESET - LOAD A - Select DB display - MSTEP, RUN, MSTEP  MCL - MSTEP  MCL - MSTEP  MCL - MSTEP  MCL - MSTEP  MICRO display: Ø55 - Macro display: Ø56 - Macro display: FFFF - Micro display: Ø57 - Macro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: XXXZ - N/A  (int. req Momentarily GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: Ø59 - Macro display: FFFF	(Ø64)
- RESET - LOAD A - Select DB display - MSTEP, RUN, MSTEP  MCL - MSTEP  MCL - MSTEP  - Micro display: Ø55 - Macro display: Ø56 - Macro display: FFFF - Micro display: FFFF - Micro display: Ø57 - Macro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: XXXØ8 - Micro display: XXXZ - N/A  (int. req Momentarily GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: Ø59 - Macro display: FFFF	(Ø65)
- Select DB display - MSTEP, RUN, MSTEP  MCL - MSTEP  - Macro display: Ø55 - Macro display: Ø56 - Macro display: Ø56 - Macro display: FFFF - Micro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: Ø58 - Macro display: XXX2 - N/A  (int. req Momentarily GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
- MSTEP, RUN, MSTEP  - Micro display: Ø55 - Macro display: FFFF - Micro display: Ø56 - Macro display: FFFF - Micro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: Ø58 - Macro display: XXX2 - N/A  - MSTEP - Micro display: Ø58 - Macro display: XXX2 - N/A  - Micro display: FFFF - Micro display: Ø59 - Macro display: FFFF	
- Macro display: FFFF  MCL - MSTEP - Micro display: Ø56 - Macro display: FFFF  - Micro display: FFFF  - Micro display: FFFF  - Micro display: FFFF  - Micro display: Ø57 - Macro display: XXØ8 - Micro display: Ø58 - Macro display: XXX2 - N/A  P4) GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
MCL - MSTEP - Micro display: Ø56 - Macro display: FFFF  LMR - MSTEP - Micro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: XXX2 - Micro display: XXX2 - N/A  (int. req Momentarily GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	; RUN on
- Macro display: FFFF - Micro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: XXXØ8 - Micro display: Ø58 - Macro display: XXX2 - N/A  P4)  GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
LMR - MSTEP - Micro display: Ø57 - Macro display: XXØ8 - Micro display: XXØ8 - Micro display: XXØ8 - Micro display: Ø58 - Macro display: XXX2 - N/A P4)  GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
LSR - MSTEP - Macro display: XXØ8 - Micro display: Ø58 - Macro display: Ø58 - Macro display: XXX2 - N/A P4) GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
LSR - MSTEP - Micro display: Ø58 - Macro display: XXX2 - N/A  (int. req Momentarily GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
(int. req Momentarily GND P4 (HU31-26,H36) - MSTEP - Macro display: XXX2 - N/A - Micro display: Ø59 - Macro display: FFFF	
(int. req Momentarily - N/A  GND P4  (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
P4) GND P4 (HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
(HU31-26,H36) - MSTEP - Micro display: Ø59 - Macro display: FFFF	
- MSTEP - Micro display: Ø59 - Macro display: FFFF	
- Macro display: FFFF	
RDV - MSTEP - Micro display: d64	; INT or
- Micro display. 904	
- Macro display: FFFF	
RSR - MSTEP - Micro display: Ø65	
- Macro display: FFF5	
RMR - MSTEP - Micro display: Ø66	
- Macro display: FFØ8	
- RESET - HLT on	
Bus - LOAD A - Micro display: Ø64	
Contention - FLDEN (L.S.) - N/A	
Logic	
RSR - LOAD NEXT CS - Micro display:	
(w/contention) XXXX,XXXX,CFFE	
RMR - LOAD NEXT CS - Micro display:	
(w/contention) XXXX,XXXX,CFFE	
- RESET - N/A	
- LOAD A - Micro display: Ø64	
- NORM (all) - N/A	,
- Select DB display	
- MSTEP, RUN, MSTEP - Micro display: Ø64	
- MSTEP, RUN, MSTEP - Micro display: Ø64 - Macro display: FFFF	. DIN
- Macro display, FFFF	; RUN on

Table AXXV (Continued)

FUNCTION	ACTION	OBSERVATION
RSR	- MSTEP	- Micro display: Ø65 - Macro display: FFFF
RMR	- MSTEP	- Micro display: Ø66 - Macro display: FFFF
	- RESET	- HLT on
	- DISP SR	- Macro display: FFF5
	- DISP MR	- Macro display: FFØ8

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- 6. Pennett, Gary and Saleem Iftekar. Design of an R232 Interface for the Microprogrammable Minicomputer Emulator. Unpublished laboratory report. Wright-Patterson Air Force Base: Air Force Institute of Technology, 1978.
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## Appendix 1

## Schematics

This appendix contains a schematic that describes the electrical configuration of each circuit card. In order to simplify the drawings, the following conventions were used:

- Even though the logic gates used were on IC's, individual logic symbols were used for functional clarity.
- 2. Where two or more IC's of the same type are adjacent, pin numbers for the connections are given for only one, and the others may be assumed to follow the same pattern.
- 3. A connection between intersecting lines is designated by a dot.
- 4. A fillet connecting two lines indicates a connection to a bus.
  Where an IC has several adjacent connections to a bus, only the first and last connections are named.
- 5. Connections to edge or cable connectors are designated by the symbol <<.</p>

The user will find it helpful to use the schematics in conjunction with the wiring tables which are available from the laboratory staff.

A sketch of the component layout is included for FP1, but the wiring tables contain the information for all other circuit cards.

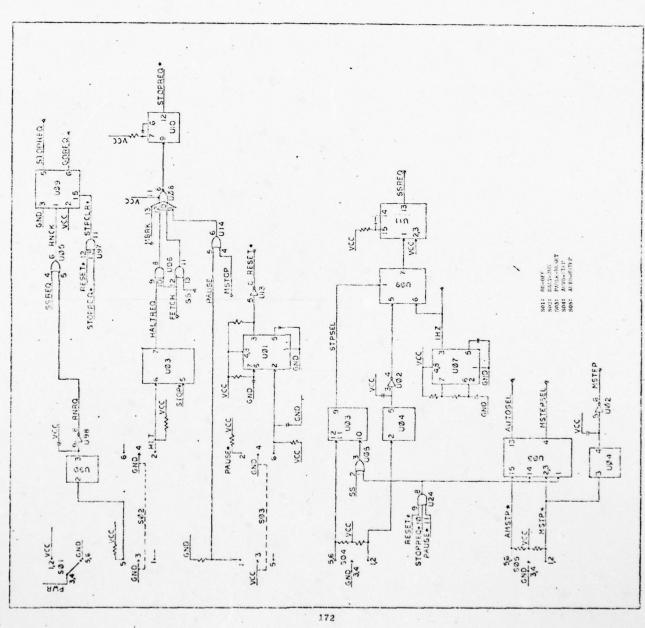


Figure 434. FP1 Schematic

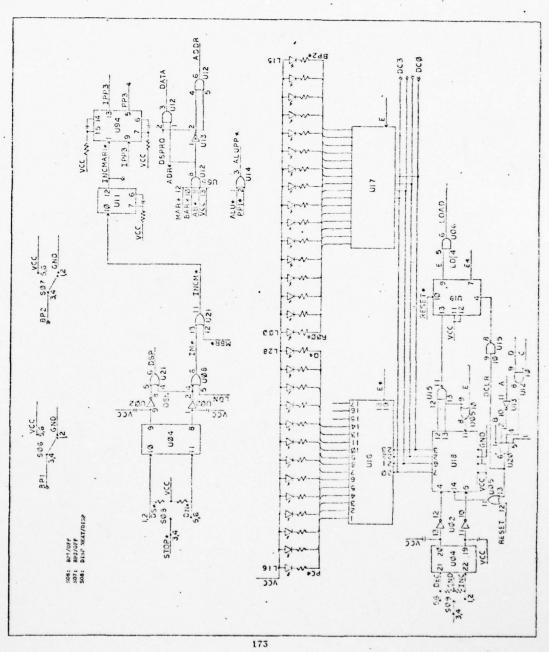


Figure A34. (Continued)

Figure A34. (Continued)

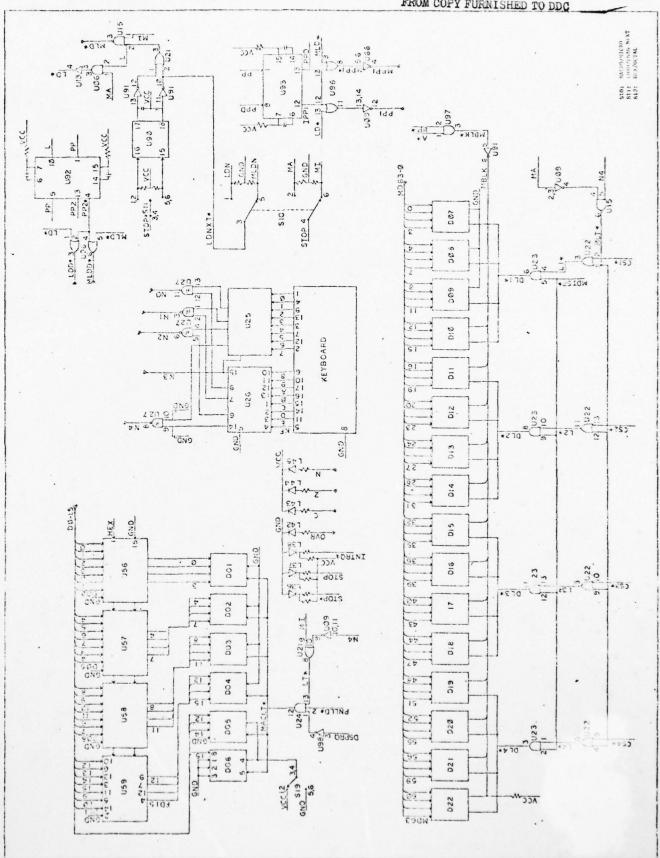
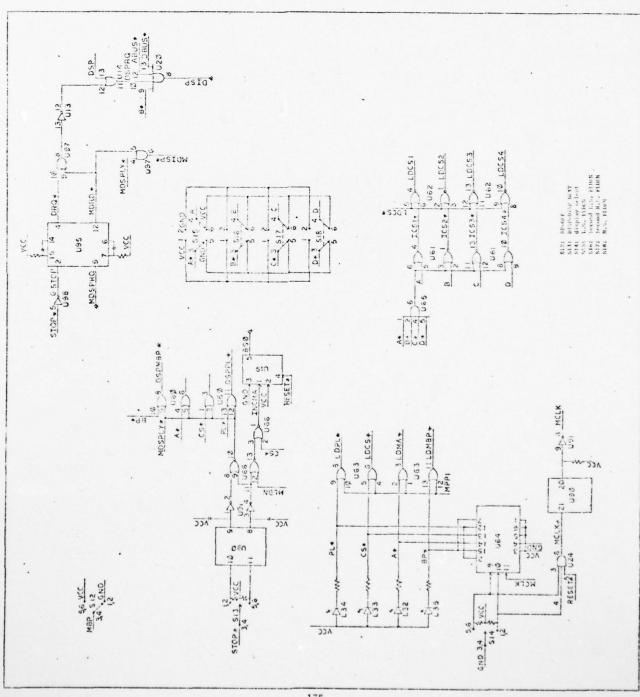
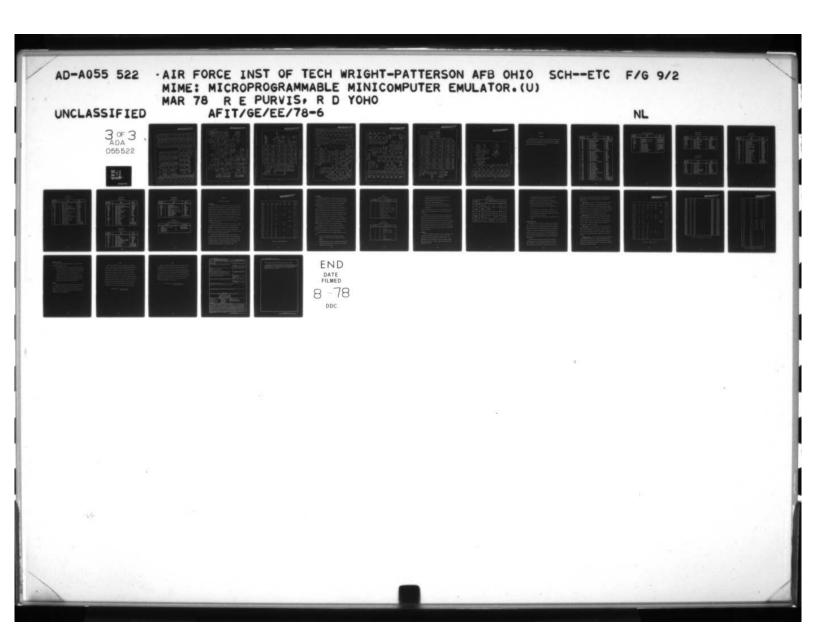


Figure A34. (Continued)





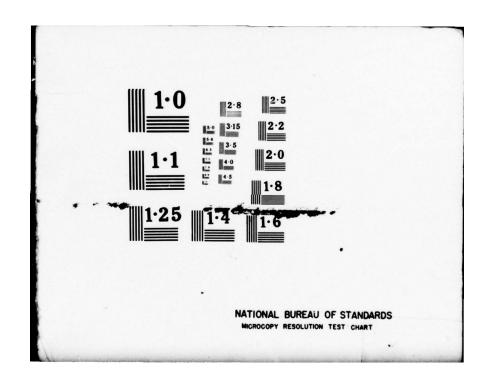
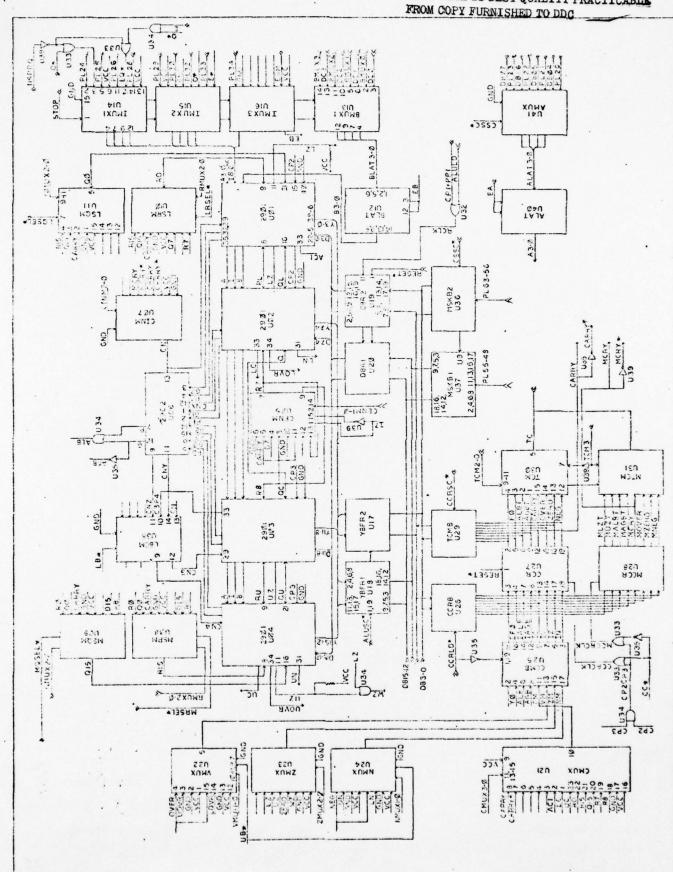


Figure A35. PP2 Schematic

Figure A36. ALU Schematic



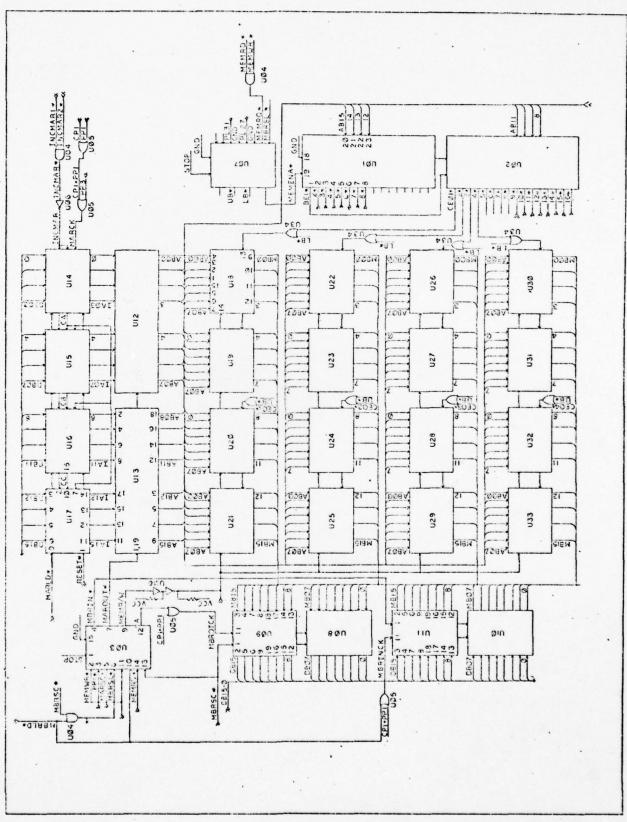


Figure A37. MEM1 Schematio

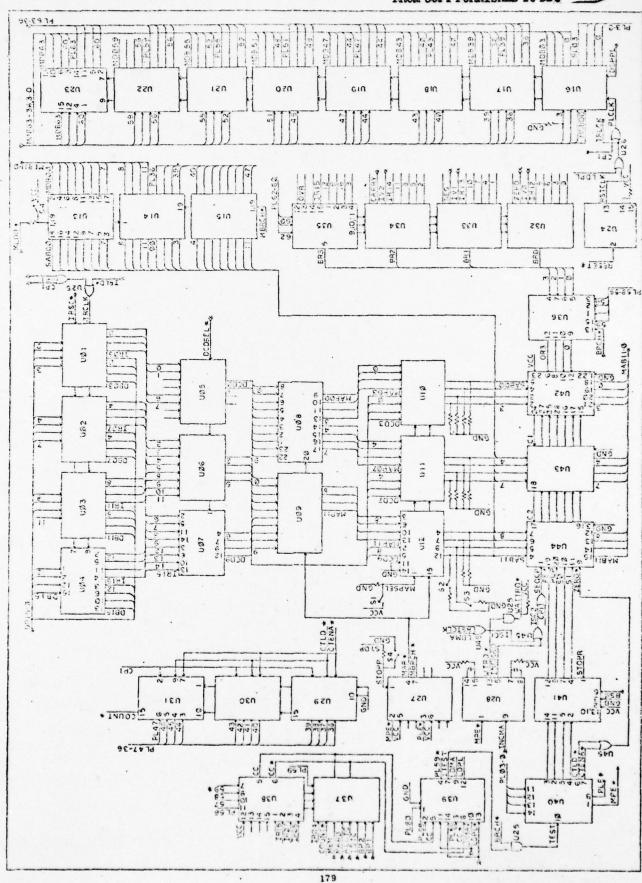


Figure A38. CCUI Schematic

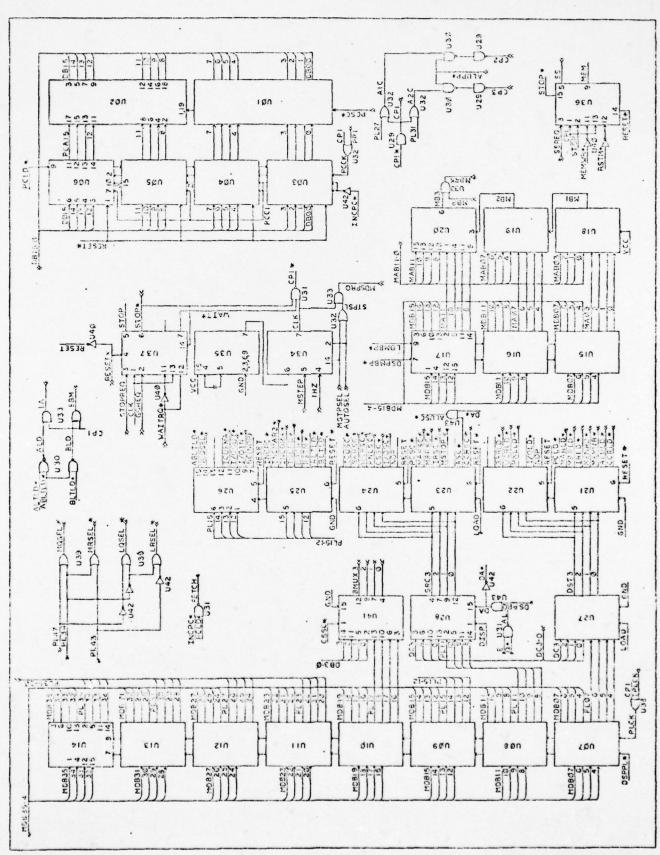


Figure A39. CCU2 Schematic

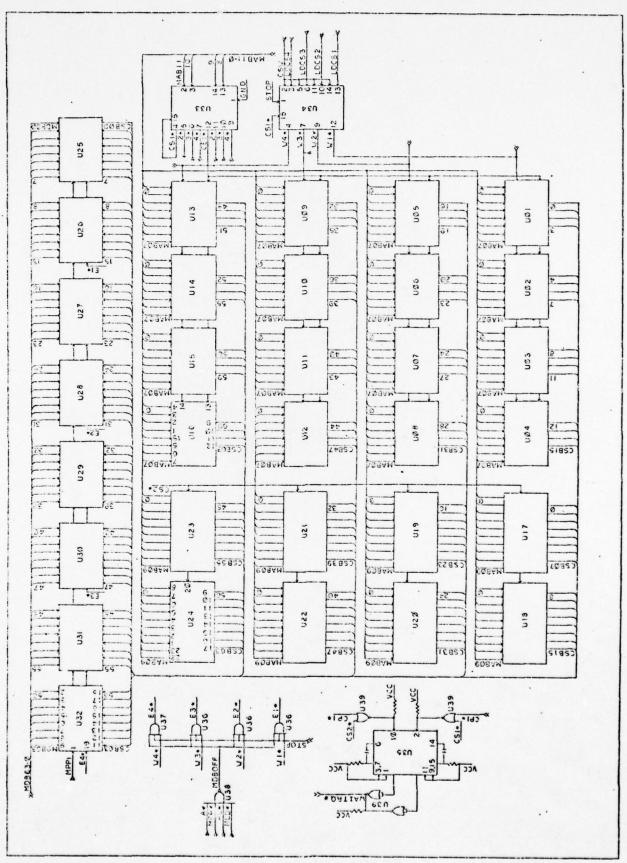


Figure A40. CS1 Schematic

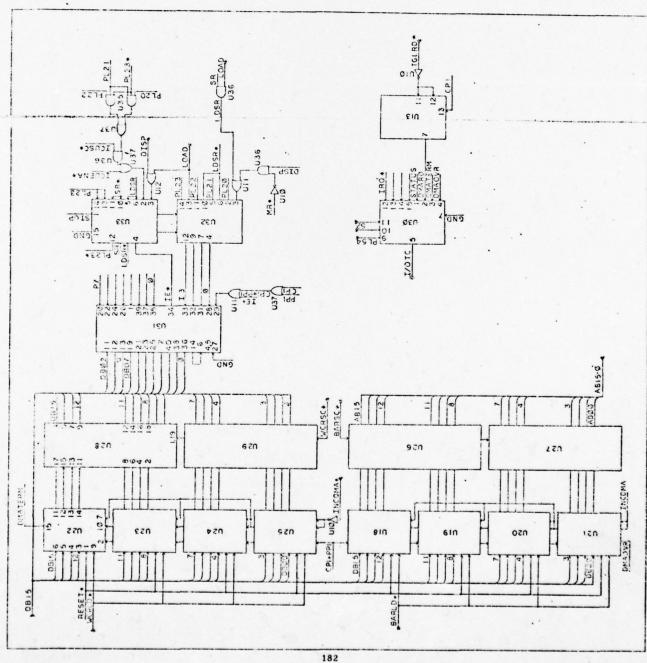


Figure A41. I/O Schematic

# Appendix 2

## Parts List

This appendix provides a complete list of parts used in MIME. Table AXXXIII, I/O Parts List, contains only those parts necessary to implement the basic I/O capability discussed in the User's Manual. The complete I/O design and parts list are contained in Ref. 6.

Table AXXVI FP1 Parts List

Component Designation	Part Name	Part Number
K01	hexadecimal keyboard	Digitran KL036
D01-22	hexademical display	HP 5082-7340
U01	precision timer	72555
U02	hex inverter	7414N
U03	quad S-R latch	74179N
U04	8-bit bistable latch	74100N
U05	quad 2-input OR	7432N
U06	quad 2-input AND	74S108N
U07	precision timer	72555
. U08	dual 4-input NOR	7425N
UO9	quad 2-1 mux (inverted	74LS158N
000	output)	1 Tableton
U10-11	dual monostable multivibrator	54123
U12	quad 2-input AND	7408
U13	hex inverter	7414N
U14	quad 2-input OR	7432
U15	quad 2-input NAND	7400N
U16-17	4-16 decoder	74154N
U18	4-bit shift register	74LS193N
U19	dual J-K flip-flop	74S112N
U20	dual 4-input AND	74H21
U21-22	quad 2-input OR	7432N
U23	quad 2-input AND	7408
U24	triple 3-input AND (0.C.	54S15J
024	output)	343130
U25-26	8-3 encoder	74148N
U27	quad 2-input NAND	74132N
U56-59	quad 2-1 mux	74157N
U60	quad 2-input OR	74LS32N
U61-62	quad 2-input NOR	7402N
U63	quad 2-input OR	74LS32N
U64	4-bit shift register	74194N
U65	dual 4-input NAND	74H21N
U66	quad 2-input NOR	5402A
U90	8-bit bistable latch	74100N
U91	hex inverter	7414N
U92-95	dual monostable multivibrator	74123J
U96	quad 2-input OR	74LS32N
U97	quad 2-input AND	74LS08N
U98	hex inverter	5414N
U99	dual J-K flip-flop	74S112N
S01-2	DPST switch	C&K 7201J2-V4-1
S03-5	DPDT center off mom. switch	C&K 720132-V4-1
S06-7	DPST switch	C&K 7201J2-V4-1
S08-9	DPDT center off mom. switch	C&K 7201J2-V4-1
500-3	DIDI CONCOL OIL MOM. SWICON	Our 120102-14-1

Table AXXVI (Continued)

Component	Part	Part
Designation	Name	Number
S10 S11 S12 S13-14 S15-18 L01-43 C1 C2 C3 C4 C5	DPST switch momentary DPDT center off DPST switch momentary DPDT center off DPST switch LED cable connector printed circuit board for printed circuit board for printed circuit board for printed circuit board	C&K 7201J2-V4-1 C&K 7205J2-V4-1 C&K 7201J2-V4-1 C&K 7205J2-V4-1 C&K 7201J2-V4-1  3-M 3492-3005 3-M 3496-3005 3-M 3496-3005 3-M 3496-3005 3-M 3493-3005 3-M 3492-3005 Vector

Table AXXVII

# FP2 Parts List

Component Designation	Part Name	Part Number
U01-8	dual 4-1 mux	54LS253DM
U09-10	octal 3-state buffer	74LS244N
U11	quad 2-input NAND	74S04N
U12-15	quad 2-1 mux	74157N
U16-23	shift register	54164J
U24-31	octal 3-state buffer	74LS244N
U32-50	quad 2-1 mux	74157N
В	circuit card	Augat 8136 WR61
C2	cable connector	3-M 3496-3005
C4	cable connector	3-M 3496-3005

Table AXXVIII

## MEM1 Parts List

Component Designation	Part Name	Part Number
U01-2	4-16 decoder	74154N
U03	quad 2-1 mux	74S257N
UQ4	quad 2-input NAND	74508
UO5	2-input OR	74LS32N
U06	hex inverter	74S04N
U07	quad 2-1 mux	74S257N
U08-11	octal 3-state register	74LS374N
U12-13	octal 3-state buffer	74LS244N
U14-17	quad binary counter .	74LS161AN
U18-33	256x4 RAM	2112A-2
G	circuit card	Augat 8136 WR61

Table AXXIX
ALU Parts List

Component Part Designation Name		Part Number
U01-4	4-bit microprocessor slice	Am2901DC
U05	8-1 3-state mux	74LS251N
U06	lookahead carry	Am2902PC
U07-11	8-1 3-state mux	74LS251N
U12	4-bit bistable latches	7475N
U13-16	quad 2-1 mux	74157N
U17-18	octal 3-state buffer	74LS244N
U19-20	octal 3-state register	74LS273N
U21	1-16 mux	74150N
U22-24	8-1 mux	74151AN
U25-26	octal 3-state buffer	74LS244N
U27-28	octal 3-state register	74LS273N
U29	octal 3-state buffer	74LS244N
U30-31	8-1 3-state mux	74LS251N
U32-33	quad 2-input OR	7432N
U34	quad 2-input NAND	74LS08N
U35	hex inverter	7414N
U36-37	octal 3-state buffer	74LS244N
U3·8	quad 2-1 mux	74157N
U39	hex inverter	7414N
U40	4 bit bistable latches	74175N
U41	quad 2-1 mux	74157N
F	circuit card	Augat 8136WR61
C6	cable connector	3-M 3492-3005
C8	cable connector	3-M 3493-3005

Table AXXX.

# CCU1 Parts List

Component Designation	Part Name	Part Number
U01-4	quad D register (3-state)	Am2918PC
U05-7	quad 2-1 mux	74157N
U08-9	1K x 8 EPROM	TMS 2708JL
U10-12	quad 2-1 3-state mux	74S257N
U13-15	octal 3-state buffer	74LS244N
U16-23	quad D register (3-state)	Am2918PC
U24	dual monostable multivibrator	74123N
U25	quad 2-input AND (0.C. output)	7409N
U26	quad 2-input OR	74LS32N
U27	quad 2-1 mux	74157N
U28	dual monostable multivibrator	54123N
U29-31	up/down binary counter	74LS169N
U32-35	8-1 mux	74151N
U36	16-way Branch Control Unit	Am29803DC
U37-38	8-1 mux (3-state)	74251N
U39	quad 2-1 mux (inverted output)	74LS158N
U40	Next Address Control Unit	Am29811
U41	quad 2-1 mux	74157N
U42	Microprogram Sequencer	Am2909DC
U43-44	Microprogram Sequencer	Am2911PC
U45	quad 2-input OR	74LS32N
D	circuit card	Augat 8136 WR61
C3	cable connector	3-M 3492-3005
C7	cable connector	3-M 3493-3005

Table AXXXI
CCU2 Parts List

Component Designation		
U01-2	octal 3-state buffer	74LS244N
U03-6	synchronous 4-bit counter	74LS161AN
U07-17	quad D(3-state output) register	Am2918PC
U18-20	4-bit comparator	74LS85N
U21-26	3-8 decoder	74S138N
U27-28	quad 2-1 mux	74S257N
U29	quad 2-input NAND buffer	7437N
U30	quad 2-input NAND	7400N
U31	triple 3-input NAND	7410
U32	quad 2-input	7432N
U33	quad 2-input	7408
U34	dual 4-1 mux	74153J
U35	dual voltage controlled oscillator	74LS124N
U36-37	dual J-K flip-flop	74S112N
U38-39	quad 2-input OR	7432
U40	hex inverter	74S04N
U41	quad 2-1 mux	74S257N
U42	hex inverter	7404
E	circuit card	Augat 8136WR61
C5	cable connector	3-M 3493-3005
C8	cable connector	3-M 3493-3005

Table AXXXII

## CS1 Parts List

Component Designation	Part Name	Part Number	
UO1-16	256X4 RAM	2112A-2	
U17-24	1KX8 EPROM	TMS 2708JL	
U25-32	bus transceiver	74LS245N	
U33	2-4 line decoder	74S139N	
U34	quad 2-1 mux (inverted output)	74158N	
U35	dual monostable multivibrator	74123J	
U36-37	triple 3-input NAND	74H11	
U38	dual 4-input NAND	7420N	
U39	quad 2-input O.C. NOR	. 7433N ,	
C ·	circuit card	Augat 8136WR61	
C1	cable connector .	3-M 3492-3005	
C7	cable connector	3-M 3493-3005	

Table AXXXIII

I/O Parts List

Component Designation	. Part Name	Part Number	
U10	hex inverter	7414	
U11-12	quad 2-input OR	7432	
U18-25	synchronous 4-bit counter	74161	
U26-29	octal 3-state buffer	74LS244N	
U30	8-1 mux	74151	
U31	Priority Interrupt Encoder	- Am2914PC	
U32	quad 2-1 mux	74157N	
U33	quad 2-1 mux (inverted output)	74158N	
U34	quad 2-input OR	7414N	
U35	triple 3-input AND	74H11	
U36	quad 2-input AND	7408	
U37	quad 2-input OR	7432N	
Н	circuit card	Augat 8136WR61	

Table AXXXIV

Chassis and Miscellaneous Parts

Part Name	Part Number
circuit card edge connector card rack extender card BNC connectors binding posts barrier strip	Augat 14005-1P1 Augat 8170-R63 Augat 8136-13861

## Appendix B

#### Configuration Management

#### Introduction

In order to manage the development of MIME and provide a definitive description at the end of the project, it was necessary to establish specific configuration procedures. Configuration management is defined by MIL STD 483 as a discipline applying technical and administrative direction and surveillance to document product characteristics, control changes, and update documentation. This appendix specifies the various procedures used during this project and provides explanation of the notation and conventions used in the system documentation. Configuration management procedures were applied to the project in two phases: informal and formal control.

During the requirements definition phase of the project, informal procedures and documentation were sufficient to maintain control. This documentation consisted of requirements lists and functional block diagrams. The informal procedures consisted of merely dating each document as it was completed so that the documents with the most recent date reflected the current system definition.

Because the configuration became much more detailed during the design and fabrication phases, formal procedures and detailed documentation were required. Two types of documentation were used to provide a complete description of the system electrical configuration: wiring tables and schematics. Because of their importance, the formal documentation and procedures will be discussed in detail.

	MAR		DATE
		CONN NO.	SIGNAL
	01.01.0		SNO
BUC1 32 W13 W27 02	BU( 2		7 305
PUC1 93 W17 NO			43
9U01 04 W16		BE112	4315
BU01 05 W15 V08 18	BU09		0315
PU01 05 W14 W03 02	RUC9		413
BU01 07 W13		30439	215
BUC1 98 W12 GND			SND
PU01 03 V12		30433	314
BU01 10 V13 W07 04	9009		414
BU01 11 V14 V06 16	BU09		2314
BU01 12 V15		3E051	4314
BUC1 13 V15 NC			45
PU01 14 V17 V26 14	BUC2		DATA
8U01 15 V18 GND			340
RUG1 16 V19 VCC			voo
PU02 01 W28 GND			SND
PU02 02 W27 W18 02	BU11		400R

Figure B1. Wiring Table Sample

## Wiring Tables

The physical configuration of MIME consisted of various types of components mounted on circuit cards. Thus, it was required to document the connections on each card as well as the connections between cards.

A portion of the ALU wiring which was generated using the computer programs discussed later is shown in Figure B1 as an example.

Each component was given a unique identifier that designated component type, component number, and the circuit card on which it was located. In addition, each possible location of a component pin on a circuit card corresponded to a card column and row coordinate. The location of the component pins thus specifies the component location and provides a description of the physical layout. Each circuit card connector was also given a unique identifier that designated the connector type and the circuit card on which it was located. These component and connector designations used in conjunction with the pin numbers allowed all connections to be completely described.

Associated with each pin of both connectors and components is a unique alphanumeric name. In so far as possible, this name is descriptive of the signal type and function that is present on that pin. As asterisk was used to indicate a negated signal.

The specific guidelines used in assigning designators are given below:

- Each circuit card shall be given a unique on character identifier. Table BI lists the card designators and their meaning.
- Each component shall be given a one character identifier which designates the component type. Table BIIlists the component designators and their meaning.

Table BI
Circuit Card Identifiers

Identifiers	Circuit Board
А	Control Store 2 (CS2)
В	Front Panel 2 (FP2)
С	Control Store 1 (CS1)
D	Computer Control Unit 1 (CCU1)
E	Computer Control Unit 2 (CCU2)
F	Arithmetic Logic Unit (ALU)
G	Memory 1 (MEM1)
Н	Input/Output (I/O)
Р	Front Panel 1 (FP1)

Table BII
Component Identifiers

Identifiers	Component Type		
С	capacitor		
D	hexadecimal display		
к	hexadecimal keyboard		
L	LED		
R	resistor		
s	Switch		
U	integrated circuit		

- Within a circuit card, components of each type shall be consecutively numbered beginning with one.
- Each card connector shall be designated either E or C to denote edge or cable type respectively.
- 5. The coordinate system provided on the wire wrap circuit cards shall be used to specify a unique location for each component pin.

The various designators and their format are summarized in Table BIII.

A sample of how the designators appear in a wiring table was shown in Figure B1.

The primary type of wiring table used during the project was an intra circuit card table that completely described the component-to-component and component-to-connector wiring on a given card. One table of this type was generated for each card, and Figure B1 contains a portion of the ALU table as an example. This table is presented in order of component and pin numbers; each entry identifies the items that are connected, the location of the wire, and the associated signal name. Special purpose formats of the wiring table are discussed under Computer Program Aids.

### Schematics

Circuit card schematics were used to provide a diagrammatical representation of the circuit card wiring. A complete set of MIME schematics are included in Appendix A, MIME User's Manual. Due to space limitations on the drawings, only the signal names of primary importance are included. In order to simplify the drawings several conventions were used:

Table BIII

Designator Formats

Designator		Character Position				Example
Туре	1	2	3	4	5	Example
circuit card	card designator					В
card coordinate	card column (letter)	card (numb				W43
component	card location	type	compone	ent number		BUO1
edge connector	card location	Е		pin number		BE106
cable connector	card location	С	connector	pin numbe	er	BC207

- Even though the logic gates used were on IC's, individual logic symbols were used for functional clarity.
- 2. Where two or more IC's of the same type are adjacent, pin numbers for the connections are given for only one, and the others may be assumed to follow the same pattern.
- A connection between intersecting lines is designated by a dot.
- 4. A fillet connecting two lines indicates a connection to a bus. Where an IC has several adjacent connections to a bus, only the first and last connections are named, and intervening ones are assumed to be consecutive.
- Connections to edge or cable connectors are designated by the symbol.

## Computer Program Aids

Automated aids for the generation and update of the wiring tables were a significant factor in providing accurate and versatile documentation. The first step of the documentation process was to manually generate a description of the wiring on each card in the format shown in Figure B1. This data was then keypunched and stored on permanent disk files (Ref 23:6-1). From this point, all further manipulation of the files could be accomplished interactively. This allowed convenient access to the files for making changes and automatically generating updated tables.

Because of the volume of each wiring table, the likelihood of error was great, and it was desired to have some means of assuring their consistency. It was also desired to be able to present the tables in special purpose formats. In order to achieve these goals

several computer programs were written and these are discussed below. Complete details of these programs may be found in a report by the authors (Ref 24).

Consistency Check. Because the wiring connections were described for each pin of every component, each wire actually appeared in the wiring table twice. Therefore, the authors devised a computer program to verify that the two entries describing a single wire were consistent. Inconsistent entries or those for which no mate was found were identified on a computer printout. This information was used to correct the wiring table until internal consistency had been achieved.

Alphabetized Sort. The initial format of the wiring tables was indexed by component and pin numbers. However, frequently the need arose to determine the circuit card location of a specific signal. To facilitate signal tracing during troubleshooting, a computer program to sort the table in order to alphabetized signal name was used. Figure B2 shows an example of this data.

Connector Sort. A computer program was devised to extract and order all connector entries from each table. The separate connector lists were then concatenated to form a master connector pin list. A sample of the data is shown in Figure B3. Presentation of the data in this format was used when only signals between circuit cards were of interest.

Backplane Generator. In order to facilitate wiring the backplane (wiring between edge connectors), a computer program was devised to extract the edge connector entries from the master connector pin list and match all those having the same name to form an entry. An example of this data is shown in Figure B4.

				0.3	MAR		DATE
COMP DESIG	40. 514	03090 DESIG	COOPD DESIG	PIN NO.	DECIE	C ONN NO.	SIGNAL NAME
PU02	0.2	W27	W18	02	8961		ADDR
B110 1	0.2	W1 8	W27	0.2	8005		4008
PU0 1	12	V1 5				BE051	4314
PUN 1	04	W1 5				BE112	4315
BU0 1	14	V17	V25	14	BUCS		ATAC
PU01	11	V14	V06	16	9176.9		7314
PUC 1	05	W1 3	V 0 8	18	BU09		D315
PU01	09	V1 2				BC436	014
BU01	07	W13				BC439	015
BU0 1	15	V1 3	GND				SND
BUD S	01	W28	GND				GND
PUC 1	01	W10	GND				340
BU01	28	W1 ?	GND				SNO
PU01	10	V1.3	W07	04	9009		414
BU0 1	36	W1 4	M63	02	8009		M15
8U01	13	V1 6	NC				NC
BU0 1	0 ₹	W1 7	ИС				40
8001	15	V1 9	vcc				voc

Figure B2. Alphabetized Data

BU24	0.3	308	BE002	40300
BU24	07	7)4	BE003	40302
BU24	12	A02	3E004	MDB04
BU24	15	436	3E005	40306
BU35	0.3	DC 8	9E006	40308
BUSE	07	004	BECC7	40310
PU25	12	002	3E008	MD912
B112	15	03.6	BE009	40314
PU26	03	F08	9E010	MD316
BU25	07	F0 4	BE011	40318
PU25	12	F32	BE012	40920
PU25	15	506	BE013	40322
BU27	0.3	408	3E014	MDB24
BU27	07	H0 4	BE015	40325
BU27	12	G0 S	BE016	40328
BU27	15	606	95017	OEFCH
PU28	0.3	K08	BE018	40332
BU28	07	K34	BE019	40834
B1123	12	J02	BE020	MD836
BU28	15	J06	3E021	47338
PIJ29	33	M0 8	BE022	47946
B053	07	M0 4	BE023	MD342
EU23	12	LC2	BE024	MD344
BU29	15	L06	BEC25	47346
5030	03	208	95026	47348
BU3 0	07	P0 4	3E027	40350
P1130	12	NO 2	3E028	MD352
BU33	15	N3 6	3E029	47354
BU31	03	S0 8	BE030	40356
PU31	07	504	9E031	47358
DI171	12	P.0 2	BE032	40360
BU31	15	P3 6	BE033	40862
BU13	01	M27	BE035	HEX*
BU48	02	926	3E036	44300
PULA	11	A22	BE037	44302
9049	02	026	BE038	44304
BU49	11	05.5	BE039	41306
BU5 )	02	F26	BE040	44908
PU5 1	11	F22	3E041	44310
BU11	05	422	3E042	PNLSC*

Figure B3. Master Connector Pin List Excerpt

ABDD	BE044	GENAL	
A301	35105		
AB02	BE045	GE045	
A803	BE105	GE106	
<b>A B D 4</b>	BE046	GE046	
ABC 3	BE107	GE107	
4905	35047	GE047	
AROT	BE108	SE108	
A369	85048	GE048	
A303	BE109	GE109	
ARC	HE044		
AP13	35043	GE049	HE049
AB11	BE110	GE110	HE110
AR12	9E050	GE050	HE 050
AR1 3	PE111	GE111	HE111
AB14	35051	GE051	HE051
A315	BE112	GE112	HE112
A91	HE105		
AP2	HE045		
AB3	HE106		
AB4	HE045		
A95	HE107		
486	HE047		
AB7	HE108		
AR8	HE048		
AB9	HE109		

Figure B4. · Backplane Wiring Table Excerpt

# Management Procedures

In order to control documentation changes, it was necessary to specify the following procedures:

- 1. Upon completion, each document was given an effectivity date.
- 2. Changes to a document were accomplished by noting the changes in red and entering the date of the change. The effectivity date was also changed to that of the modification.
- Upon accumulation of sufficient red-line changes to cause confusion, a revised version of the document was generated.
- 4. Each circuit card was physically dated with the date of the document(s) describing its current configuration.

## Summary

This appendix has described the procedures used by the authors to achieve and maintain configuration control during the project. While the procedures could have been more formal and rigorous, they were adequate to describe the configuration, control changes, and update documentation in a systematic manner.

## Vita

Richard E. Purvis was born on 13 October 1946 in Portsmouth,
Virginia. A 1965 graduate of Hampton High School, Hampton, Virginia,
he attended Virginia Polytechnic Institute, Blacksburg, Virginia, from
which he received the degree of Bachelor of Science (Electrical
Engineering) in June, 1970. He received a commission in the USAF
through OTS in March 1971, and was assigned to Williams AFB, Arizona
for Undergraduate Pilot Training. He received his aeronautical rating
of Pilot in February 1972, and was assigned to Shaw AFB, South Carolina
for upgrade training in the RF-4C Phantom II aircraft. He was subsequently assigned to Zweibrucken AB, Germany in October 1972, where
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Am2900 emulation		control			
microprogramming microprocessor microprogrammed control					
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This report addresses the desi	20. ABSTRACT (Continue on reverse side if necessary and identify by block number)  This report addresses the design and fabrication of a microprogrammable,				
general purpose minicomputer specifically configured for use in an educational					
environment. In order to have utility as an instructional aid in the areas of					
computer control and microprogramming, it was determined that such a machine					
must have the following attributes: educationally oriented human interface,					
educationally oriented design, and user-microprogrammability. These high level					
attributes were then used as a basis for deriving functional and detail require-					
ments. The Am2900 Bipolar Microprocessor Family was used as the basis for					

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realizing the design which satisfied the defined requirements.

The project resulted in hardware which was used by students in digital engineering classes and laboratory to investigate microprogramming and its application to emulation. This report includes representative microcode necessary to emulate sample PDP-11/03 instructions as a demonstration of MIME capabilities.